

PCF50633

Power supply and battery management controller Rev. 06 — 05 March 2008

User manual

Document information

Info	Content
Keywords	PCF50633, PMU, I ² C-bus, USB charger, DC-to-DC converter
Abstract	This document introduces and describes the features and operation of the PCF50633 power supply and battery management controller



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Revision history

		·
06 2008	80305	Supersedes PCF50633_5

Modifications

• File prepared for worldwide distribution.

05	20080128	Supersedes PCF50633_4
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Modifications

Min. value for AUTO parameter V_O changed from V_{O(prog)} – 3 to V_{O(prog)} – 5 (Table 47).

04	20071127	Supersedes PCF50633_3
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Modifications

- Application diagram revised (Figure 61)
- HCLDO min. programmable o/p voltage value changed from 1.0 V to 0.9 V (<u>Table 2</u>, <u>Table 75</u> and <u>Table 88</u>)
- USB current limit (I_{lim(USBx)}): min./typ. values changed from 900/950 to 800/900 respectively when limit set to 1000 mA and from 425/462 to 400/450, respectively, when limit set to 500 mA (Table 91)
- Voltage drop across the USB-SYS FET (ΔV_{USB-SYS}) changed from 200 mV to 235 mV (<u>Table 91</u>).

03	20070720	Supersedes PCF50633 2	
US	20070720	Superseues FCF50033 Z	

Modifications

- HUQFN68 and HUQFN88 packages discontinued
- Error in package layout drawing corrected (B1 = 0.20, 0.16; Figure 62)
- Parameter values updated
- Soldering guidelines updated.

	02	20061030	Supersedes PCF50633_1
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Modifications

- The format of this user manual has been redesigned to comply with the new identity guidelines of NXP Semiconductors
- Legal texts have been adapted to the new company name where appropriate
- Updated to incorporate changes since initial release
- HUQFN68 and HUQFN88 packages added.

Contact information

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1. Introduction

The PCF50633 is a highly integrated solution providing power supply generation and battery management for mobile devices such as portable media players. It contains linear and switching regulators, including an automatic up/down converter for hard disk supply. Other features include a complete USB-compliant battery charger, system control functions and a multi-purpose Analog-to-Digital Converter (ADC). The device can be controlled by a host controller via an I²C-bus serial interface.

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This document describes the features and operation of the PCF50633 and contains all the information, including interface and connection details, required to integrate the IC into a mobile device.

2. Features

2.1 System control

- I²C-bus interface enabling extended control over all modules
- State machine ensuring optimal activity in each device state
- Programmable start-up and shutdown sequencer
- Real Time Clock including 32768 Hz oscillator and alarms
- Interrupt controller
- Wake-up possibilities at 6 pins allowing wake-up by push button, slide switch and adapter/USB insertion
- Three General Purpose I/Os (GPIO) and one high-current General Purpose Output (GPO)
- 8-byte general purpose memory
- · Ambient light sensor
- Thermal protection.

2.2 Supplies

- Auto step-up/step-down converter (1.1 A, 1.7 MHz, internal switches) for a hard disk
- Step-down converter (500 mA, 1.7 MHz, internal switches) for a CPU
- Step-down converter (500 mA, 1.7 MHz, internal switches) for memory, plus parallel Low Dropout Regulator (LDO) for standby mode
- Backlight boost converter, incorporating intensity and on/off ramp control
- Seven linear regulators (4 x 50 mA, 2 x 150 mA, 1 x 200 mA with current limiting)
- Dynamic voltage management on both step-down converters
- Programmable inrush current on all switching regulators
- On/off and output voltage control by software (I²C) and via control pins (GPIOs)
- Power failure detection on most outputs
- Outputs pulled down to ground when supplies are off (except LED converter)
- Linear regulators can be used as switches.

2.3 Battery management

- Battery charge and play system:
 - Supports single-cell Li-Ion batteries
 - Separate adapter and current-limited USB inputs
 - Application can operate from external source when battery is low or not connected

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- Battery remains fully charged after charging as long as an external power supply is connected
- Programmable precharge and fast charge currents
- Integrated power transistors
- Thermal regulation loop controls charge rate at maximum device temperature
- Undervoltage lockout detectors with programmable thresholds
- Backup battery input for RTC supply when main battery is empty
- · Backup battery charger.

2.4 ADC

- 10-bit resolution
- 4 input pins
- Analog preprocessor offering input voltage division and subtraction
- Direct and ratiometric measurement modes.

3. Applications

- Hard disk-based portable media players
- Flash-based portable media players
- PDAs
- · Smartphones.

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4. Quick reference data

Table 1. Quick reference data

 $V_{SS} = REFGND = GND = 0 V$; $T_{amb} = -40 \text{ to } +85 \text{ }^{\circ}\text{C}$; unless otherwise specified.

	, 4,,,,,	<u> </u>				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{SYS}	system supply voltage	Active mode	2.8	-	5.3	V
V_{BAT}	battery supply voltage	Active mode	2.8	-	5	V
V_{BUBAT}	backup battery supply voltage		1.6	-	3	V
V _{ADAPTSNS}	voltage on pin ADAPTSNS	voltage on pin ADAPTSNS	4	-	5.3	V
V _{USB}	USB supply voltage		4	-	5.3	V
V _{VISA}	voltage on pin VISA [1]		-	2.4	-	V
V _{VISC}	voltage on pin VISC[1]		-	2.4	-	V
V _{REFC}	voltage on pin REFC [1]		-	0.9	-	V
V _{O(LED)}	LED output voltage		5	-	18	V
f _{SW(PWM)}	PWM switching frequency	for DOWN1, DOWN2 and AUTO converters	-	1.7	-	MHz
f _{SW(PFM)}	PFM switching frequency	for LED boost converter	-	-	1	MHz
T _{th(die)}	die threshold temperature		-	125	-	°C
V _{th(batok)}	battery OK threshold voltage[2]	range; programmable in 100 mV steps	2.8	-	3.4	V
V _{th(sysok)}	system OK threshold voltage[3]	range; programmable in 100 mV steps	2.8	-	3.4	V
V _{th(sysmin)}	minimum system ON threshold voltage[4]		-	2.5	-	V
V _{th(syspres)}	system threshold voltage for save state[5]	no backup battery	1.7	2	2.3	V
$V_{th(bubpres)}$	backup battery threshold voltage for save state[6]		1	1.3	1.6	V
V _{th(adaptpres)}	adapter presence threshold voltage		3.25	3.6	3.95	V
V _{th(usbpres)}	USB adapter presence threshold voltage		3.25	3.6	3.95	V
I _{DD(tot)}	total supply current	in Save state; $V_{BAT} = 2.5 \text{ V}$; no USB or adapter present	-	-	50	μΑ
		in Standby state; all supplies disabled; V_{BAT} = 3.6 V; no USB or adapter present	-	-	60	μΑ
		in Active state; all supplies enabled (no load); V _{BAT} = 3.6 V; no USB or adapter present	-	-	1	mA

^[1] Note that V_{VISA}, V_{VISC} and V_{REFC} are internal signals. Pins **VISA**, **VISC** and **REFC** are provided to allow external decoupling capacitors to be connected. Decoupling is necessary to ensure stable operation.

^[2] If a USB supply is connected and USBBATCHK = 1, a transition from Save to Standby will only occur if V_{BAT} > V_{th(batok)} and V_{SYS} > V_{th(sysok)}. A transition from Standby to Save will occur if V_{BAT} < V_{th(batok)} or V_{SYS} < V_{th(sysok)}.

^[3] If the system voltage drops below V_{th(sysok)}, a *lowsys* interrupt is generated and the time-out timer is started. The SYSOK status bit is reset (see Table 14 and Table 20).

^[4] If the system voltage drops below V_{th(sysmin)}, an emergency shutdown is initiated and the system transitions to the Save state.

^[5] If the system voltage drops below V_{th(syspres)}, and no backup battery is present (bubpres = 0; see <u>Table 14</u>), the system will be reset and enter the NoPower state. If a backup battery is connected (V_{BUBAT} > V_{th(BUBPRES)}), the PCF50633 will continue in Save mode, powered by the backup battery.

^[6] If the system voltage is below V_{th(syspres)}, the system will continue to operate in the Save state as long as bubbres = 1 (V_{BUBAT} > V_{th(bubpres)}; see Table 14). If bubbres changes to 0, the system will be reset and enter the NoPower state.

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Table 2: Overview power supplies

 $V_{SS} = REFGND = GND = 0 \text{ V; } T_{amb} = -40 \text{ to } +85 \text{ °C; } unless \text{ otherwise specified.}$

Supply Name	Maximum output current	Minimum output voltage	Maximum output voltage	Output voltage step size	Switching frequency	Quiescent current	PSRR[1]	Output capacitor[2]	Inductor
Programm	Programmable power supplies								
DOWN1	500 mA	0.625 V	3.00 V	25 mV	1.7 MHz		-	22 μF	4.7 μΗ
DOWN2	500 mA	0.625 V	3.00 V	25 mV	1.7 MHz		-	22 μF	4.7 μΗ
AUTO	500 mA[3]	1.80 V	3.80 V	25 mV	1.7 MHz		-	22 μF	4.7 μΗ
	1100 mA	1.80 V	3.80 V	25 mV	1.7 MHz		-	47 μF	2.2 μΗ
LED	25 mA	5.0 V	18.0 V	1 mA	< 1 MHz		-	10 μF	2.2 μΗ
LDO1: LDO3	50 mA	0.90 V	3.60 V	100 mV		25 μA + 2 % of load	60 dB	470 nF	
LDO4	150 mA	0.90 V	3.60 V	100 mV		70 μA + 2 %	60 dB	470 nF	
LDO5	150 mA	0.90 V	3.60 V	100 mV		of load	60 dB	470 nF	
LDO6	50 mA	0.90 V	3.60 V	100 mV		25 μA + 2 % of load	60 dB	470 nF	
HCLDO	200 mA[4]	0.90 V	3.60 V	100 mV		70 μA + 2 % of load	60 dB	470 nF	
MEMLDO	1 mA	0.90 V	3.60 V	100 mV		5 μΑ	60 dB	<u>[5]</u>	

^[1] Typical values assuming 100 Hz < f < 1000 Hz.

5. Ordering information

Table 3. Ordering information

Type number	Package			
	Name	Description	Version	
PCF50633HN/xx/N3[1]	HVQFN68	plastic, thermal enhanced, very thin quad flat package; no leads; 68 terminals; body 8 x 8 x 0.85 mm	SOT852-2	

^{[1] &#}x27;xx' indicates the IC variant.

^[2] Typical values assuming X7R type ceramic capacitor.

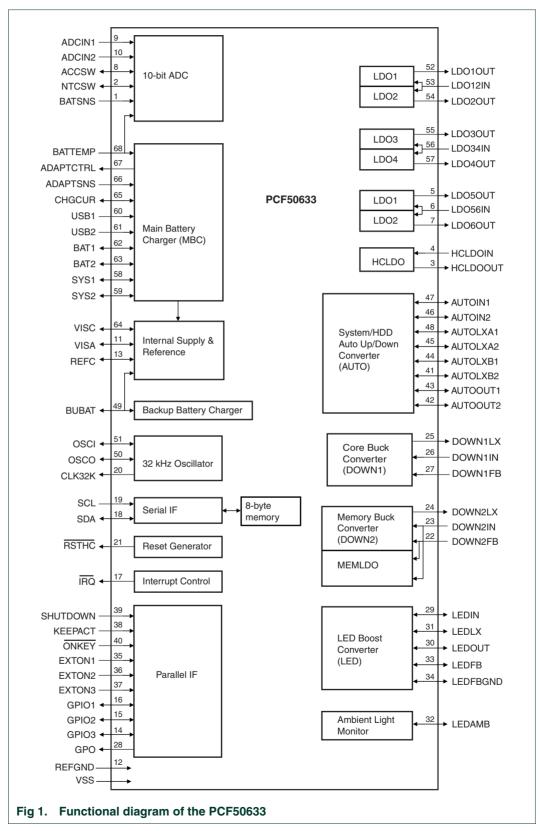
^[3] Smaller external components can be used in the 500 mA configuration; the **AUTOLXA2** and **AUTOLXB1** pins must remain unconnected in this configuration (see Section 8.9.6.3).

^[4] Current limited; output limited to 175 % of the max current (or 350 mA); module is switched off after a programmable debounce time when current exceeds specified limit; afterwards, the On/Off Controller will regularly try to power up the module again (see Section 8.11.6.2).

^[5] Output available at the **DOWN2FB** pin.

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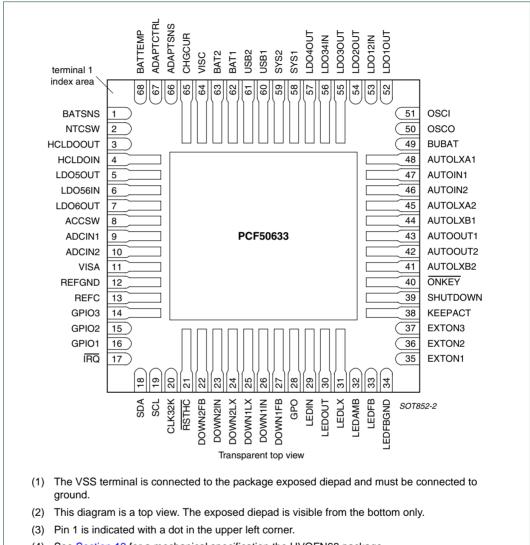
6. Functional Diagram



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7. Pinning Information

7.1 Pinning



(4) See Section 13 for a mechanical specification the HVQFN68 package.

Fig 2. Pin configuration for HVQFN68 package

7.2 Pin description

Table 4. Pin description

Symbol	Pin	Description
Control interf	aces	
ONKEY	40	active-LOW 'on' key input with internal pull-up resistor
EXTON1	35	external activation (wake-up) input
EXTON2	36	external activation (wake-up) input
EXTON3	37	external activation (wake-up) input

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Table 4. Pin description ...continued

Table 4. Pir	i descriptio	oncontinuea
Symbol	Pin	Description
RSTHC	21	active-LOW reset output for host controller; open-drain output
CLK32K	20	32.768 kHz digital clock output; open-drain output
GPIO1	16	input mode: control signal inputs with programmable impact on activity
GPIO2	15	¯ of regulators. – output mode: general purpose open-drain outputs
GPIO3	14	- output mode. general purpose open drain outputs
GPO	28	general purpose push-pull output
SHUTDOWN	39	shuts down the PCF50633 when a LOW-to-HIGH transition is detected
ĪRQ	17	interrupt request to host controller; this active-LOW signal has an open-drain output
KEEPACT	38	Active state continuation input
SCL	19	I ² C-bus interface clock
SDA	18	I ² C-bus interface data
Linear and sw	vitching reg	gulators
AUTOIN1 ¹¹	47	DC-to-DC auto up/down converter input 1
AUTOIN2[1]	46	DC-to-DC auto up/down converter input 2
AUTOLXA12	48	inductor connection 1 to buck part of DC-to-DC auto up/down converter
AUTOLXA2[2]	45	inductor connection 2 to buck part of DC-to-DC auto up/down converter
AUTOLXB1[2]	44	inductor connection 1 to boost part of DC-to-DC auto up/down converter
AUTOLXB2[2]	41	inductor connection 2 to boost part of DC-to-DC auto up/down converter
AUTOOUT1[1]	43	DC-to-DC auto up/down converter output 1
AUTOOUT2[1]	42	DC-to-DC auto up/down converter output 2
DOWN1IN	26	DC-to-DC step-down converter 1 input
DOWN1FB	27	DC-to-DC step-down converter 1 feedback input
DOWN1LX	25	inductor connection to DC-to-DC step-down converter 1
DOWN2IN	23	DC-to-DC step-down converter 2 input
DOWN2FB	22	DC-to-DC step-down converter 2 feedback input and MEMLDO output
DOWN2LX	24	inductor connection to DC-to-DC step-down converter 2
LEDIN	29	LED boost converter input
LEDLX	31	inductor connection to LED boost converter
LEDOUT	30	current-controlled output of LED boost converter
LEDFB	33	feedback for current loop of LED boost converter
LEDFBGND	34	feedback ground sense input to LED boost converter
LEDAMB	32	ambient light sensor input
LDO12IN	53	shared input for LDO1 and LDO2 linear regulators
LDO10UT	52	LDO1 linear regulator output
LDO2OUT	54	LDO2 linear regulator output
LDO34IN	56	shared input for LDO3 and LDO4 linear regulators
LDO3OUT	55	LDO3 linear regulator output

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Table 4. Pin description ...continued

Table 4. Fil	i descriptio	IIcontinued	
Symbol	Pin	Description	
LDO4OUT	57	LDO4 linear regulator output	
LDO56IN	6	shared input for LDO5 and LDO6 linear regulators	
LDO5OUT 5		LDO5 linear regulator output	
LDO6OUT	7	LDO6 linear regulator output	
HCLDOIN	4	high-current linear regulator input	
HCLDOOUT	3	high-current linear regulator output	
32.768 kHz os	cillator		
OSCI	51	32.768 kHz oscillator input	
OSCO	50	32.768 kHz oscillator output	
Internal supp	y		
REFC	13	reference voltage; bypass capacitor connection	
VISA	11	internal analog supply voltage decoupling node	
VISC	64	internal analog supply voltage decoupling node	
Battery charg	er		
USB1 ¹¹	60	USB power input 1	
USB2[1]	61	USB power input 2	
BAT1[1]	62	battery terminal 1	
BAT2[1]	63	battery terminal 2	
BATSNS	1	battery voltage sense input	
SYS1[1]	58	system and adapter connection terminal 1	
SYS2[1]	59	system and adapter connection terminal 2	
ADAPTSNS	66	adapter sense input	
ADAPTCTRL	67	adapter switch gate drive output	
BATTEMP	68	battery temperature sense input	
CHGCUR	65	charger current reference resistor connection	
BUBAT	49	backup battery connection	
ADC			
ADCIN1	9	ADC channel 1 input	
ADCIN2	10	ADC channel 2 input	
NTCSW	2	battery temperature resistor bridge connection	
ACCSW	8	accessory resistor bridge connection	
Ground			
REFGND	12	reference ground	
VSS	backplane	power ground connection	
-			

^[1] The following pin pairs must be connected on the PCB:

AUTOIN1 to AUTOIN2

AUTOOUT1 to AUTOOUT2

USB1 to USB2

BAT1 to BAT2

SYS1 to SYS2

These pins are all power pins. They must be connected via a low-ohmic connection.

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[2] For the AUTO converter, in the 1.1 A configuration, the following pin pairs must be connected on the PCB: AUTOLXA1 to AUTOLXA2 AUTOLXB1 to AUTOLXB2 The AUTOLXA2 and AUTOLXB1 pins must remain unconnected in the 500 mA configuration (see

Section 8.9.6.3). These pins are all power pins. They must be connected via a low-ohmic connection.

8. Functional description

8.1 On/Off Control (OOC)

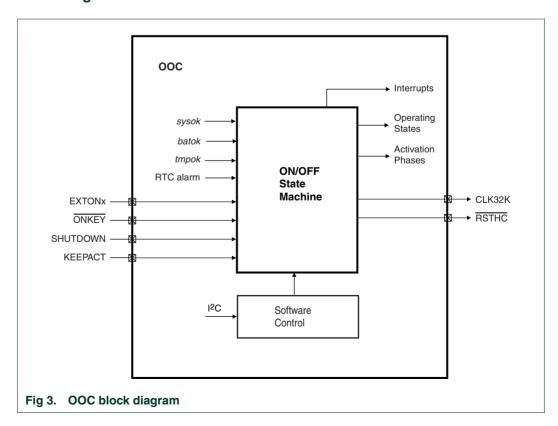
8.1.1 Introduction

The OOC controls the activity states of the <u>PCF50633</u>. It also provides sequencing for the host controller clock (**CLK32K**) and reset (**RSTHC**) signals. Four programmable start-up phases facilitate the sequential start-up of the supplies.

8.1.2 Features

- Finite state machine supporting Save, Standby and Active states
- Programmable wake-up condition for ONKEY and EXTONx inputs
- · Wake-up condition for RTC alarm
- Programmable sequencing for host controller clock (CLK32K) and reset (RSTHC)
- Four separate activity phases for power supply sequencing
- Programmable debounce for **ONKEY**, **EXTONx** and **SHUTDOWN** inputs.

8.1.3 Block diagram



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8.1.4 Hardware interface

Table 5: OOC characteristics

 $V_{SS} = REFGND = GND = 0 \text{ V}; T_{amb} = -40 \text{ to } +85 \text{ °C}; unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{SYS}	system supply voltage	Active mode	2.8	-	5.3	V
I _{Li}	input leakage current	on EXTONx, KEEPACT and SHUTDOWN pins	-1	-	+1	μΑ
		on ONKEY pin when input HIGH	-	-	+1	μΑ
		on ONKEY pin when input LOW	-15	-10	-5	μΑ
V_{IL}	LOW-level input voltage	on ONKEY, EXTONx, KEEPACT and	0	-	0.5	V
V _{IH}	HIGH-level input voltage	SHUTDOWN pins	0.8	-	5.5	V
R _{pu(int)}	internal pull-up resistance	on ONKEY pin	-	300	-	kΩ
V _{OL}	LOW-level output voltage	on CLK32K and $\overline{\text{RSTHC}}$ pins; pull-up resistance > 10 k Ω	-0.2	-	0.4	V
I _{OL}	LOW-level output current	on RSTHC and CLK32K pins	-	-	1.5	mΑ
T _{th(die)}	die threshold temperature		-	125	-	°C
$V_{th(sysmin)}$	minimum system ON threshold voltage[1]		-	2.5	-	V
V _{th(syspres)}	system threshold voltage for save state[2]	no backup battery	1.7	2	2.3	V
V _{th(bubpres)}	backup battery threshold voltage for save state[3]		1	1.3	1.6	V
V_{VISA}	voltage on pin VISA[4]		-	2.4	-	V
V_{REFC}	voltage on pin REFC[4]		-	0.9	-	V
I _{DD(tot)}	total supply current	in Save state; V _{BAT} = 2.5 V; no USB or adapter present	-	-	50	μΑ
		in Standby state; all supplies disabled; V _{BAT} = 3.6 V; no USB or adapter present	-	-	60	μΑ
		in Active state; all supplies enabled (no load)	-	-	1	mA

^[1] If the system voltage drops below $V_{th(sysmin)}$, an emergency shutdown is initiated and the system transitions to the Save state.

8.1.5 Software interface

Table 6. VERSION - Version ID register (address 00h) bit description

Bit	Symbol	Access	Value	Description
7-0	version	R	XXXXXXX	IC version number

^[2] If the system voltage drops below V_{th(syspres)}, and no backup battery is present (*bubpres* = 0; see <u>Table 14</u>), the system will be reset and enter the NoPower state. If a backup battery is connected (V_{BUBAT} > V_{th(BUBPRES)}), the PCF50633 will continue in Save mode, powered by the backup battery.

^[3] If the system voltage is below V_{th(syspres)}, the system will continue to operate in the Save state as long as *bubpres* = 1 (V_{BUBAT} > V_{th(BUBPRES)}; see Table 14). If *bubpres* is reset to 0, the system will be reset and will enter the NoPower state.

^[4] Note that V_{VISA} and V_{REFC} are internal signals. Pins VISA and REFC are provided to allow external decoupling capacitors to be connected. Decoupling is necessary to ensure stable operation.

Table 7. VARIANT - Version ID register (address 01h) bit description

Bit	Symbol	Access	Value	Description
7-0	variant	R	xxxxxxx	ROM number to distinguish PCF50633 variants with different reset values

Table 8. OOCSHDWN - OOC shutdown register (address 0Ch) bit description [1]

Bit	Symbol	Access	Reset	Description
0	go_stby	R/W[2]	0	no action initiates a transition to Standby
1	reserved			
2	totrst	R/W[2]	0	0: no action 1: resets time-out timer
3	coldboot	R/W	1	no coldboot condition coldboot; device has been in NoPower state
7:4	reserved			

^[1] Register is reset in NoPower state.

Table 9. OOCWAKE - OOC wake-up register (address 0Dh) bit description

Bit	Symbol	Access	Reset[1]	Description
0	onkey_wake	R	1	ONKEY functionality disabled ONKEY functionality enabled
1	exton1_wake	R	1	EXTON1 functionality disabled EXTON1 functionality enabled
2	exton2_wake	R/W	1	EXTON2 functionality disabled EXTON2 functionality enabled
3	exton3_wake	R/W	1	EXTON3 functionality disabled EXTON3 functionality enabled
4	rtc_wake	R/W	1	0: wake-up by RTC alarm disabled 1: wake-up by RTC alarm enabled
5	reserved			
6	usb_wake	R/W	1	0: wake-up by USB insert disabled 1: wake-up by USB insert enabled
7	adp_wake	R/W	1	wake-up by adapter insert disabled wake-up by adapter insert enabled

^[1] Register is reset in NoPower state.

Table 10. OOCTIM1 - OOC debounce register 1 (address 0Eh) bit description

Bit	Symbol	Access	Reset[1]	Description
1:0	exton1_deb	R/W	10	debounce time for EXTON1 00: none 01: 5 ms, 10: 14 ms 11: 62 ms
3:2	exton2_deb	R/W	10	debounce time for EXTON2 (timing same as for bits 1:0)
5:4	exton3_deb	R/W	10	debounce time for EXTON3 (timing same as for bits 1:0)
7:6	shdwn_deb	R/W	10	debounce time for SHUTDOWN (timing same as for bits 1:0)

^[1] Register is reset in NoPower state.

^[2] Bit is cleared after transition.

Table 11. OOCTIM2 - OOC debounce register 2 (address 0Fh) bit description

Bit	Symbol	Access	Reset[1]	Description
2:0	onkey_deb	R/W	010	debounce time for ONKEY 000: none 001: 5 ms 010: 14 ms 011: 62 ms 100: 200 ms 101: 500 ms 110: 1000 ms 111: 2000 ms
4:3	actphdel	R/W	01	delay between activation phases 00: 5 ms 01: 10 ms 10: 15 ms 11: 20 ms
6:5	hcrstdel	R/W	10	delay between selected activation phase and host controller reset 00: 3 ms 01: 6 ms 10: 13 ms 11: 26 ms
7	almon	R/W	0	ambient light monitor disabled ambient light monitor enabled

^[1] This register is reset at each transition to Standby state.

Table 12. OOCMODE - OOC mode register (address 10h) bit description[1]

Bit	Symbol	Access	Description
1:0	exton1_mode	R/W	EXTON1 mode selection 00: wake-up on falling edge only 01: wake-up on rising edge only 10: wake-up on falling edge only; rising edge sets the time-out timer to 8 seconds 11: wake-up on rising edge only; falling edge sets the time-out timer to 8 seconds
3:2	exton2_mode	R/W	EXTON2 mode selection behavior like exton1_mode
5:4	exton3_mode	R/W	EXTON3 mode selection behavior like exton1_mode
7:6	onkey_mode	R	ONKEY mode selection 00: wake-up on falling edge only 01: wake-up on falling edge; sets the time-out timer to 8 seconds if held LOW for 1 second 10: wake-up on falling edge only; rising edge sets the time-out timer to 8 seconds 11: reserved

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see Table 7).

Table 13. OOCCTL - OOC control register (address 11h) bit description[1]

Bit	Symbol	Access	Description
1:0	actphrst	R/W	selects activity phase to which host controller reset is related 00: related to activation phase 1 01: related to activation phase 2 10: related to activation phase 3 11: related to activation phase 4
2	actclk32on	R/W	CLK32K output disabled in Active state CLK32K output enabled in Active state
3	heartbeat	R/W	KEEPACT input requires DC HIGH KEEPACT input requires toggling input to retain Active state
4	usbbatchk	R/W	 0: V_{BAT} status has no effect on state machine 1: V_{BAT} must be > V_{th(batok)} to go to Standby state
5	reserved		
6	stbclk32on	R/W	CLK32K output disabled in Standby state CLK32K output enabled in Standby state
7	reserved		

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see Table 7).

Table 14. OOCSTAT - OOC status register (address 12h) bit description

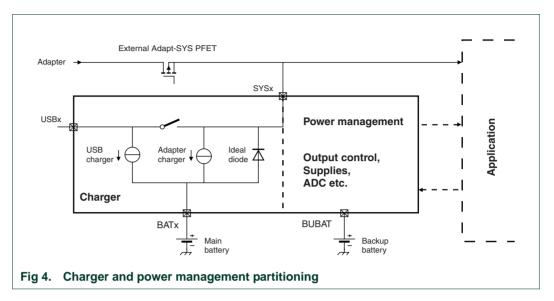
Bit	Symbol	Access	Description
0	onkey	R	ONKEY voltage is below threshold ONKEY voltage is above threshold
1	exton1	R	EXTON1 voltage is below threshold EXTON1 voltage is above threshold
2	exton2	R	EXTON2 voltage is below threshold EXTON2 voltage is above threshold
3	exton3	R	EXTON3 voltage is below threshold EXTON3 voltage is above threshold
4	bubpres	R	0: V _{BUBAT} < V _{th(bubpres)} 1: V _{BUBAT} > V _{th(bubpres)}
5	sysok	R	0: $V_{SYS} < V_{th(sysok)}$ 1: $V_{SYS} > V_{th(sysok)}$
6	batok	R	0: V _{BAT} < V _{th(batok)} 1: V _{BAT} > V _{th(batok)}
7	tmpok	R	0: die temperature > T _{th(die)} 1: die temperature < T _{th(die)}

8.1.6 Functional description

8.1.6.1 Activity states

From the perspective of on/off control, the PCF50633 is composed of a charger and a power management unit. The charger operates autonomously; it charges the battery when necessary, provided charging is possible. It also delivers the system voltage required by the power management unit.

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The power management unit features 4 activity states:

NoPower

In the NoPower state both the system and the backup battery voltages are below their presence threshold levels ($V_{SYS} < V_{th(syspres)}$ and $V_{BUBAT} < V_{th(bubpres)}$; see <u>Figure 6</u>). There is insufficient energy available to power any of the internal circuits. The system will change state from NoPower to Save when V_{SYS} rises above $V_{th(sysmin)}$.

Save

In the Save state, the power management section is supplied from either the system voltage (if $V_{SYS} > V_{th(syspres)}$) or the backup battery (if $V_{SYS} < V_{th(syspres)}$ and $V_{BUBAT} > V_{th(bubpres)}$; see Figure 6). Only the internal supplies, the 32 kHz oscillator and the real-time clock will be active. The GPIOs will maintain their state. If both the system and the backup battery voltages fall below there presence threshold levels ($V_{SYS} < V_{th(syspres)}$) and $V_{BUBAT} < V_{th(bubpres)}$), the PCF50633 will revert to the NoPower state.

Standby

In Standby state, the power management section is supplied by the system voltage, which will be above its OK threshold level ($V_{th(sysok)}$ is specified by the *svmlvl* bits in the *SVMCTL* control register; see <u>Table 35</u>). All monitoring and internal control functions in the PCF50633 are activated. Most power supplies remain off, but all LDOs (LDO1 through LDO6, MEMLDO and HCLDO) may be enabled if required (see <u>Table 15</u> and <u>Section 8.8.5</u>). If V_{SYS} falls below $V_{th(sysok)}$, the PCF50633 will revert to the Save state.

Active

The PCF50633 is fully functional in the Active state. The host controller has full control through the serial I^2C -bus interface.

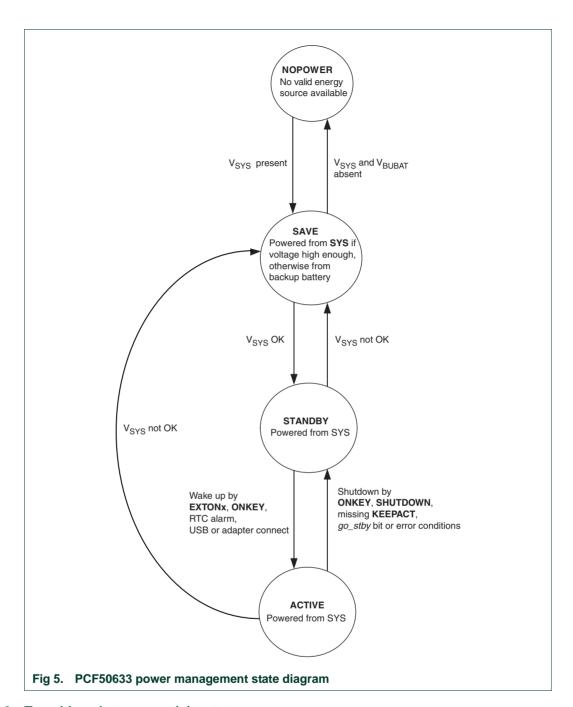
<u>Table 15</u> describes module activity in each state while <u>Figure 5</u> illustrates the PCF50633 state diagram.

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Table 15. Activity states and module activity

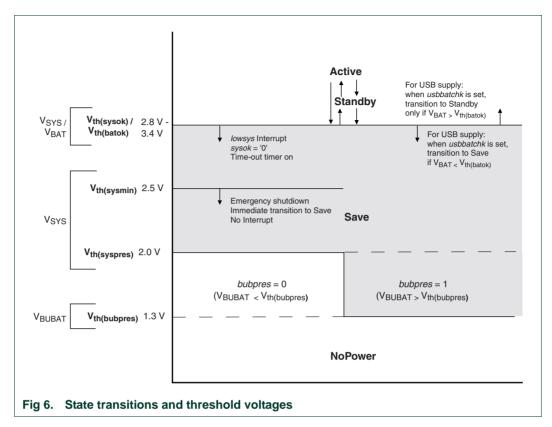
Device state	Modules always on	Modules programmable ON or OFF	Modules always off
NoPower	None	None	All
Save	OSC32, RTC, INT, GPIO	None	Others
Standby	OSC32, RTC, INT, GPIO, SVM	LDO1-LDO6, HCLDO, MEMLDO, BVM, CLK32K	Others
Active	OSC32, RTC, INT, GPIO, SVM, BVM, I ² C, THS	Others	None

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8.1.6.2 Transitions between activity states

The OOC controls the transitions between the activity states of the power management section of the PCF50633.



Transition from NoPower to Save: The system will change state from NoPower to Save when the system voltage (V_{SYS}) rises above $V_{th(sysmin)}$.

Transition from Save to NoPower: In the absence of a charged backup battery (bubpres = 0), the system will return to the NoPower state when the system voltage falls below $V_{th(syspres)}$. If a backup battery is present (bubpres = 1), the system will return to NoPower when the backup battery voltage falls below $V_{th(bubpres)}$.

Transition from Save to Standby: The PCF50633 will change state from Save to Standby when V_{SYS} is greater than $V_{th(sysok)}$ (specified by the *svmlvl* control bits in register *SVMCTL*; see <u>Table 35</u>) and the die temperature is below the maximum temperature threshold ($T_{th(die)}$; see <u>Section 8.6</u>).

An additional condition may be imposed if a USB supply is connected. In this case, if bit usbbatchk in control register OOCCTL (see <u>Table 13</u>) is set, the PCF50633 will only change state from Save to Standby if V_{BAT} is greater than $V_{th(batok)}$.

Transition from Standby to Save: The PCF50633 will revert to the Save state if the system voltage drops below $V_{th(sysok)}$ or the die temperature is above the maximum temperature threshold ($T_{th(die)}$; see Section 8.6).

If a USB supply is connected, and bit usbbatchk in control register OOCCTL (see Table 13) is set, the PCF50633 will also revert to the Save state if V_{BAT} falls below $V_{th(batok)}$.

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Transition from Standby to Active: Several wake-up events will cause the PCF50633 to switch from Standby to the Active state. Note that the response to these events is edge sensitive:

- The user presses the **ONKEY** (**ONKEY** falling edge; see Section 8.1.6.4)
- One of the EXTONx inputs goes HIGH or LOW (depending on the configuration of the extonx_mode control bits; see <u>Table 12</u> and <u>Section 8.1.6.5</u>)

If a fault condition prevents the transition to Active state triggered by any of these events, the wake-up event will be lost.

The following wake-up events will continue to be asserted as long as the event remains active (level sensitive):

- An RTC alarm interrupt
- A high enough voltage is detected on either the **USBx** or **ADAPTSNS** pin to indicate that a USB device or an adapter has been connected.

The RTC alarm and external power connection events remain valid as long as the corresponding interrupt bits are set in the INT module. The interrupt bits are cleared by a read access to the INT register.

All wake-up events can be disabled by clearing the corresponding *wake* control bits in the *OOCWAKE* register (see Table 9). Note that interrupts are still generated.

In the Active state a subset (dependant on the reset values of the IC variant) of the power supplies is switched on. After the supplies have become stabilized, the **RSTHC** output is released allowing the host controller to start up.

Transition from Active to Standby: Transitions from Active to Standby can be direct and immediate or can occur after an 8-second delay. In the later case, a time-out timer is initiated and the system enters Standby after 8 seconds, providing the host controller doesn't intervene in the meantime.

A direct and immediate transition is initiated in the event of one of the following (error) conditions:

- The go_stby bit in control register OOCSHDWN (see <u>Table 8</u>) is set. This allows the
 host controller approximately 2 ms to shut down before the PCF50633 enters Standby
 state.
- Absence of a valid KEEPACT signal (see Section 8.1.6.11).
- A LOW-to-HIGH transition on the **SHUTDOWN** pin

An 8-second time-out timer is initiated in the event of one of the following conditions. After 8 seconds, the PCF50633 enters Standby mode if no action is taken by the host controller in the meantime:

- The **ONKEY** pin is LOW for longer than 1 second (if *onkey_mode* control bits configured accordingly; see Table 12).
- Rising edge on ONKEY (if onkey_mode control bits configured accordingly; see <u>Table 12</u>).
- Rising or falling edge on EXTONx (if extonx_mode control bits configured accordingly; see <u>Table 12</u> and <u>Section 8.1.6.5</u>)

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Transitions from Active to Save: Transitions from Active to Save can be direct and immediate or can occur after a 1-second or an 8-second delay. In the later case, a time-out timer is initiated and the system enters Save state after, respectively, 1 or 8 seconds if the host controller doesn't intervene in the meantime.

A direct and immediate transition occurs when V_{SYS} falls below the V_{th(sysmin)}.

The following conditions initiate the time-out timer:

- lowsys interrupt when the system voltage drops below V_{th(sysok)} (specified by the svmlvl control bits in register SVMCTL; see Table 35) (8-second time-out)
- hightmp interrupt when the die temperature exceeds the maximum temperature threshold, T_{th(die)} (1-second time-out)

8.1.6.3 Time-out timer

PCF50633 on/off control uses a time-out timer to set up delays before responding to several events, as discussed above in <u>Section 8.1.6.2</u>. The timer is set to 8 seconds for all events other than a high die temperature event, when the timer is set to 1 second.

These delays are inserted to allow the host controller time to poll interrupts and respond to events. The *totrst* bit in control register *OOCSHDWN* can be used to extend the delay if necessary or to ignore the event (see Table 8). When *totrst* is set to 1:

- If no timer-related interrupts (interrupts that would cause the timer to be initiated) have been generated, the timer is stopped. In this case the PCF50633 remains in the Active state.
- If one or more timer-related interrupts have been generated but have not been read by the host controller, the timer is reset. The delay is set to 1 or 8 seconds as appropriate, allowing the host controller time to poll the remaining interrupts.

8.1.6.4 ONKEY control input

The **ONKEY** input is intended to be connected to a push button which, when pressed, connects the input to ground. The **ONKEY** input has an internal pull-up resistor to ensure the input is HIGH by default. However, it can also be used as a regular control input.

The *onkey_wake* control bit (bit 0 in register *OOCWAKE*; see <u>Table 9</u>) enables/disables the ONKEY function.

A programmable debounce filter is incorporated into the **ONKEY** input. The debounce time is determined by the setting of control bits *onkey_deb* (bits 2:0 in control register *OOCTIM2*; see Table 11).

The ONKEY mode, which determines how the PCF50633 responds when the push button is pressed, is selected via the *onkey_mode* control bits (bits 7:6 in control register OOCMODE; see Table 12).

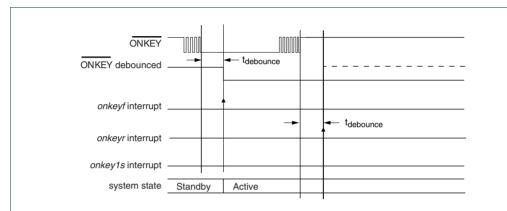
Three interrupts (*onkeyf*, *onkeyr* and *onkey1s*) are generated when the push button is pressed and released, as illustrated in Figure 7 and Figure 8.

A transition from Active to Standby in response to an ONKEY event is interrupt driven.

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Note that if the PCF50633 goes to Standby in response to an *onkey1s* interrupt, the interrupt register must be read the next time the chip starts up in order to clear the *onkey1s* interrupt. If this is not done, the next *onkey1s* interrupt-driven transition to Standby will fail.

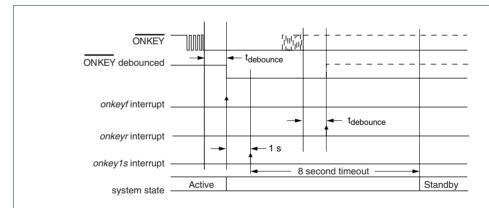
The status of the **ONKEY** pin (HIGH or LOW) can be determined by reading bit 0 of the *OOCSTAT* control register (see Table 14).



The debounced signal retains its original value until the new value has been stable for at least the selected debounce time. A spike (> $30 \mu s$) in the original signal will reset the debounce timer. The filter suppresses all signal activity shorter than the debounce time.

A Standby-to-Active transition is initiated by pressing the **ONKEY**

Fig 7. ONKEY behavior when push button pressed in Standby state



The debounced signal retains its original value until the new value has been stable for at least the selected debounce time. A spike (> 30 μ s) in the original signal will reset the debounce timer. The filter suppresses all signal activity shorter than the debounce time.

An Active-to-Standby transition is initiated when the **ONKEY** push button is held down for 1 second.

Fig 8. ONKEY behavior when push button pressed in Active state

Note that if the **ONKEY** push button is held down for more than one second during the ONKEY wake-up transition, an Active-to-Standby transition is not initiated (the time-out timer is not set and an *onkey1s* interrupt is not generated).

8.1.6.5 EXTON control inputs

Three inputs are provided to facilitate external activation. The **EXTONx** inputs are intended to be connected to a variety of wake-up sources, such as an active user interface or external connectors. They can be configured to initiate either wake-up or shutdown transitions (via the *extonx_mode* control bits in the *OOCMODE* register; see Table 12).

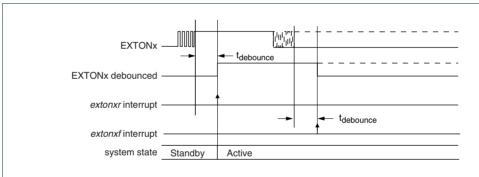
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Each of the *extonx_wake* control bits (bits 3:1 in control register *OOCWAKE*; see <u>Table 9</u>) enables/disables its respective **EXTONx** input. The inputs, **EXTON1**, **EXTON2** and **EXTON3**, are functionally identical.

Programmable debounce filters are incorporated into the **EXTONx** inputs. The debounce time is determined by the setting of the *extonx_deb* control bits (bits 5:0 in control register *OOCTIM1*; see Table 10).

The status of the **EXTONx** pins (HIGH or LOW) can be determined by reading bits 3:1 of the *OOCSTAT* control register (see Table 14).

Two interrupts (*extonxr* and *extonxf*, see <u>Table 18</u>) are generated in response to activity on each of the **EXTONx** inputs as illustrated in Figure 9.



The debounced signal retains its original value until the new value has been stable for at least the selected debounce time. A spike (> 30 μ s) in the original signal will reset the debounce timer. The filter suppresses all signal activity shorter than the debounce time

wake-up on rising edge of EXTONx input (extonx_mode = 01)

Fig 9. EXTON behavior

8.1.6.6 SHUTDOWN control input

When a positive edge is detected on the **SHUTDOWN** input, a transition from Active to Standby is initiated.

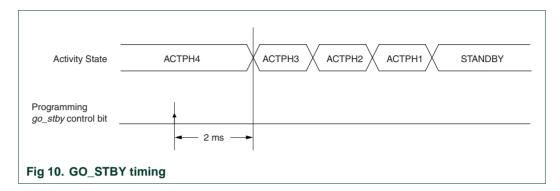
The **SHUTDOWN** input features a programmable debounce filter. The debounce time is determined by the setting of control bits *shdwn_deb* (bits 7:6 in control register *OOCTIM1*; see <u>Table 10</u>).

8.1.6.7 *go_stby* bit

Writing 1 to the *go_stby* control bit initiates a transition from Active to Standby state (bit 0 in control register *OOCSHDWN*; Table 8).

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A 2 ms delay is inserted between the write operation and the disabling of activation phase 4 (ACTPH4; see <u>Section 8.1.6.8</u> below). This allows the host controller to perform any necessary housekeeping tasks. <u>Figure 10</u> shows a timing diagram for a shutdown sequence in response to 1 being written to *go_stby*.

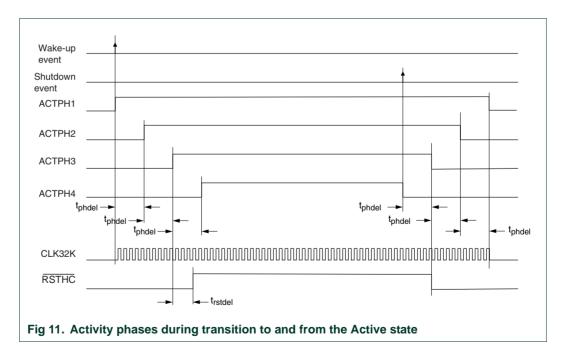


8.1.6.8 Activity phases

There are 4 distinct phases involved in a state transition to or from the Active state (see Figure 10 above). This is necessary to enable power supply and reset signal sequencing.

The *actphdel* control bits (bits 4:3 in control register *OOCTIM2*; see <u>Table 11</u>) set the delay between the phases. The ACTPH1 to ACTPH4 signals are available as GPIO or GPO outputs.

The sequence is followed for all shutdown conditions with the exception of an emergency shutdown ($V_{SYS} < V_{th(sysmin)}$), in which case there is an immediate transition to the Save state.



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8.1.6.9 Reset outputs

The **RSTHC** output signal is intended to drive the reset input of the host controller. It is synchronized with one of the activity phases discussed above in Section 8.1.6.8 and then released (pulled HIGH) after a pre-determined period, t_{rsdel} , of between 3 and 26 ms (t_{rsdel} allows time for the supply to the host controller to stabilize before the reset signal is released).

The activity phase is selected by the *actphrst* control bits (bits 1:0 in register *OOCCTL*; see <u>Table 13</u>) and the delay (t_{rsdel}) by the *hcrstdel* control bits (bits 6:5 in register *OOCTIM2*; see <u>Table 11</u>).

The **RSTHC** output pin is open drain, requiring an external pull up resistor. The synchronization and timing of the **RSTHC** signal is illustrated in the bottom trace of Figure 11 (actphrst = 10).

When the voltage on the $\bf SYS$ pin drops below $V_{th(sysmin)}$ (emergency shutdown), $\bf RSTHC$ goes LOW immediately in order to shut down the host controller.

8.1.6.10 CLK32K output

A 32.678 Hz system clock is available on the **CLK32K** pin when activated. The clock can be activated in Standby or Active states by setting *stbclk32on* or *actclk32on*, respectively, in the *OOCCTL* control register (see <u>Table 13</u>). In the Active state, the activation of the clock is synchronized with ACTPH1, as shown in Figure 11.

The **CLK32K** pin has an open drain output, allowing the appropriate voltage swing to be generated externally. A typical value for an external pull-up resistor is $100 \text{ k}\Omega$.

8.1.6.11 KEEPACT input

The **KEEPACT** input is intended to ensure that the host controller remains active while the PCF50633 is in Active state. However, it can also be used by an external circuit to force a transition from Active to Standby.

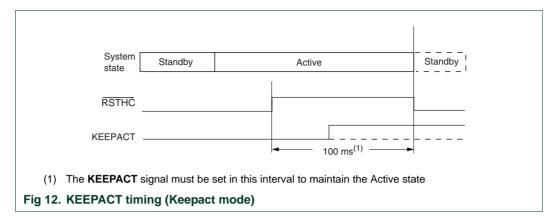
KEEPACT supports two modes:

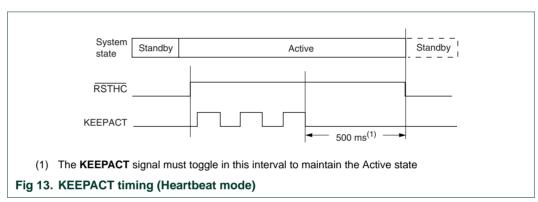
- Keepact mode: after a transition from Standby to Active the PCF50633 expects the KEEPACT input to be forced HIGH by the host controller. If this does not happen within 100 ms of RSTHC going HIGH, the PCF50633 reverts to Standby.
- Heartbeat mode: after a transition from Standby to Active the PCF50633 expects the KEEPACT signal to toggle at least every 500 ms. If this does not happen, the PCF50633 reverts to Standby.

Regular Keepact mode is selected by default. Heartbeat mode is selected when the *heartbeat* control bit in the *OOCCTL* register is set (see <u>Table 13</u>).

KEEPACT timing is illustrated in Figure 12 and Figure 13.

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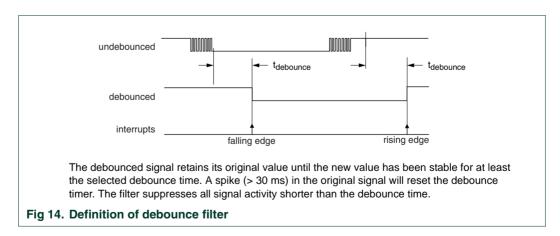


The default reset KEEPACT mode is variant dependent (see Table 7).

8.1.6.12 Debounce filters

Many control signals in the PCF50633 can be debounced to avoid responding to signal spikes. Debounce filters are enabled in all states. Debounce times are programmable.

The timing diagram in Figure 14 applies to all debounce filters in the PCF50633.



8.1.6.13 COLDBOOT flag

The *coldboot* flag indicates that the PCF50633 has been in NoPower state before entering Active state.

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The status of the *coldboot* flag can be determined by reading bit 3 of the *OOCSHDWN* control register (see <u>Table 8</u>). The host controller should read the *coldboot* flag once the PCF50633 enters the Active state. The only way to clear the *coldboot* flag is by programming it to 0 via the I²C-bus serial interface. It is not possible to set the *coldboot* flag via I²C-bus programming.

8.1.6.14 Types of control register

The PCF50633 contains several types of control register, which are automatically reset under different conditions:

- Registers which are reset at initial start-up only and which retain their data in all states except NoPower. These are largely on/off control, interrupt, charger and RTC registers
- Registers which are reset at each transition to Standby state. These are mostly supply control registers.
- Registers with fixed contents, such as device identifiers. These are never reset.

8.2 Interrupt Controller (INT)

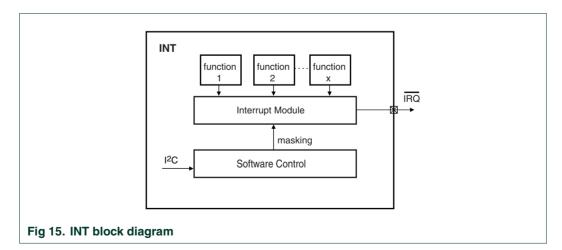
8.2.1 Introduction

The interrupt controller captures and masks interrupts and generates a signal (**IRQ** goes LOW) to indicate to the host that an interrupt has been generated. Interrupts indicate to the host that the PCF50633 has changed status and that some action is required. The host determines interrupt priority.

8.2.2 Features

- All interrupts are Read and Clear (R&C)
- All interrupts to IRQ can be masked.

8.2.3 Block diagram



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8.2.4 Hardware interface

Table 16. Interrupt controller characteristics

 $V_{SS} = REFGND = GND = 0 \ V; \ T_{amb} = -40 \ to +85 \ ^{\circ}C; \ unless \ otherwise \ specified.$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{OL}	LOW-level output voltage on IRQ pin	Pull up resistance > 10 k Ω	-0.2	-	0.4	V
I _{OL}	LOW-level output current on IRQ pin		-	-	1.5	mA

8.2.5 Software interface

Table 17. INT1 - Interrupt register 1 (address 02h) bit description[1]

Bit	Symbol	Access	Description ^[2]	
0	adpins	R&C	ADAPTSNS pin voltage has risen above $V_{th(adaptpres)}$; (see Section 8.12.6.3)	
1	adprem	R&C	ADAPTSNS pin voltage has dropped below V _{th(adaptpres)} ; (see Section 8.12.6.3)	
2	usbins	R&C	USBx pin voltage has risen above V _{th(usbpres)} ; (see Section 8.12.6.2)	
3	usbrem	R&C	USBx pin voltage has dropped below V _{th(usbpres)} ; (see Section 8.12.6.2)	
4	reserved			
5	reserved			
6	rtcalarm	R&C	RTC alarm time expired; (see Section 8.15.7)	
7	second	R&C	RTC periodic one second interrupt; (see Section 8.15.7)	

^[1] This register is reset in NoPower state.

Table 18. INT2 - Interrupt register 2 (address 03h) bit description[1]

Bit	Symbol	Access	Description ^[2]
0	onkeyr	R&C	rising edge detected on ONKEY pin; (see <u>Section 8.1.6.4</u>)
1	onkeyf	R&C	falling edge detected on ONKEY pin; (see <u>Section 8.1.6.4</u>)
2	exton1r	R&C	rising edge detected on EXTON1 pin; (see Section 8.1.6.5)
3	exton1f	R&C	falling edge detected on EXTON1 pin; (see Section 8.1.6.5)
4	exton2r	R&C	rising edge detected on EXTON2 pin; (see Section 8.1.6.5)
5	exton2f	R&C	falling edge detected on EXTON2 pin; (see Section 8.1.6.5)
6	exton3r	R&C	rising edge detected on EXTON3 pin; (see Section 8.1.6.5)
7	exton3f	R&C	falling edge detected on EXTON3 pin; (see Section 8.1.6.5)

^[1] This register is reset in NoPower state (all bits set to 0).

^[2] This column describes the events that cause the corresponding interrupt bits to be set (to logic 1).

^[2] This column describes the events that cause the corresponding interrupt bits to be set (to logic 1).

Table 19. INT3 - Interrupt register 3 (address 04h) bit description[1]

Bit	Symbol	Access	Description[2]
0	batfull	R&C	battery is fully charged (charger has entered Battery Full mode); (see Section "Battery Full mode" on page 88)
1	chghalt	R&C	charger has entered HALT mode; (see Section "Halt mode" on page 89)
2	thlimon	R&C	charger has activated thermal-loop current limiting in the USB-to-SYS path; (see Section 8.12.6.10)
3	thlimoff	R&C	charger has deactivated thermal-loop current limiting in the USB-to-SYS path; (see $\underline{\text{Section 8.12.6.10}}$)
4	usblimon	R&C	charger has activated USB current limiting in the USB-to-SYS path; (see Section "USB Charge and Play mode" on page 85)
5	usblimoff	R&C	charger has deactivated USB current limiting in the USB-to-SYS path; (see Section "USB Charge and Play mode" on page 85)
6	adcrdy	R&C	ADC conversion completed; (see Section 8.14.6.1)
7	onkey1s	R&C	ONKEY LOW for at least 1 second; (see Section 8.1.6.4)

^[1] This register is reset in NoPower state (all bits set to 0).

Table 20. INT4 - Interrupt register 4 (address 05h) bit description[1]

Bit	Symbol	Access	Description ^[2]
0	lowsys	R&C	SYS voltage fallen below V _{th(sysok)} ; (see <u>Section 8.4.6</u>)
1	lowbat	R&C	BAT voltage fallen below V _{th(batok)} ; (see <u>Section 8.5.6</u>)
2	hightmp	R&C	die temperature threshold (T _{th(die)}) exceeded; (see Section 8.6.6)
3	autopwrfail	R&C	AUTO output voltage below 90% of target; (see Section 8.8.6.3)
4	dwn1pwrfail	R&C	DOWN1 output voltage below 90% of target; (see Section 8.8.6.3)
5	dwn2pwrfail	R&C	DOWN2 output voltage below 90% of target; (see Section 8.8.6.3)
6	ledpwrfail	R&C	LED output current below 90% of target; (see Section 8.8.6.3)
7	ledovp	R&C	overvoltage detected at output of LED converter; (see Section 8.10.6.3)

^[1] This register is reset in NoPower state (all bits set to 0).

Table 21. INT5 - Interrupt register 5 (address 06h) bit description[1]

Bit	Symbol	Access	Description ^[2]
0	ldo1pwrfail	R&C	LDO1 output voltage below 90% of target; (see Section 8.8.6.3)
1	ldo2pwrfail	R&C	LDO2 output voltage below 90% of target; (see Section 8.8.6.3)
2	ldo3pwrfail	R&C	LDO3 output voltage below 90% of target; (see Section 8.8.6.3)
3	ldo4pwrfail	R&C	LDO4 output voltage below 90% of target; (see Section 8.8.6.3)
4	ldo5pwrfail	R&C	LDO5 output voltage below 90% of target; (see Section 8.8.6.3)
5	ldo6pwrfail	R&C	LDO6 output voltage below 90% of target; (see Section 8.8.6.3)
6	hcldopwrfail	R&C	HCLDO output voltage below 90% of target; (see Section 8.8.6.3)
7	hcldoovl	R&C	overload ($I_O > 350$ mA) detected in HCLDO regulator; (see Section 8.11.6.2)

^[1] This register is reset in NoPower state (all bits set to 0).

^[2] This column describes the events that cause the corresponding interrupt bits to be set (to logic 1).

^[2] This column describes the events that cause the corresponding interrupt bits to be set (to logic 1).

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[2] This column describes the events that cause the corresponding interrupt bits to be set (to logic 1).

Table 22. INT1MASK - Interrupt mask register 1 (address 07h) bit description[1]

Bit	Symbol	Access	Description
0	adpinsm	R&C	masks adpins interrupt when set
1	adpremm	R&C	masks adprem interrupt when set
2	usbinsm	R&C	masks usbins interrupt when set
3	usbremm	R&C	masks usbrem interrupt when set
4	reserved		
5	reserved		
6	rtcalarmm	R&C	masks rtcalarm interrupt when set
7	secondm	R&C	masks second interrupt when set

^[1] This register is reset in NoPower state (all bits set to 0).

Table 23. INT2MASK - Interrupt mask register 2 (address 08h) bit description[1]

Bit	Symbol	Access	Description
0	onkeyrm	R&C	masks onkeyr interrupt when set
1	onkeyfm	R&C	masks onkeyf interrupt when set
2	exton1rm	R&C	masks exton1r interrupt when set
3	exton1fm	R&C	masks exton1f interrupt when set
4	exton2rm	R&C	masks exton2r interrupt when set
5	exton2fm	R&C	masks exton2f interrupt when set
6	exton3rm	R&C	masks exton3r interrupt when set
7	exton3fm	R&C	masks exton3f interrupt when set

^[1] This register is reset in NoPower state (all bits set to 0).

Table 24. INT3MASK - Interrupt mask register 3 (address 09h) bit description[1]

Bit	Symbol	Access	Description
0	batfullm	R&C	masks batfull interrupt when set
1	chghaltm	R&C	masks chghalt interrupt when set
2	thlimonm	R&C	masks thlimon interrupt when set
3	thlimoffm	R&C	masks thlimoff interrupt when set
4	usblimonm	R&C	masks usblimon interrupt when set
5	usblimoffm	R&C	masks usblimoff interrupt when set
6	adcrdym	R&C	masks adcrdy interrupt when set
7	onkey1sm	R&C	masks onkey1s interrupt when set

^[1] This register is reset in NoPower state (all bits set to 0).

Table 25. INT4MASK - Interrupt mask register 4 (address 0Ah) bit description[1]

Bit	Symbol	Access	Description
0	lowsysm	R&C	masks lowsys interrupt when set
1	lowbatm	R&C	masks lowbat interrupt when set
2	hightmpm	R&C	masks hightmp interrupt when set

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Table 25.	INT4MASK - Interrupt mask register 4	(address 0Ah) bit description[1]continued

Bit	Symbol	Access	Description
3	autopwrfailm	R&C	masks autopwrfail interrupt when set
4	dwn1pwrfailm	R&C	masks dwn1pwrfail interrupt when set
5	dwn2pwrfailm	R&C	masks dwn2pwrfail interrupt when set
6	ledpwrfailm	R&C	masks ledpwrfail interrupt when set
7	ledovpm	R&C	masks ledovp interrupt when set

^[1] This register is reset in NoPower state (all bits set to 0).

Table 26. INT5MASK - Interrupt mask register 5 (address 0Bh) bit description[1]

Bit	Symbol	Access	Description
0	ldo1pwrfailm	R&C	masks Ido1pwrfail interrupt when set
1	ldo2pwrfailm	R&C	masks Ido2pwrfail interrupt when set
2	ldo3pwrfailm	R&C	masks Ido3pwrfail interrupt when set
3	ldo4pwrfailm	R&C	masks Ido4pwrfail interrupt when set
4	ldo5pwrfailm	R&C	masks Ido5pwrfail interrupt when set
5	ldo6pwrfailm	R&C	masks Ido6pwrfail interrupt when set
6	hcldopwrfailm	R&C	masks hcldopwrfail interrupt when set
7	hcldoovlm	R&C	masks hcldoovl interrupt when set

^[1] This register is reset in NoPower state (all bits set to 0).

8.2.6 Functional description

The PCF50633 uses the interrupt controller to signal to the host controller that an event has occurred that may require it to take some action. Interrupts can be generated by a number of modules. The interrupt controller does not prioritize interrupts. This is the responsibility of the host controller.

There are no timing restrictions relating to interrupt processing. All events demanding immediate action are processed by the PCF50633 without requiring action from the host controller.

The interrupt controller captures and masks interrupt signals generated in the relevant modules. When an interrupt is generated, the interrupt controller signals the event to the host controller by forcing **IRQ** low and setting the relevant bit in the appropriate interrupt register. **IRQ** is implemented as an open drain output.

The interrupt controller is active in all states with the exception of the NoPower state. Events that occur in the Standby state are captured and stored so that they can be processed by the host controller once the system returns to the Active state.

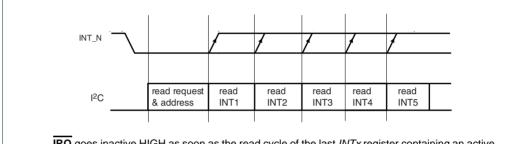
Interrupt registers (8-bit) are cleared once they have been read via the I²C-bus interface. Interrupts generated while a read-and-clear (R&C) operation is being performed are still captured.

Note that, when the PCF50633 shuts down in response to an interrupt (*lowsys*, *onkey1s*, *hightmp* etc.), the appropriate interrupt register must be read when the chip starts up again in order to clear the interrupt. If this is not done, the PCF50633 will not shut down as expected the next time that interrupt is generated.

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The host controller should read all interrupt regist<u>ers in</u> a single I²C-bus read action. This ensures that all active interrupts are cleared. The **IRQ** signal will go HIGH as soon at the read cycle to the last register containing an active interrupt has begun (see Figure 16).

All interrupts can be masked: the **IRQ** signal does not go LOW when a masked interrupt is generated. For each interrupt register, there is a corresponding mask register. Masking is implemented by setting the appropriate mask bits in the relevant mask registers. When an interrupt is generated, the appropriate interrupt status bit is set, whether the interrupt is masked or not. This allows the host controller to accurately determine interrupt status at any time by polling the interrupt registers.



IRQ goes inactive HIGH as soon as the read cycle of the last *INTx* register containing an active interrupt begins.

Read access may or may not use incremental addressing.

Fig 16. Interrupt timing

8.3 General Purpose Input/Output (GPIO/GPO)

8.3.1 Introduction

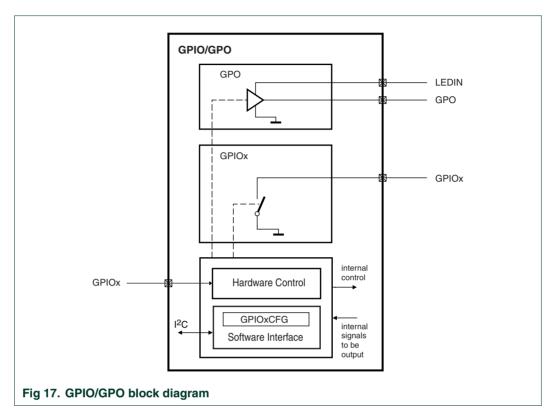
The PCF50633 contains three general purpose open-drain input/output pins (**GPIO1**, **GPIO2** and **GPIO3**) and one high current push-pull output (**GPO**). **GPIOx** signal direction (input or output) is determined by the bit settings in control register *GPIOCTL* (see Table 29).

8.3.2 Features

- GPO has a high current push-pull output
- GPIOs have high current open-drain outputs
- GPIOs are input/output configurable
- Selectable output functions
- Selectable output inversion
- The GPO can be configured, in conjunction with the LED converter and an external FET, to generate output voltages in excess of V_{O(LED)(max)} (see <u>Table 66</u>).

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8.3.3 Block diagram



8.3.4 Hardware interface

Table 27. GPIO characteristics

 $V_{SS} = REFGND = GND = 0 \text{ V}; T_{amb} = -40 \text{ to } +85 \text{ }^{\circ}\text{C}; \text{ unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{IL}	LOW-level input voltage	GPIO is set to input	0	-	0.5	V
V _{IH} [1]	HIGH-level input voltage	GPIO is set to input	1.0	-	5.5	V
V _{n(max)} [1]	maximum voltage on all pins		-	-	5.5	V
I _{sink}	sink current	active low; ON mode (switch closed)	0	-	100	mA
IL	leakage current	3-state mode (switch open)	-	-	5	μΑ
V _{OL}	LOW-level output voltage	I _{OL} = 100 mA	-0.3	-	0.35	V

^[1] High voltage spikes could occur on the **GPIOx** output when switching an inductive load. In this case a free-wheel diode or capacitance should be connected across **GPIOx** and ground to eliminate the spikes. The limiting values must be respected under all conditions (see Section 10 "Limiting values").

Table 28. GPO characteristics

 $V_{SS} = REFGND = GND = 0 \text{ V}; T_{amb} = -40 \text{ to } +85 \text{ °C}; \text{ unless otherwise specified.}$

	, 41110					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I_{O}	output current		-10	-	10	mA
V _{OH}	HIGH-level output voltage	$I_{OH} = -10 \text{ mA}$	$0.8V_{LEDIN}$	-	V_{LEDIN}	V
V _{OL}	LOW-level output voltage	$I_{OL} = -10 \text{ mA}$	-0.3	-	0.35	V

8.3.5 Software interface

Table 29. GPIOCTL - GPIO I/O mode control register (address 13h) bit description

Bit	Symbol	Access	Reset[1]	Description
0	gpio1dir	R/W	[2]	GPIO1 I/O mode; 0: output, 1: input
1	gpio2dir	R/W	[2]	GPIO2 I/O mode; 0: output, 1: input
2	gpio3dir	R/W	[3]	GPIO3 I/O mode; 0: output, 1: input
7:3	reserved			

^[1] Reset values are determined by the IC variant (see Table 7).

Table 30. GPIO1CFG - GPIO1 signal selection register (address 14h) bit description[1]

Bit	Symbol	Access	Description
2:0	gpio1sel	R/W	GPIO1 output signal selection 000: fixed 0 001: reserved 010: SYSx pin voltage > V _{th(sysok)} 011: battery charging in progress 100: mobile mode: adapter & USB absent 101: USBx pin voltage > V _{th(usbpres)} 110: ACTPH1 signal 111: fixed 1
3	gpio1pol	R/W	GPIO1 output signal polarity 0: no inversion, 1: inversion
7:4	reserved		

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see Table 7).

Table 31. GPIO2CFG - GPIO2 signal selection register (address 15h) bit description[1]

Bit	Symbol	Access	Description
2:0	gpio2sel	R/W	GPIO2 output signal selection 000: fixed 0 001: reserved 010: SYSx pin voltage > V _{th(sysok)} 011: battery charging in progress 100: mobile mode: adapter & USB absent 101: USBx pin voltage > V _{th(usbpres)} 110: ACTPH2 signal 111: fixed 1
3	gpio2pol	R/W	GPIO2 output signal polarity 0: no inversion, 1: inversion
7:4	reserved		

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see <u>Table 7</u>).

^[2] Reset in NoPower state.

^[3] Reset in Standby state.

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Table 32. GPIO3CFG - GPIO3 signal selection register (address 16h) bit description[1]

Bit	Symbol	Access	Description
2:0	gpio3sel	R/W	GPIO3 output signal selection 000: fixed 0 001: reserved 010: SYSx pin voltage > V _{th(sysok)} 011: battery charging in progress 100: mobile mode: adapter & USB absent 101: USBx pin voltage > V _{th(usbpres)} 110: ACTPH3 signal 111: fixed 1
3	gpio3pol	R/W	GPIO3 output signal polarity 0: no inversion, 1: inversion
7:4	reserved		

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see Table 7).

Table 33. GPOCFG - GPO signal selection register (address 17h) bit description[1]

			, , ,
Bit	Symbol	Access	Description
2:0	gposel	R/W	GPO output signal selection 000 : fixed 0 001: LED external NFET drive signal; see Section 8.10.6.6 010: SYSx pin voltage > V _{th(sysok)} 011: CLK32K 100: mobile mode: adapter & USB absent 101: USBx pin voltage > V _{th(usbpres)} 110: ACTPH4 signal 111: fixed 1
3	gpopol	R/W	GPO output signal polarity 0: no inversion, 1: inversion
7:4	reserved		

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see <u>Table 7</u>).

8.3.6 Functional description

The GPIO inputs can be configured as power supply enable inputs (see <u>Section 8.8</u>). When the **GPIOx** pins are configured as inputs, the settings in the *GPIOxCFG* registers have no effect; see <u>Table 30</u> and <u>Table 31</u>).

The **GPIOx** outputs are all high current (100 mA) open drain outputs. The output voltage can be set to any value < 5.5 V.

The **GPO** output is driven by a push-pull stage which is powered by the voltage on the **LEDIN** pin. It can be used in conjunction with the LED converter to generate output voltages $> V_{O(LED)(max)}$ (for details see <u>Section 8.10.6.6</u>).

The **GPIO** and **GPO** pins can output different signals concurrently, as detailed in the *GPIOxCFG* and *GPOCFG* control registers (see <u>Table 30</u> to <u>Table 33</u>). The *gpioxsel* and *gposel* bits are used to select the output signal. The *gpioxpol* and *gpopol* bits offer optional inversion.

GPIOx/GPO outputs signals are available in Active, Standby and Save modes.

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When any of these pins is configured as an output, input functionality is disabled. Any **GPIOx** pin configured as a power supply enable input will not function as such (see Section 8.8).

8.4 System Voltage Monitor (SVM)

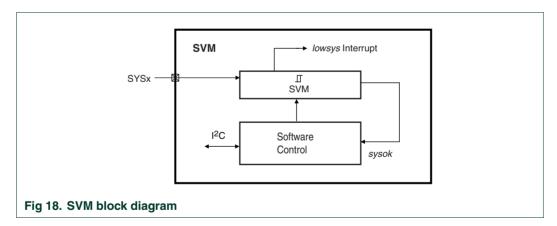
8.4.1 Introduction

The PCF50633 contains two voltage monitors with programmable threshold levels used to affect state transitions. This section describes the System Voltage Monitor (SVM), which monitors the voltage on pins **SYS1** and **SYS2**. The next section describes the Battery Voltage Monitor (BVM).

8.4.2 Features

- The SVM is automatically activated by the On/Off Control (OOC) logic (see Section 8.1.6.1)
- Programmable threshold (V_{th(svsok)})
- A lowsys interrupt is generated when the voltage on SYSx drops below the specified threshold
- Built-in hysteresis and programmable debounce filter to minimize system oscillations
- The OOC initiates state transitions in response to a *lowsys* interrupt (see Section 8.1.6.1).

8.4.3 Block diagram



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8.4.4 Hardware interface

Table 34. SVM characteristics

 $V_{SS} = REFGND = GND = 0 \text{ V}; T_{amb} = -40 \text{ to } +85 \text{ }^{\circ}\text{C}; \text{ unless otherwise specified.}$

			-			
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{\text{th(sysok)}}$	system OK threshold voltage ^[1]	range; programmable in 100 mV steps	2.8	-	3.4	V
		accuracy	-2	V _{th(sysok)}	+2	%
V _{th(sysok)hys}	hysteresis of system OK threshold voltage		-	$0.04 \times V_{th(sysok)}$	-	V
t _{deb(SVM)}	debounce time for low system voltage condition (rising edge only)		-5%	62	+5%	ms

^[1] If the system voltage drops below $V_{th(sysok)}$, a lowsys interrupt is generated and the sysok status bit is reset (see Table 14 and Table 20).

8.4.5 Software interface

Table 35. SVMCTL - SVM control register (address 19h) bit description[1]

Bit	Symbol	Access	Reset[1]	Description			
0	svmlow	R		•	Itage is higher than the programmed threshold Itage is lower than the programmed threshold		
3-1	svmlvl	R/W	[2]	V _{th(sysok)} threshold level			
				000: n.a.	100: 3.10 V		
				001: 2.80 V	101: 3.20 V		
				010: 2.90 V	110: 3.30 V		
				011: 3.00 V	111: 3.40 V		
4	svmdisdb	R/W	0	0: enable 62 n	ns debounce filter		
				1: disable 62 r	ns debounce filter		
7:5	reserved						

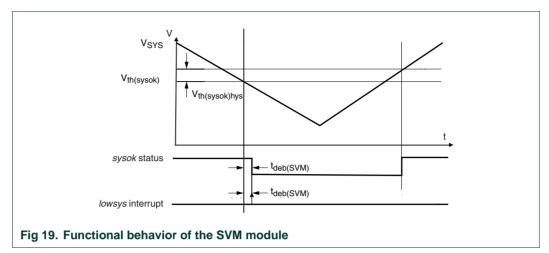
^[1] This register is reset in NoPower state.

8.4.6 Functional description

Figure 19 illustrates the behavior of the SVM.

^[2] Reset values are determined by the IC variant (see Table 7).

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The SVM monitors the system voltage (V_{SYS} , the voltage on pins **SYS1** and **SYS2**) at all times. As long as V_{SYS} remains above $V_{th(sysok)}$, the *sysok* status bit in the *OOCSTAT* control register will be = 1 (see Table 14).

If the system voltage drops below $V_{th(sysok)}$, a *lowsys* interrupt is generated and the *sysok* status bit is set to 0.

The threshold voltage, $V_{th(sysok)}$, is determined by the *svmlvl* control bits in the *SVMCTL* register (see Table 35).

When a low system voltage is detected in Active state, the host controller should initiate a transition to Save. If this doesn't happen within 8 seconds of a *lowsys* interrupt being generated, the OOC will force the PCF50633 to the Save state to prevent the battery becoming excessively discharged.

A hysteresis and debounce filter is built in to prevent rapid cycling of the *lowsys* interrupt signal. The rising edge of the SVM low voltage signal is debounced with a debounce time of 62 ms. The falling edge is not debounced. The debounce filter can be disabled by setting the *svmdisdb* control bit in the *SVMCTL* register (see Table 35).

8.5 Battery Voltage Monitor (BVM)

8.5.1 Introduction

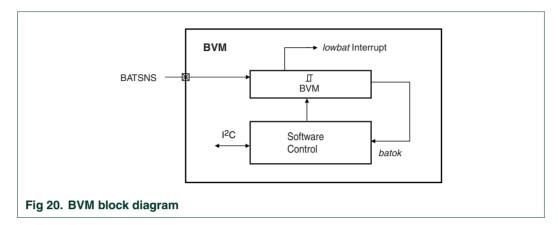
The BVM monitors the voltage on the **BATSNS** pin.

8.5.2 Features

- The BVM is automatically activated by OOC logic
- Programmable threshold (V_{th(batok)})
- A lowbat interrupt is generated when the voltage on BATSNS drops below the specified threshold
- Built-in hysteresis and programmable debounce filter to minimize system oscillations
- A lowbat interrupt can affect state transitions (see Section 8.1.6.2).

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8.5.3 Block diagram



8.5.4 Hardware interface

Table 36. BVM characteristics

 $V_{SS} = REFGND = GND = 0 V$; $T_{amb} = -40 \text{ to } +85 \text{ }^{\circ}\text{C}$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{th(batok)}$	battery OK threshold voltage[1]	range	2.8	-	3.4	V
		accuracy	-2	$V_{th(batok)}$	+2	%
V _{th(batok)hys}	hysteresis of battery OK threshold voltage			$0.04 \times \\ V_{th(batok)}$		V
t _{deb(BVM)}	debounce time for low battery condition (rising edge only)		-5%	62	+5%	ms

^[1] If a USB supply is connected and usbbatchk = 1, a transition from Save to Standby will only occur if V_{BAT} > V_{th(batok)} and V_{SYS} > V_{th(sysok)}. A transition from Standby to Save will occur if V_{BAT} < V_{th(batok)} or V_{SYS} < V_{th(sysok)}.

8.5.5 Software interface

Table 37. BVMCTL - BVM control register (address 18h) bit description

Bit	Symbol	Access	Reset[1]	Description	
0	bvmlow	R		BATSNS pin voltage is higher than the programmed threshold BATSNS pin voltage is lower than the programmed threshold	
3-1	bvmlvl	R/W	[2]	V _{th(batok)} threshold level 000: n.a. 100: 3.10 V 001: 2.80 V 101: 3.20 V 010: 2.90 V 110: 3.30 V 011: 3.00 V 111: 3.40 V	
4	bvmdisdb	R/W	0	0: enable 62 ms debounce filter 1: disable 62 ms debounce filter	
7:5	reserved				

^[1] This register is reset in NoPower state.

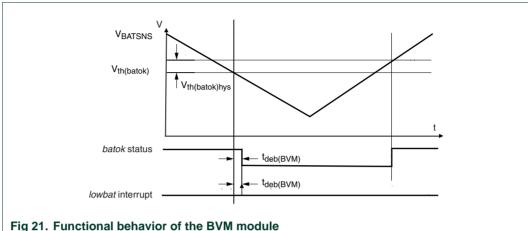
^[2] Reset values are determined by the IC variant (see Table 7).

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8.5.6 Functional description

Figure 21 illustrates the behavior of the BVM.



The BVM monitors the voltage on the **BATSNS** pin. As long as this voltage remains remains above $V_{th(batok)}$, the batok status bit in the OOCSTAT control register will be = 1 (see Table 14).

If the **BATSNS** pin voltage drops below V_{th(batok)}, a *lowbat* interrupt is generated and the batok status bit is set to 0.

The threshold voltage, V_{th(batok)}, is determined by the *bvmlvl* control bits in the *BVMCTL* register (see Table 37).

Note that the BVM output signal will only affect state transitions if the usbbatchk bit in control register OOCCTL is = 1 (see Table 13).

A hysteresis and debounce filter is built in to prevent rapid cycling of the *lowbat* interrupt signal. The rising edge of the BVM low battery signal is debounced with a debounce time of 62 ms. The falling edge is not debounced. The debounce filter can be disabled by setting the bymdisdb control bit in the BVMCTL register (see Table 37).

8.6 Temperature High Sensor (THS)

8.6.1 Introduction

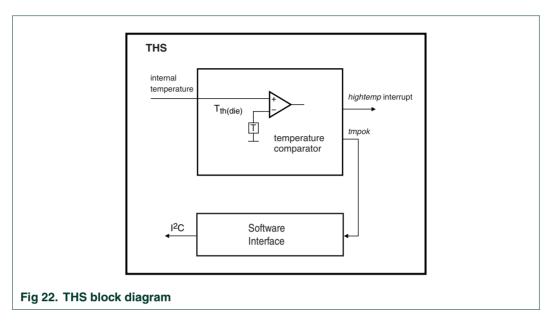
The Temperature High Sensor monitors the junction temperature of the PCF50633.

8.6.2 Features

- Fixed temperature threshold (T_{th(die)})
- Built-in hysteresis and debounce filter minimizes system oscillations.

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8.6.3 Block diagram



8.6.4 Hardware interface

Table 38. THS characteristics

 $V_{SS} = REFGND = GND = 0 \text{ V; } T_{amb} = -40 \text{ to } +85 \text{ °C; unless otherwise specified.}$

Symbol	Symbol	Conditions	Min	Тур	Max	Unit
T _{th(die)}	die threshold temperature[1]		-	125	-	°C
T _{th(die)hys}	hysteresis of die threshold temperature		15	20	25	°C
t _{deb}	debounce time		-	62	-	ms

^[1] If the die temperature exceeds T_{th(die)} + T_{hys(die)}, a *hightmp* interrupt is generated and the *tmpok* status bit is set to 0 (see <u>Table 14</u>, <u>Table 20</u> and <u>Figure 23</u>).

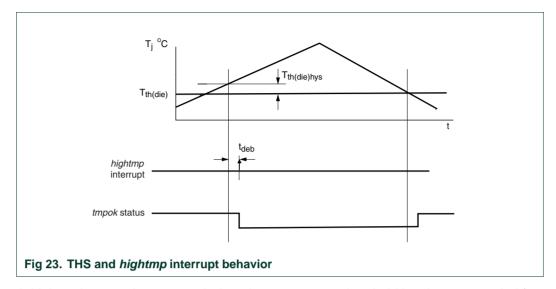
8.6.5 Software interface

The interrupt (*hightmp*) associated with the THS can be found in register *INT4* (see <u>Table 20</u>). The status bit (*tmpok*) associated with the THS is located in the *OOCSTAT* register (see <u>Table 14</u>).

8.6.6 Functional description

Figure 23 illustrates the behavior of the THS and the hightmp interrupt.

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A *hightmp* interrupt is generated when the temperature threshold has been exceeded for more than 62 ms (debounce time). When a *hightmp* interrupt is generated, the host controller should initiate a transition to Save. If this doesn't happen within 1 seconds of a *hightmp* interrupt being generated, the OOC will force the PCF50633 to the Save state to prevent the circuit getting damaged.

Note that if the PCF50633 goes to Save state in response to a *hightmp* interrupt, the appropriate interrupt register must be read the next time the chip starts up in order to clear the *hightmp* interrupt. If this is not done, the *hightmp* interrupt will remain active.

Built-in hysteresis and debounce filter prevent rapid cycling of the *hightmp* signal.

The THS cannot be disabled via I^2C -bus interface. The high temperature status can be determined by sampling status bit *tmpok* in the *OOCSTAT* register (see <u>Table 14</u>).

8.7 32 kHz oscillator (OSC32)

8.7.1 Introduction

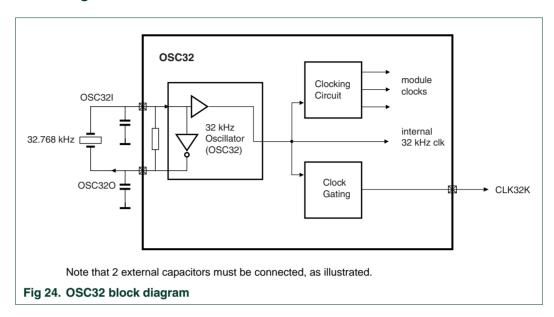
The 32.768 kHz crystal oscillator provides an accurate low frequency clock signal for the PCF50633 and external circuitry.

8.7.2 Features

- An accurate low-frequency clock for internal timing
- An external 32 kHz clock via the CLK32K pin, which is an open-drain output that becomes active as soon as the PCF50633 enters Active or Standby state (depending on the settings of the xxxclk32on bits in the OOCCTL register; see Table 13)
- Provides a reference for internal clocks, e.g. switching regulators.

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8.7.3 Block diagram



8.7.4 Hardware interface

Table 39. OSC32 characteristics

 $V_{SS} = REFGND = GND = 0 \text{ V}; T_{amb} = -40 \text{ to } +85 \text{ }^{\circ}\text{C}; \text{ unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
gm	oscillator transconductance		8	14	20	μS
t _{STARTUP}	total start-up time until CLK32 signal active	System is forced to go to Active state when charged main battery is connected while ONKEY is LOW	-	400	500	ms
Cı	Input capacitance between OSCI and OSCO pins		-	5	-	pF

8.7.5 Software interface

There are no registers associated with the OSC32.

8.7.6 Functional description

The 32 kHz oscillator module can be used without a crystal by connecting a 32.768 kHz signal to the **OSC32I** pin. The **OSC32O** pin should be left floating in this configuration.

The PCF50633 can also be used without a 32 kHz crystal or external 32 kHz clock input. In this case, a 32 kHz clock signal will be generated internally. However, the clock will be less accurate in this situation and there will be a increase in power consumption, particularly in Save and Standby states. Both the **OSC32I** and **OSC32O** pins must be grounded when using the PCF50633 without a 32 kHz crystal or external clock signal.

8.8 Power Supply Module (PSM)

8.8.1 Introduction

The power supply module controls the enabling and disabling of the LDOs and converters.

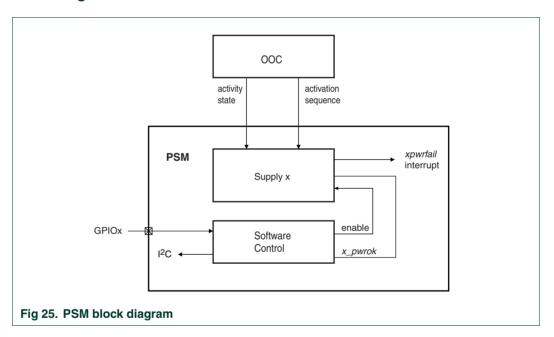
8.8.2 Features

- Power supply sequencing using 4 different activation and deactivation phases
- Supply module activation via the appropriate *x_on* control bit
- Direct control via the GPIO inputs
- LDOs can be activated in Active and Standby states; converters can only be activated in Active state

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• Power failure detection for all supplies other than MEMLDO.

8.8.3 Block diagram



8.8.4 Hardware interface

There is no hardware interface associated with the PSM.

8.8.5 Software interface

Table 40. STBYCTL1 - LDO Standby control register (address 3Bh) bit description[1]

Bit	Symbol	Access	Description
0	ldo1_ena_stb	R/W	if set, LDO1 is ON in Standby state
1	reserved		
2	ldo2_ena_stb	R/W	if set, LDO2 is ON in Standby state
3	reserved		
4	ldo3_ena_stb	R/W	if set, LDO3 is ON in Standby state

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Table 40. STBYCTL1 - LDO Standby control register (address 3Bh) bit description[1]

Bit	Symbol	Access	Description
5	reserved		
6	ldo4_ena_stb	R/W	if set, LDO4 is ON in Standby state
7	reserved		

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see Table 7).

Table 41. STBYCTL2 - LDO Standby control register (address 3Ch) bit description[1]

Bit	Symbol	Access	Description
0	ldo5_ena_stb	R/W	if set, LDO5 is ON in Standby state
1	reserved		
2	ldo6_ena_stb	R/W	if set, LDO6 is ON in Standby state
3	reserved		
4	hcldo_ena_stb	R/W	if set, HCLDO is ON in Standby state
5	reserved		
6	memldo_ena_stb	R/W	if set, MEMLDO is ON in Standby state
7	reserved		

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see Table 7).

Table 42. DEBPF1 - Power fail debounce register 1 (address 3Dh) bit description

				. , , , ,
Bit	Symbol	Access	Reset[1]	Description
1:0	auto_debpf	R/W	11	AUTO power failure debounce time 00: none 01: 1 ms 10: 10 ms 11: 100 ms
3:2	down1_debpf	R/W	11	DOWN1 power failure debounce time; settings like <i>auto_debpf</i>
5:4	down2_debpf	R/W	11	DOWN2 power failure debounce time; settings like <i>auto_debpf</i>
7:6	led_debpf	R/W	11	LED power failure debounce time; settings like <i>auto_debpf</i>

^[1] This register is reset in NoPower state.

Table 43. DEBPF2 - Power fail debounce register 2 (address 3Eh) bit description

Bit	Symbol	Access	Reset[1]	Description
1:0	ldo1_debpf	R/W	11	LDO1 power failure debounce time 00: none 01: 1 ms 10: 10 ms 11: 100 ms

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Table 43. DEBPF2 - Power fail debounce register 2 (address 3Eh) bit description ...continued

Bit	Symbol	Access	Reset[1]	Description
3:2	ldo2_debpf	R/W	11	LDO2 power failure debounce time; settings like <i>Ido1_debpf</i>
5:4	ldo3_debpf	R/W	11	LDO3 power failure debounce time; settings like <i>Ido1_debpf</i>
7:6	ldo4_debpf	R/W	11	LDO4 power failure debounce time; settings like <i>Ido1_debpf</i>

^[1] This register is reset in NoPower state.

Table 44. DEBPF3 - Power fail debounce register 3 (address 3Fh) bit description

Bit	Symbol	Access	Reset[1]	Description
1:0	ldo5_debpf	R/W	11	LDO5 power failure debounce time 00: none 01: 1 ms 10: 10 ms 11: 100 ms
3:2	ldo6_debpf	R/W	11	LDO6 power failure debounce time; settings like <i>Ido5_debpf</i>
5:4	hcldo_debpf	R/W	11	HCLDO power failure debounce time; settings like <i>Ido5_debpf</i>
7:6	reserved			

^[1] This register is reset in NoPower state.

Table 45. DCDCSTAT - DC-to-DC converter status register (address 41h) bit description

D.,			B 1.4
Bit	Symbol	Access	Description
0	auto_pwrok	R	0: AUTO V_0 < 90% of target 1: AUTO V_0 > 90% of target
1	down1_pwrok	R	0: DOWN1 V_O < 90% of target 1: DOWN1 V_O > 90% of target
2	down2_pwrok	R	0: DOWN2 V_O < 90% of target 1: DOWN2 V_O > 90% of target
3	led_pwrok	R	0: LED I _O < 90% of target 1: LED I _O > 90% of target
7:4	reserved		

Table 46. LDOSTAT - LDO status register (address 42h) bit description

Bit	Symbol	Access	Description
0	ldo1_pwrok	R	0: LDO1 V_O < 90% of target 1: LDO1 V_O > 90% of target
1	ldo2_pwrok	R	0: LDO2 V _O < 90% of target 1: LDO2 VV _O > 90% of target
2	ldo3_pwrok	R	0: LDO3 V _O < 90% of target 1: LDO3 V _O > 90% of target
3	ldo4_pwrok	R	0: LDO4 V _O < 90% of target 1: LDO4 V _O > 90% of target

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Bit	Symbol	Access	Description
4	ldo5_pwrok	R	0: LDO5 V_0 < 90% of target 1: LDO5 V_0 > 90% of target
5	ldo6_pwrok	R	0: LDO6 V_O < 90% of target 1: LDO6 V_O > 90% of target
6	hcldo_pwrok	R	0: HCLDO V_O < 90% of target 1: HCLDO V_O > 90% of target
7	hcldo_ovl	R	0: HCLDO is not in overload mode

1: HCLDO is in overload mode

Table 46. LDOSTAT - LDO status register (address 42h) bit description ...continued

8.8.6 Functional description

8.8.6.1 Power supply sequencing

The supply modules can be activated or deactivated during any of the four phases involved in a transition to or from the Active state (see <u>Section 8.1.6.8</u>). This makes it possible to satisfy supply sequence requirements and reduces battery load by spreading inrush current peaks over time.

Each supply is assigned to one of the four phases by means of the associated *x_ena_act* control bits in the relevant control register (see, for example, control bits *auto_ena_act* in Table 51).

8.8.6.2 Supply module activation

When the PCF50633 is in Active state, each supply module can be activated/deactivated individually according to the settings of the following control bits:

- The x_ena_act control bits which determine which activation phase is associated with the module (see, for example auto_ena_act which, when = 00, selects activation phase 1 for the Auto converter; see Table 51)
- The x_pxc control bits. When an x_pxc control bit is set, the module is activated if the
 associated GPIOx pin goes HIGH (see, for example, auto_p1c which, when set, turns
 the AUTO converter on when GPIO1 = 1; see Table 51)
- The x_on control bit which, when set, activates the module during the assigned activity phase regardless of the state of the **GPIOx** pins (see, for example, auto_on which, when set, turns the AUTO converter ON, ignoring the state of the **GPIOx** pins).

For each supply module, there is an associated control register containing these control bits (see, for example, register *AUTOENA* for AUTO; <u>Table 51</u>). Their reset values are mask programmable.

All LDOs can be enabled in Standby state, as well as in Active state. Control bit x_ena_stb determines whether an LDO will be on or off in Standby state (see <u>Table 40</u> and <u>Table 41</u>).

The volatile memory is intended to be supplied by DOWN2 in Active state, and by MEMLDO in non-active states:

 DOWN2 is enabled in Active state if down2_on is set or if one of the down2_pxc bits is set and the associated GPIOx pin is HIGH. DOWN2 cannot be active in any other state (see <u>Table 59</u>)

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 MEMLDO can be enabled in Active and Standby states, according to the settings of memldo_ena_act, memldo_ena_stb and memldo_pxc (see <u>Table 41</u> and <u>Table 63</u>). Note, however, that MEMLDO is automatically disabled if DOWN2 is enabled.

The LDOs can be enabled in the Standby state, as well as in the Active state. The DC-to-DC converters can only be enabled in the Active state. Since converters are more efficient than LDOs, they are usually employed in preference to LDOs in the Active state when possible. MEMLDO and DOWN2 will normally be programmed to deliver the same output voltage. DOWN2 will be employed in the Active state while MEMLDO will be enabled when the PCF50633 is in Standby.

8.8.6.3 Power failure detection

Power failure detection is implemented for all regulators except MEMLDO. A power failure is detected when the module is enabled and its output voltage is lower than 90% of the target value for a period longer than the power failure detection debounce time.

The power failure detection debounce time can be set to any of 4 values via the x_debpf control bits (see <u>Table 42</u>, <u>Table 43</u> and <u>Table 44</u>). Both falling and rising edges of the power failure signal are debounced.

When a supply module is switched on, the associated x_pwrok control bit (see <u>Table 45</u> and <u>Table 46</u>) is masked for a period of 100 ms. This is to ensure a power failure is not erroneously detected at start-up.

A power failure condition is signaled to the interrupt module which then generates an *xpwrfail* interrupt. The supply module will not be switched off. The Host controller should take appropriate action.

8.9 AUTO, DOWN1 and DOWN2 converters

8.9.1 Introduction

The PCF50633 contains two inductive step-down converters (DOWN1 and DOWN2) capable of delivering output currents up to 500 mA and one inductive auto step-up/step-down converter (AUTO) capable of delivering an output current of 1.1 A. DOWN2 incorporates a parallel linear regulator (MEMLDO) for use in Standby state. All the converters can be switched on or off under software control, either directly via the I²C-bus or by configuring the **GPIOx** pins as power supply enable inputs. Note that AUTO, DOWN1 and DOWN2 can only be enabled in the Active state.

8.9.2 Features

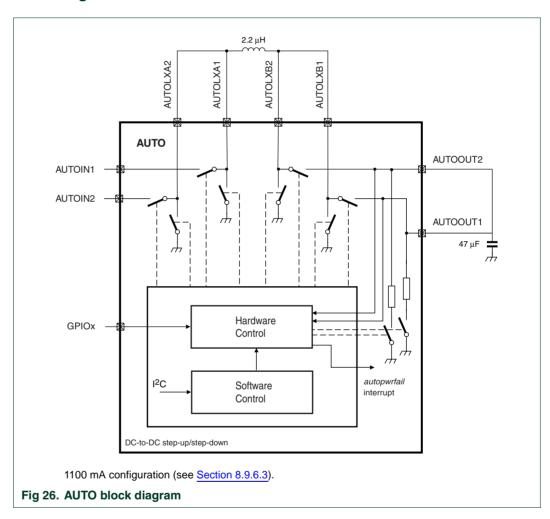
- Digital control with automatic changeover between PWM and PFM modes
- High switching frequency (1.7 MHz) allowing the use of small value inductors and output capacitors
- No adjustments of dynamic response required; the digital control technology ensures stable operation under all conditions
- Suitable for low-ESR output capacitors thanks to current-mode control; Elcos or tantalum capacitors cannot be used
- Power stage with synchronous rectification
- No external components required other than an inductor and an output capacitor

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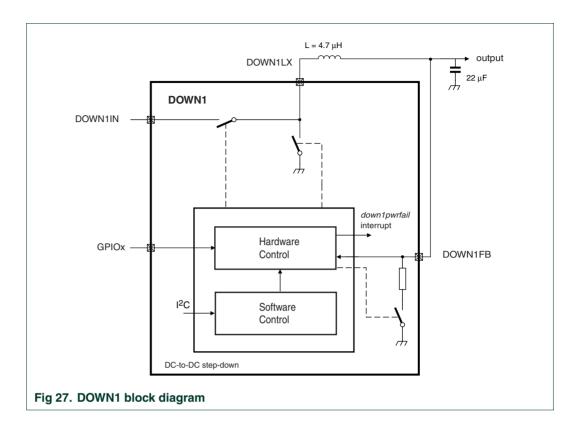
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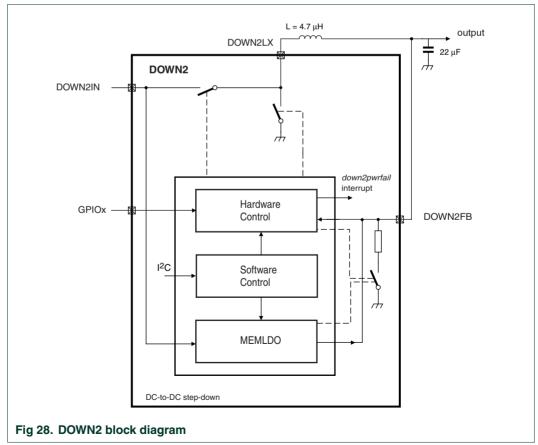
- High output voltage accuracy
- Programmable internal feedback divider, with output voltage programmable in 25 mV steps
- Primary peak current limiting
- Programmable inrush current limiting.

8.9.3 Block diagrams



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8.9.4 Hardware interface

Table 47. AUTO characteristics

 $V_{SS} = REFGND = GND = 0 \text{ V}; T_{amb} = -40 \text{ to } +85 \text{ }^{\circ}\text{C}; \text{ unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Io	output current	1.1 A configuration	-	-	1100	mA
		500 mA configuration	-	-	500 ^[1]	mA
VI	input voltage		2.7	-	5.3	V
$V_{O(prog)}$	programmable output voltage	programmed via auto_out bits	1.8	-	3.8	V
V _{O(step)}	output voltage step size		-	25	-	mV
Vo	output voltage		-5	V _{O(prog)}	+3	%
V _{O(rppl)}	output voltage ripple		-	-	15	mV
f _{sw(PWM)}	PWM switching frequency		-	1.7	-	MHz
R _{pd(ext)}	internal pull-down resistor connected to the output	AUTO is disabled	-	80	-	Ω

^[1] Smaller external components can be used in the 500 mA configuration. The AUTOLXA2 and AUTOLXB1 pins must be left floating in this configuration (see Section 8.9.6.3).

Table 48. DOWN1 and DOWN2 characteristics

 $V_{SS} = REFGND = GND = 0 \text{ V}; T_{amb} = -40 \text{ to } +85 \text{ }^{\circ}\text{C}; \text{ unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _O	output current		-	-	500	mA
VI	input voltage		2.7	-	5.3	V
V _{O(prog)}	programmable output voltage	programmed via downx_out bits	0.625	-	3.0	V
V _{O(step)}	output voltage step size		-	25	-	mV
Vo	output voltage		-3	V _{O(prog)}	+3	%
V _{O(rppl)}	output voltage ripple		-	-	15	mV
f _{sw(PWM)}	PWM switching frequency		-	1.7	-	MHz
R _{pd(ext)}	internal pull-down resistor connected to the output	DOWNx is disabled	-	120	-	Ω

Table 49. MEMLDO characteristics[1]

 $V_{SS} = REFGND = GND = 0 \text{ V; } T_{amb} = -40 \text{ to } +85 \text{ }^{\circ}\text{C; unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Io	output current		-	-	1	mA
VI	input voltage	LDO operated as regulator	2.7	-	5.5	V
		LDO operated as low ohmic switch	1.8	-	5.5	V
V _{O(prog)}	programmable output voltage	programmed via memldo_out bits	0.9	-	3.6	V
V _{O(step)}	output voltage step size		-	100	-	mV
Vo	output voltage		-3.0	$V_{O(prog)}$	+3	%
$\Delta V_{O}/\Delta I_{L}$	load regulation		-	1.0	-	%/mA
$\Delta V_{O}/\Delta V_{I}$	line regulation		-	1	2	mV/V

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 MEMLDO shares input (DOWN2IN) and output (DOWN2FB) pins with DOWN2. MEMLDO is automatically disabled if DOWN2 is enabled.

8.9.5 Software interface

Table 50. AUTOOUT - AUTO output voltage select register (address 1Ah) bit description[1]

Bit	Symbol	Access	Description
7:0	auto_out	R/W	V _{O(prog)} = 0.625 + auto_out × 0.025 V eg. 00000000 to 00101110: reserved 00101111: 1.8 V (min) 01010011: 2.7 V 01101010: 3.275 V 01101011: 3.300 V 01101100: 3.325 V 01111111 : 3.800 V (max)
			11111110 : 3.800 V 11111111 : 3.800 V

^[1] This register is reset at each transition to Standby state. Reset value is determined by the IC variant (see Table 7).

Table 51. AUTOENA - AUTO output enable register (address 1Bh) bit description

Bit	Symbol	Access	Reset[1]	Description
0	auto_on	R/W	[2]	if set, converter is ON
1	auto_p1c	R/W	[2]	if set, converter is ON when GPIO1 = 1
2	auto_p2c	R/W	[2]	if set, converter is ON when GPIO2 = 1
3	auto_p3c	R/W	[2]	if set, converter is ON when GPIO3 = 1
5:4	auto_ena_act	R/W	[2]	selects activation phase: 00: ACTPH1 01: ACTPH2 10: ACTPH3 11: ACTPH4
7:6	reserved			

^[1] This register is reset at each transition to Standby state.

Table 52. AUTOCTL - AUTO control register (address 1Ch) bit description

Bit	Symbol	Access	Reset[1]	Description
0	autopwmonly	R/W	0	automatic PFM-PWM selection converter operates in PWM mode
1	auto_mod	R/W	0	selects regulator type: 0: auto up/down; 1: down-only
7:2	reserved			

^[1] This register is reset at each transition to Standby state.

^[2] Reset values are determined by the IC variant (see Table 7).

Table 53. AUTOMXC - AUTO maximum current register (address 1Dh) bit description[1]

Bit	Symbol	Access	Description
5:0	auto_maxc	R/W	sets current limit of AUTO converter $I_{I(max)} = auto_maxc \times 40 \text{ mA}$ e.g. $000101 = 200 \text{ mA}$
6	auto_maxcmod	R/W	current limit mode: 0: limiting at start-up only 1: limiting always active
7	reserved		

^[1] This register is reset at each transition to Standby state. Reset value is determined by the IC variant (see Table 7).

Table 54. DOWN1OUT - DOWN1 o/p voltage select register (address 1Eh) bit description[1]

Bit	Symbol	Access	Description
7:0	down1_out	R/W	$V_{O(prog)} = 0.625 + down1_out \times 0.025 \text{ V, e.g.}$ 000000000 : 0.625 V (min) 000101111 : 1.200 V 001011111 : 1.800 V 010111111 : 3.000 V (max)
			 11111110 : 3.000 V 11111111 : 3.000 V

^[1] This register is reset at each transition to Standby state. Reset value is determined by the IC variant (see Table 7).

Table 55. DOWN1ENA - DOWN1 output enable register (address 1Fh) bit description[1]

Bit	Symbol	Access	Reset	Description
0	down1_on	R/W	[2]	if set, converter is ON
1	down1_p1c	R/W	[2]	if set, converter is ON when GPIO1 = 1
2	down1_p2c	R/W	[2]	if set, converter is ON when GPIO2 = 1
3	down1_p3c	R/W	[2]	if set, converter is ON when GPIO3 = 1
5:4	down1_ena_act	R/W	[2]	selects activation phase: 00: ACTPH1 01: ACTPH2 10: ACTPH3 11: ACTPH4
7:6	reserved			

^[1] This register is reset at each transition to Standby state.

Table 56. DOWN1CTL - DOWN1 control register (address 20h) bit description

Bit	Symbol	Access	Reset[1]	Description
0	down1pwmonly	R/W	0	automatic PFM-PWM selection converter operates in PWM mode
4:1	down1_dvmstep	R/W	0000	DVM step time; defines number of 32768 Hz clock cycles between each step; e.g.: 0000: no DVM, 0001: 30 μs, 1111: 458 μs
7:5	reserved			

^[1] This register is reset at each transition to Standby state.

^[2] Reset values are determined by the IC variant (see Table 7).

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Table 57. DOWN1MXC - DOWN1 maximum current register (address 21h) bit description[1]

Bit	Symbol	Access	Description
5:0	down1_maxc	R/W	sets current limit of DOWN1 converter $I_{I(max)} = down1_maxc \times 15 \text{ mA}$ e.g. 01101 = 195 mA
6	down1_maxcmod	R/W	current limit mode: 0: limiting at start-up only 1: limiting always active
7	reserved		

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

Table 58. DOWN2OUT - DOWN2 o/p voltage select register (address 22h) bit description[1]

Bit	Symbol	Access	Description
7:0	down2_out	R/W	output voltage setting: same as for down1_out (see <u>Table 54</u>)

^[1] This register is reset at each transition to Standby state. Reset value is determined by the IC variant (see Table 7).

Table 59. DOWN2ENA - DOWN2 output enable register (address 23h) bit description[1]

Bit	Symbol	Access	Reset	Description
0	down2_on	R/W	[2]	if set, converter is ON
1	down2_p1c	R/W	[2]	if set, converter is ON when GPIO1 = 1
2	down2_p2c	R/W	[2]	if set, converter is ON when GPIO2 = 1
3	down2_p3c	R/W	[2]	if set, converter is ON when GPIO3 = 1
5:4	down2_ena_act	R/W	[2]	selects activation phase: 00: ACTPH1
7:6	reserved			

^[1] This register is reset at each transition to Standby state.

Table 60. DOWN2CTL - DOWN2 control register (address 24h) bit description

Bit	Symbol	Access	Reset[1]	Description
0	down2pwmonly	R/W	0	automatic PFM-PWM selection converter operates in PWM mode
4:1	down2_dvmstep	R/W	0000	DVM step time, defines number of 32768 Hz clock cycles between each step e.g.: 0000: no DVM, 0001: 30 μs, 1111: 458 μs
7:5	reserved			

^[1] This register is reset at each transition to Standby state.

^[2] Reset values are determined by the IC variant (see <u>Table 7</u>).

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Table 61. DOWN2MXC - DOWN2 maximum current register (address 25h) bit description[1]

Bit	Symbol	Access	Description
5:0	down2_maxc	R/W	sets current limit of DOWN2 converter $I_{l(max)} = down2_maxc \times 15 \text{ mA}$ e.g. 01101 = 195 mA
6	down2_maxcmod	R/W	current limit mode: 0: limiting at start-up only 1: limiting always active
7	reserved		

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

Table 62. MEMLDOOUT - MEMLDO o/p voltage select reg. (address 26h) bit description[1]

Bit	Symbol	Access	Description
4:0	memldo_out	R/W	V _{O(prog)} = 0.9 + memldo_out × 0.1 V; e.g. 00000: 0.9 V 00001: 1.0 V 11000: 3.3 V 11011: 3.6 V 11111: 3.6 V
5	memldo_swmod	R/W	0: linear regulator mode 1: switch mode
7:6	reserved		

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

Table 63. MEMLDOENA - MEMLDO output enable register (address 27h) bit description[1]

Bit	Symbol	Access	Description
0	memldo_on	R/W	if set, LDO is ON
1	memldo_p1c	R/W	if set, LDO is ON when GPIO1 = 1
2	memldo_p2c	R/W	if set, LDO is ON when GPIO2 = 1
3	memldo_p3c	R/W	if set, LDO is ON when GPIO3 = 1
5:4	memldo_ena_act	R/W	selects activation phase: 00: ACTPH1 01: ACTPH2 10: ACTPH3 11: ACTPH4
7:6	reserved		

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

Table 64. DCDCPFM - DCDC force PFM control (address 84h) bit description[1]

Bit	Symbol	Access	Description
0	autopfm ^[2]	R/W	if set, the AUTO converter is temporarily forced to PFM mode.

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Table 64. DCDCPFM - DCDC force PFM control (address 84h) bit description [1] continued
--

Bit	Symbol	Access	Description
1	down1pfm ^[2]	R/W	if set, the DOWN1 converter is temporarily forced to PFM mode.
2	down2pfm ^[2]	R/W	if set, the DOWN2 converter is temporarily forced to PFM mode.
7:3	reserved		

- [1] Register is reset in NoPower state.
- [2] Bits are cleared when action finished.

8.9.6 Functional description

8.9.6.1 Current limiting

All three DC-to-DC converters feature built-in programmable peak current limiting. This makes it possible to control converter inrush currents at start-up and, optionally, during the entire activation period.

The maximum peak current is set via x_maxc bits in the AUTOMXC and DOWNxMXC control registers (see <u>Table 53</u>, <u>Table 57</u> and <u>Table 61</u>) If the $x_maxcmod$ bit is set, the current limit will be imposed at all times. Otherwise, the inrush current will be limited from start-up until the converter output reaches its target level.

Note that the programmed current limit represents the inductor peak current. Since the current waveform will be triangular in shape, the average value will be somewhat lower.

Further inrush current control can be achieved by spreading the start-up events over time by assigning the converters to different activation phases (see Section 8.1.6.8).

8.9.6.2 Dynamic voltage management (DOWN1 and DOWN2)

Both step-down converters offer dynamic voltage management (DVM) in order to ensure smooth transitions between operating voltages. The DVM implemented In the PCF50633 does not require additional output voltage registers. It functions as follows:

When a new *down1_out* or *down2_out* output voltage is set (see <u>Table 54</u> and <u>Table 58</u>), the digital controller will increase or decrease the output voltage in 25 mV steps until the target voltage has been achieved. The delay between steps can be specified for each converter individually by means of the *x_dvmstep* control bit (bits 4:1 in the *DOWNxCTL* control registers; see <u>Table 56</u> and <u>Table 60</u>). The *x_dvmstep* bit value specifies the number of 32768 Hz clock cycles between each 25 mV step. When this value is set to 0000, the transition between current and target voltages will be immediate.

The duty cycle of both converters can reach 100%, in which case the input voltage will approach the value of the target output voltage.

A pull-down switch on the output of DOWN1 guarantees an output voltage of 0 V when the converter is switched off.

A pull-down switch on the output of DOWN2 guarantees an output voltage of 0 V when both DOWN2 and MEMLDO are switched off.

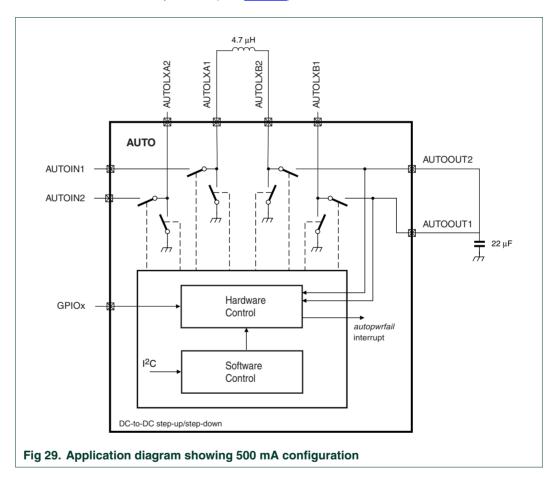
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8.9.6.3 AUTO configuration

The auto step-up/step-down converter can be configured as a regular step-down converter. This facilitates the optimal use of all power switches for maximum efficiency.

The *auto_mod* bit in the converter control register, which is mask programmable, determines the operating mode: auto step-up/step-down or down-only mode (see Table 52).

AUTO can be configured to deliver a maximum output current of either 500 mA or 1100 mA. Reducing the current capability from 1100 mA to 500 mA makes it possible to use smaller external components (see <u>Table 2</u>).



The pin configuration depends on the selected operating mode and the required current capability, as illustrated in <u>Table 65</u>.

Table 65. AUTO pin configuration

Mode	AUTO_MOD bit	AUTOIN1/2	AUTOLXA1	AUTOLXA2	AUTOLXB1	AUTOLXB2	AUTOOUT1/2
Auto (1.1A)	0	input	LXA[1]	LXA[1]	LXB[1]	LXB[1]	output
Auto (500mA)	0	input	LXA[1]	floating	floating	LXB[1]	output
Down-only (1.1A)	1	input	LXA[1]	LXA[1]	floating	floating	output

^[1] LXA and LXB are the inductor nodes on the PCB.

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The 500 mA configuration is depicted in <u>Figure 29</u> (see <u>Figure 26</u> for an illustration of the 1100 mA configuration).

Pull-down switches on the outputs guarantees an output voltage of 0 V when the converter is switched off.

8.10 LED boost converter & Ambient Light Monitor (ALM)

8.10.1 Introduction

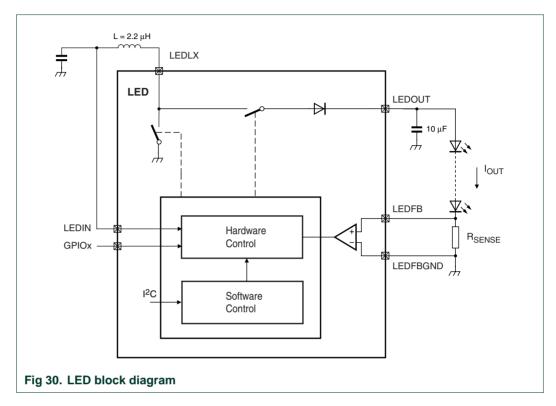
The LED converter is a dedicated boost converter capable of driving a chain of LEDs.

8.10.2 Features

- · LED current control by means of an external sense resistor
- Digitally controlled Pulse Frequency Modulation (PFM)
- Bus-controlled dimming by logarithmic scaling of the LED current
- Digital ramp-up and ramp-down control for smooth on/off transitions using the logarithmic dimming scale
- Ambient light sensor
- Inrush current limiting
- Overcurrent protection
- Overvoltage protection. Maximum output voltage of V_{O(LED)(max)}. using internal switch, or greater using additional discrete components
- · Output disconnected from input when switched off
- Module can also be used to create a 5 V/100 mA USB supply.

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8.10.3 Block diagram



8.10.4 Hardware interface

Table 66. LED characteristics

 $V_{SS} = REFGND = GND = 0 \text{ V; } T_{amb} = -40 \text{ to } +85 \text{ °C; unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{O(LED)}$	LED output voltage		5	-	18	V
I _{O(LED)}	LED output current	$V_{O(LED)} = 18 \text{ V}$	-	-	25	mA
		$V_{O(LED)} = 5 V_{1}$	-	-	100	mΑ
V_{LEDFB}	voltage on pin LEDFB		1/512 × 1.25	-	1.25	V
$V_{th(ovp)}$	over-voltage protection threshold voltage		18	19	20	V
$V_{th(OCP)}$	over-current protection threshold	led_ocp = 0	-	1000	-	mA
	voltage	led_ocp = 1	-	500	-	mA
f _{sw(PFM)}	PFM switching frequency		-	-	1	MHz

^[1] A 5 V/100 mA USB supply source can be generated by configuring the LED supply module as a boost converter (see Section 8.10.6.7).

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8.10.5 Software interface

Table 67. LEDOUT - LED output voltage select register (address 28h) bit description

Bit	Symbol	Access	Reset[1]	Description
5:0	led_out	R/W	1111112	output current setting: $I_{LED} = V_{LEDFB}/R_{SENSE}$; examples from the 6-bit semi-logarithmic range Code V _{LEDFB} (mV)[3] 000000 : reserved 000001 : 2 000011 : 10 001000 : 27 001010 : 37 001110 : 56 010010 : 81 010110 : 113 011010 : 149 011110 : 196 100010 : 250 100110 : 318 101010 : 401 101110 : 501 110010 : 626 110110 : 778 111010 : 961 111111 : 1250

7:6 reserved

Table 68. LEDENA - LED output enable register (address 29h) bit description[1]

Bit	Symbol	Access	Description
0	led_on	R/W	if set, LED converter is ON
1	led_p1c	R/W	if set, LED is ON when GPIO1 = 1
2	led_p2c	R/W	if set, LED is ON when GPIO2 = 1
3	led_p3c	R/W	if set, LED is ON when GPIO3 = 1
5:4	led_ena_act	R/W	selects activation phase 00: ACTPH1 01: ACTPH2 10: ACTPH3 11: ACTPH4
7:6	reserved		

^[1] This register is reset at each transition to Standby state.

^[1] This register is reset at each transition to Standby state.

^[2] *led_out* should never be set to 000000, as this would result in a deadlock making it impossible to program another value. If *led_out* should be inadvertently set to 000000, the *LEDOUT* register can be reset by disabling and enabling the LED converter via control bit *led_on* in the *LEDENA* register (see Table 68).

^[3] V_{LEDFB} , the voltage across $R_{\text{SENSE}} = (e^{\frac{led_{out}/20}{20}} - 1)/(e^{\frac{63}{20}} - 1) \times 1.25 \ V$ (see Section 8.10.6.1).

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Table 69. LEDCTL - LED control register (address 2Ah) bit description

Bit	Symbol	Access	Reset[1]	Description
0	led_ovpon	R/W	1	overvoltage protection disabled overvoltage protection enabled
1	led_ovprst[2]	R/W	0	0: no action 1: resets overvoltage protection
2	led_ocp	R/W	0	0: OCP limit is 1000 mA 1: OCP limit is 500 mA
7:3	reserved		_	

^[1] This register is reset at each transition to Standby state.

Table 70. LEDDIM - LED ramp control register (address 2Bh) bit description

Bit	Symbol	Access	Reset[1]	Description
7:0	led_dimstep	R/W	00000001	binary coded step time for dimming curve: $t_{dimstep} = 16 \times led_dimstep / 32768$

^[1] This register is reset at each transition to Standby state.

Table 71. ALMGAIN - Ambient lighting gain factor register (address 4Fh) bit description

Bit	Symbol	Access	Reset[1]	Description
4:0	alm_gain	R/W	00000	ambient light processing gain factor
7:5	reserved		_	

^[1] This register is reset at each transition to Standby state.

Table 72. ALMDATA - Ambient light intensity data register (address 50h) bit description

Bit	Symbol	Access	Reset[1]	Description
7:0	alm_data	R	00000000	ambient light intensity data

^[1] This register is reset at each transition to Standby state.

8.10.6 Functional description

8.10.6.1 Control functionality

The LED converter employs a pulse frequency mode control scheme, which regulates the voltage between the **LEDFB** and **LEDFBGND** pins (V_{LEDFB}). This voltage, which determines the dimming level, is set via the *led_out* control bits in the *LEDOUT* register (see <u>Table 67</u>). The sense resistor connecting these pins transforms this voltage into a current in the LED string.

The maximum (and default) LED current through the sense resistor is defined by the formula:

$$I_{LED} = 1.25/R_{SENSE}$$
 A (1)

The default value for *led_out* (111111) is assumed in the above equation. A lower continuous current level can be set by changing the value of *led_out* (see Table 67).

The voltage across R_{SENSE} is determined by the formula:

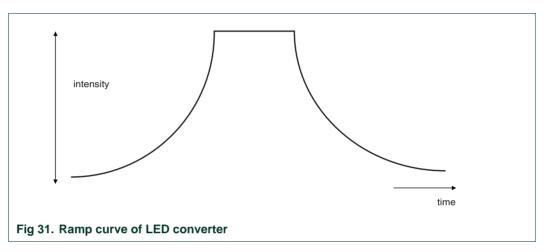
^[2] This control bit is not automatically cleared.

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$$V_{LEDFB} = \frac{e^{led_out/20} - 1}{e^{63/20} - 1} \times 1.25 \text{ V}$$
 (2)

8.10.6.2 Ramp control

The ramp controller creates a smooth semi-logarithmic ramp-up or ramp-down of the LED current when the LED module is switched on or off. The maximum value is determined by the settings of the *led_out* control bits. The ramp time is set by the *led_dimstep* control bits in the *LEDDIM* register (see Table 70).



8.10.6.3 Overvoltage protection

The overvoltage protection circuit checks for an overvoltage condition on the output of the LED converter. The overvoltage protection limit is set to $V_{O(LED)(max)}$. Overvoltage protection can be disabled by clearing the *led_ovpon* bit in the *LEDCTL* register (see Table 69).

When an overvoltage is detected, an *ledovp* interrupt is generated and the LED module is shut down. The module can be restarted by setting the *led_ovprst* bit in the *LEDCTL* register.

8.10.6.4 Overcurrent protection

Overcurrent protection is implemented to avoid saturation of the external coil. The overcurrent protection limit is programmable to 500 mA or 1000 mA via the *led_ocp* control bit in the *LEDCTL* register (see <u>Table 69</u>).

The circuit measures the current through the primary switch and disables the switch as soon as the current exceeds the OCP limit. Current limiting is performed cycle by cycle, and no signalling to the interrupt generator or to the OOC block is implemented.

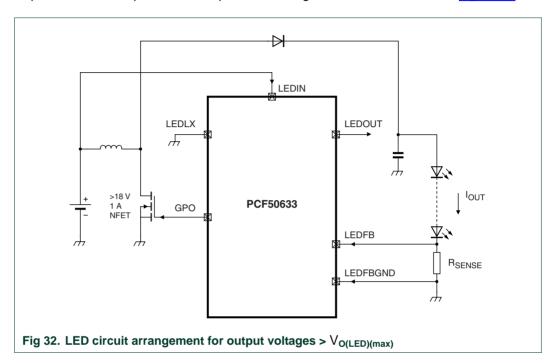
8.10.6.5 Inrush current limiting

At start-up, the output node is raised to the input voltage level using a small current. Thereafter, regular control of the converter is asserted. Consequently, inrush currents will never exceed the normal input current at full load.

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8.10.6.6 Generating output voltages over V_{O(LED)(max)}

The controller can generate output voltages in excess of $V_{O(LED)(max)}$ with the aid of additional discrete components. The GPO output can drive a discrete N-type FET when the *gposel* bits in register *GPOCFG* are set to 001 (see <u>Table 33</u>). A discrete diode is required to create a path to the output. The arrangement is shown below in Figure 32.



If required, the input voltage can be prevented from being transferred to the output when the LED module is disabled. This can be achieved with the addition of a PFET, controlled by the GPIO output configured to ensure the PFET is active only while the LED module is enabled. This arrangement is shown below in Figure 33.

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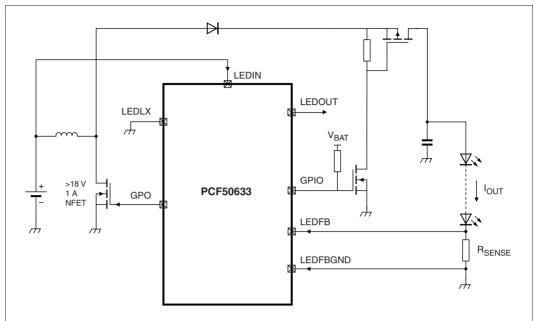
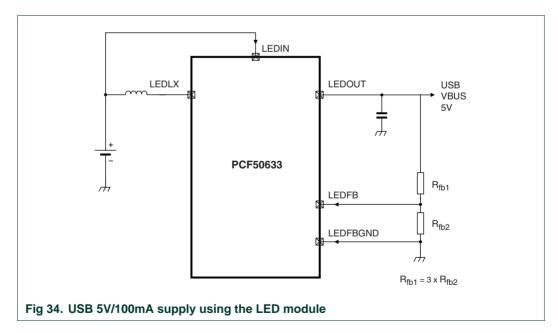


Fig 33. LED circuit arrangement for output voltages $> V_{O(LED)(max)}$ with output disconnected from input when converter is off.

8.10.6.7 Generating a 5V USB supply

A 5 V/100 mA USB supply source can be generated by configuring the LED supply module as a boost converter. The LED chain and the current sense resistor are replaced with a regular voltage divider as illustrated in Figure 34.

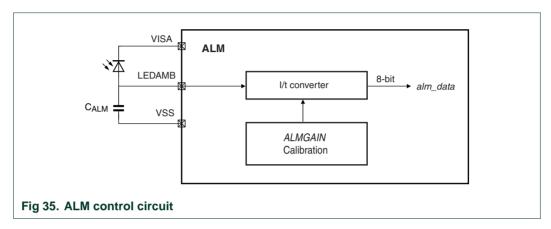


The formula $R_{fb1} = 3 \times R_{fb2}$ in Figure 34 assumes the default output voltage, $V_{LEDFB} = 1.25 \text{ V}$, has been selected ($led_out = 1111111$; see Table 67).

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8.10.6.8 Ambient light monitor

The ambient light monitor can be used to adjust the LED current in response to changes in ambient light levels. The current through an external photodiode is measured and stored in the *ALMDATA* register (see <u>Table 72</u>). The host controller can adjust the *led_out* bit settings in response to changes in this value.



The ambient light level is measured by an external photodiode connected between the **VISA** and **LEDAMB** pins using a current-to-time converter circuit, which provides at least a 3 decade photo current range.

The full scale setting is determined by the value of the capacitor connected between the **LEDAMB** and **REFGND** pins and the *alm_gain* gain bits in the *ALMGAIN* control register (see Table 71). The value of the capacitor is determined by the equation,

$$C_{ALM} = I_{D(max)} \times 76 \text{ us} \tag{3}$$

where $I_{D(max)}$ represents the photodiode current under maximum ambient lighting conditions.

The *alm_gain* control bits make it possible to adjust the ambient light control loop for variations in the sensitivity of the photodiode.

The ambient light measurement is repeated every 20 ms. A low pass filter removes high frequency disturbances from the ambient light control loop.

The **LEDAMB** pin can be grounded or left open if the ambient light monitor is not being used.

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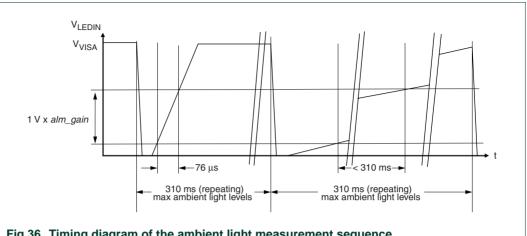


Fig 36. Timing diagram of the ambient light measurement sequence

8.11 Linear regulators

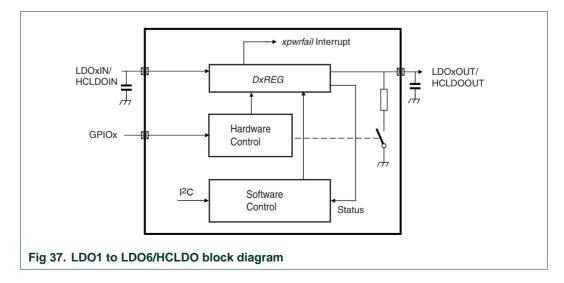
8.11.1 Introduction

The PCF50633 contains 7 general purpose regulators, LDO1 to LDO6 and HCLDO.

8.11.2 Features

- Low drop-out voltage
- · Low quiescent current at no load in normal operating mode, eliminating the need for special power-saving modes
- Programmable output voltage in 100 mV steps
- Power fail detection at 90% of the target output voltage, resulting in an interrupt (see Section 8.8.6.3)
- Switch mode, resulting in a low-resistive path between input and output at minimum quiescent current.

8.11.3 Block diagram



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8.11.4 Hardware interface

Table 73. LDO1, LDO2, LDO3 and LDO6 characteristics $V_{SS} = REFGND = GND = 0 \ V; T_{amb} = -40 \ to +85 \ ^{\circ}C; unless otherwise specified.$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Io	output current		-	-	50	mA
VI	input voltage	LDO operated as regulator	2.7	-	5.5	V
		LDO operated as low ohmic switch	1.8	-	5.5	V
$V_{O(prog)}$	programmable output voltage	programmed via <i>Idox_out</i> bits	0.9	-	3.6	V
V _{O(step)}	output voltage step size		-	100	-	mV
Vo	output voltage		-2.5	V _{O(prog)}	+2.5	%
$\Delta V_O/\Delta I_L$	load regulation		-	0.03	-	%/mA
$\Delta V_O/\Delta V_I$	line regulation		-	1	2	mV/V
V_{pwrok}	power OK level		-	$0.9 \times V_{O(prog)}$	-	V
PSRR	power supply rejection ratio	f < 100 kHz	-	60	-	dB
ΔV_{I-O} [1]	voltage drop from input to output		-	-	250	mV
R _{pd(ext)}	value of the pull down resistor connected to the output	LDO is disabled	-	2	-	kΩ
R _{DSon}	drain-source on-state	V _I = 2.7 V	-	4	-	Ω
	resistance[2]	V _I = 5 V	-	3	-	Ω

^[1] ΔV_{I-O} is defined as the voltage difference between input and output when the output is 1% below a reference voltage, V_{REF} , and is the minimum voltage drop required to ensure reliable operation. V_{REF} is the voltage measured at the output with V_I set to $V_{O(proq)}$ +1 V_I .

Table 74. LDO4 and LDO5 characteristics $V_{SS} = REFGND = GND = 0 \ V; T_{amb} = -40 \ to +85 \ ^{\circ}C; unless otherwise specified.$

$\begin{array}{c} V_{I} \\ V_{I} \\ \end{array} \begin{array}{c} \text{input voltage} \\ \end{array} \begin{array}{c} \text{LDO operated as} \\ \end{array} \begin{array}{c} 2.7 \\ \end{array} \begin{array}{c} - \\ \end{array} \begin{array}{c} 5.5 \\ \end{array} \begin{array}{c} V \\ \end{array} \\ \end{array} \\ V_{O(\text{prog})} \\ \end{array} \begin{array}{c} \text{programmable output voltage} \\ V_{O(\text{step})} \\ \end{array} \begin{array}{c} \text{programmed via} \\ 0.9 \\ \end{array} \begin{array}{c} - \\ \end{array} \begin{array}{c} 3.6 \\ \end{array} \begin{array}{c} V \\ \end{array} \\ V_{O(\text{step})} \\ \end{array} \begin{array}{c} \text{output voltage step size} \\ \end{array} \begin{array}{c} - \\ \end{array} \begin{array}{c} -2.5 \\ \end{array} \begin{array}{c} V_{O(\text{prog})} \\ \end{array} \begin{array}{c} +2.5 \\ \% \\ \end{array} \\ \Delta V_{O}/\Delta I_{L} \\ \end{array} \begin{array}{c} \text{load regulation} \\ \end{array} \begin{array}{c} - \\ \end{array} \begin{array}{c} 0.01 \\ \end{array} \begin{array}{c} - \\ \end{array} \begin{array}{c} 5.5 \\ \end{array} \begin{array}{c} V \\ \end{array} \\ \end{array} \\ \end{array}$				•			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$ \frac{\text{regulator}}{\text{LDO operated as low ohmic switch}} \\ V_{O(\text{prog})} \text{programmable output voltage} \frac{\text{programmed via}}{\text{Idox_out bits}} \\ 0.9 - 3.6 \text{V} \\ V_{O(\text{step})} \text{output voltage step size} \\ V_{O} \text{output voltage} \\ \Delta V_{O}/\Delta I_{L} \text{load regulation} \\ \Delta V_{O}/\Delta V_{I} \text{line regulation} \\ V_{\text{pwrok}} \text{power OK level} \\ \\ \hline \\ \frac{\text{regulator}}{\text{LDO operated as low ohmic switch}} \\ 0.9 - 3.6 \text{V} \\ 0.9 - 100 \text{m}^{2} \\ 0.9 - 2.5 V_{O(\text{prog})} +2.5 \% \\ 0.01 - 3.6 \text{V} \\ 0.9 - 3.$	I _O	output current		-	-	150	mA
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	VI	input voltage	•	2.7	-	5.5	V
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				1.8	-	5.5	V
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	V _{O(prog)}	programmable output voltage	. •	0.9	-	3.6	V
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	V _{O(step)}	output voltage step size		-	100		mV
	Vo	output voltage		-2.5	$V_{O(prog)}$	+2.5	%
V_{pwrok} power OK level - $0.9 \times$ - V	$\Delta V_{O}/\Delta I_{L}$	load regulation		-	0.01		%/mA
- pwick personal and a second a	$\Delta V_O/\Delta V_I$	line regulation		-	1	2	mV/V
	V _{pwrok}	power OK level		-		-	V

^[2] Input-to-output resistance in Switch mode.

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 Table 74.
 LDO4 and LDO5 characteristics ...continued

 $V_{SS} = REFGND = GND = 0 \text{ V}; T_{amb} = -40 \text{ to } +85 \text{ }^{\circ}\text{C}; unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
PSRR	power supply rejection ratio	f < 100kHz	-	60		dB
ΔV_{I-O} [1]	voltage drop		-		250	mV
R _{pd(ext)}	value of the pull down resistor connected to the output	LDO is disabled	-	0.8	-	Ω
R _{DSon}	drain-source on-state resistance ^[2]	V _I = 2.7 V	-	1.2	-	Ω
		V _I = 5 V	-	8.0	-	Ω

^[1] ΔV_{I-O} is defined as the voltage difference between input and output when the output is 1% below a reference voltage, V_{REF} , and is the minimum voltage drop required to ensure reliable operation. V_{REF} is the voltage measured at the output with V_I set to $V_{O(proq)}$ +1 V_I .

Table 75. HCLDO characteristics

 $V_{SS} = REFGND = GND = 0 \text{ V}; T_{amb} = -40 \text{ to } +85 \text{ °C}; unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _O	output current		-		200	mA
VI	input voltage	LDO operated as regulator	2.7	-	5.5	V
		LDO operated as low ohmic switch	1.8	-	5.5	V
V _{O(prog)}	programmable output voltage	programmed via hcldo_out bits	0.9	-	3.6	V
V _{O(step)}	output voltage step size		-	100	-	mV
Vo	output voltage		-2.5	$V_{O(prog)}$	+2.5	%
$\Delta V_{O}/\Delta I_{L}$	load regulation		-	0.01		%/mA
$\Delta V_{O}/\Delta V_{I}$	line regulation		-	1	2	mV/V
V_{pwrok}	power OK level		-	$0.9 \times V_{O(prog)}$	-	V
PSRR	power supply rejection ratio	f < 100 kHz	-	60	-	dB
ΔV_{I-O} [1]	voltage drop		-		250	mV
R _{pd(ext)}	value of the pull down resistor connected to the output	LDO is disabled	-	2	-	kΩ
I _{lim}	current limit		-	350	-	mA
R _{DSon}	drain-source on-state	$V_{I} = 2.7 \text{ V}$	-	1.2	-	Ω
	resistance[2]	V _I = 5 V	-	8.0	-	Ω

^[1] ΔV_{I-O} is defined as the voltage difference between input and output when the output is 1% below a reference voltage, V_{REF} , and is the minimum voltage drop required to ensure reliable operation. V_{REF} is the voltage measured at the output with V_I set to $V_{O(prog)}$ +1 V_I .

^[2] Input-to-output resistance in Switch mode.

^[2] Input-to-output resistance in Switch mode.

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8.11.5 Software interface

Table 76. LDO10UT - LDO1 output voltage select register (address 2Dh) bit description[1]

Bit	Symbol	Access	Description
4:0	ldo1_out	R/W	$V_{O(prog)} = 0.9 + Ido1_out \times 0.1 \text{ V (max 3.6V)}$; e.g.
			00000 : 0.9 V
			00001 : 1.0 V
			11000 : 3.3 V
			11011 : 3.6 V
			11111 : 3.6 V
5	ldo1_swmod	R/W	0: linear regulator mode
			1: switch mode
7:6	reserved		

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

Table 77. LDO1ENA - LDO1 output enable register (address 2Eh) bit description[1]

Bit	Symbol	Access	Description
0	ldo1_on	R/W	if set, LDO is ON
1	ldo1_p1c	R/W	if set, LDO is ON when GPIO1 = 1
2	ldo1_p2c	R/W	if set, LDO is ON when GPIO2 = 1
3	ldo1_p3c	R/W	if set, LDO is ON when GPIO3 = 1
5:4	ldo1_ena_act	R/W	selects activation phase: 00: ACTPH1 01: ACTPH2 10: ACTPH3 11: ACTPH4
7:6	reserved		

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

Table 78. LDO2OUT - LDO2 output voltage select register (address 2Fh) bit description[1]

Symbol	Access	Description
ldo2_out	R/W	$V_{O(prog)} = 0.9 + Ido2_out \times 0.1V \text{ (max 3.6 V); eg.}$
		00000 : 0.9 V
		00001 : 1.0 V
		11000 : 3.3 V
		11011 : 3.6 V
		11111 : 3.6 V
ldo2_swmod	R/W	0: linear regulator mode
		1: switch mode
reserved		
	ldo2_out	Ido2_out R/W Ido2_swmod R/W

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

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Table 79. LDO2ENA - LDO2 output enable register (address 30h) bit description[1]

Bit	Symbol	Access	Description
0	ldo2_on	R/W	if set, LDO is ON
1	ldo2_p1c	R/W	if set, LDO is ON when GPIO1 = 1
2	ldo2_p2c	R/W	if set, LDO is ON when GPIO2 = 1
3	ldo2_p3c	R/W	if set, LDO is ON when GPIO3 = 1
5:4	ldo2_ena_act	R/W	selects activation phase: 00: ACTPH1 01: ACTPH2 10: ACTPH3 11: ACTPH4
7:6	reserved		

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

Table 80. LDO3OUT - LDO3 output voltage select register (address 31h) bit description[1]

			, .
Bit	Symbol	Access	Description
4:0	ldo3_out	R/W	$V_{O(prog)} = 0.9 + Ido3_out \times 0.1 \text{ V (max 3.6 V); eg.}$
			00000: 0.9 V
			00001: 1.0 V
			11000 : 3.3 V
			11011 : 3.6 V
			11111 : 3.6 V
5	ldo3_swmod	R/W	0: linear regulator mode
			1: switch mode
7:6	reserved		

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

Table 81. LDO3ENA - LDO3 output enable register (address 32h) bit description[1]

Bit	Symbol	Access	Description
0	ldo3_on	R/W	if set, LDO is ON
1	ldo3_p1c	R/W	if set, LDO is ON when GPIO1 = 1
2	ldo3_p2c	R/W	if set, LDO is ON when GPIO2 = 1
3	ldo3_p3c	R/W	if set, LDO is ON when GPIO3 = 1
5:4	ldo3_ena_act	R/W	selects activation phase: 00: ACTPH1
7:6	reserved	_	

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

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Table 82. LDO4OUT - LDO4 output voltage select register (address 33h) bit description[1]

Bit	Symbol	Access	Description
4:0	ldo4_out	R/W	$V_{O(prog)} = 0.9 + Ido4_out \times 0.1 \text{ V (max 3.6 V); eg.}$ 00000 : 0.9 V 00001 : 1.0 V 11011 : 3.6 V 11111 : 3.6 V
5	ldo4_swmod	R/W	0: linear regulator mode 1: switch mode
7:6	reserved	_	

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

Table 83. LDO4ENA - LDO4 output enable register (address 34h) bit description[1]

Bit	Symbol	Access	Description
0	ldo4_on	R/W	if set, LDO is ON
1	ldo4_p1c	R/W	if set, LDO is ON when GPIO1 = 1
2	ldo4_p2c	R/W	if set, LDO is ON when GPIO2 = 1
3	ldo4_p3c	R/W	if set, LDO is ON when GPIO3 = 1
5:4	ldo4_ena_act	R/W	selects activation phase: 00: ACTPH1 01: ACTPH2 10: ACTPH3 11: ACTPH4
7:6	reserved	_	

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

Table 84. LDO5OUT - LDO5 output voltage select register (address 35h) bit description[1]

Bit	Symbol	Access	Description
4:0	ldo5_out	R/W	$V_{O(prog)} = 0.9 + Ido5_out \times 0.1V$ (max 3.6 V); eg. 00000: 0.9 V 00001: 1.0 V 11011: 3.6 V 11111: 3.6 V
5	ldo5_swmod	R/W	0: linear regulator mode 1: switch mode
7:6	reserved	_	

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

Table 85. LDO5ENA - LDO5 output enable register (address 36h) bit description[1]

Bit	Symbol	Access	Description
0	ldo5_on	R/W	if set, LDO is ON
1	ldo5_p1c	R/W	if set, LDO is ON when GPIO1 = 1
2	ldo5 p2c	R/W	if set, LDO is ON when GPIO2 = 1

Table 85. LDO5ENA - LDO5 output enable register (address 36h) bit description[1]

Bit	Symbol	Access	Description
3	ldo5_p3c	R/W	if set, LDO is ON when GPIO3 = 1
5:4	ldo5_ena_act	R/W	selects activation phase: 00: ACTPH1 01: ACTPH2 10: ACTPH3 11: ACTPH4
7:6	reserved	-	

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

Table 86. LDO6OUT - LDO6 output voltage select register (address 37h) bit description[1]

Bit	Symbol	Access	Description
4:0	Ido6_out	R/W	$V_{O(prog)} = 0.9 + Ido6_out \times 0.1 \text{ V (max 3.6 V); e.g.}$ 00000 : 0.9 V 00001 : 1.0 V 11000 : 3.3 V 11011 : 3.6 V 11111 : 3.6 V
5	ldo6_swmod	R/W	0: linear regulator mode 1: switch mode
7:6	reserved	-	

^[1] Reset values are determined by the IC variant (see Table 7).

Table 87. LDO6ENA - LDO6 output enable register (address 38h) bit description[1]

Bit	Symbol	Access	Description
0	ldo6_on	R/W	if set, LDO is ON
1	ldo6_p1c	R/W	if set, LDO is ON when GPIO1 = 1
2	ldo6_p2c	R/W	if set, LDO is ON when GPIO2 = 1
3	ldo6_p3c	R/W	if set, LDO is ON when GPIO3 = 1
5:4	ldo6_ena_act	R/W	selects activation phase: 00: ACTPH1
7:6	reserved	_	

^[1] Reset values are determined by the IC variant (see Table 7).

Table 88. HCLDOOUT - HCLDO output voltage select register (addr. 39h) bit description[1]

Bit	Symbol	Access	Description
4:0	hcldo_out	R/W	$V_{O(prog)} = 0.9 + hcldo_out \times 0.1 \text{ V (max 3.6 V); e.g.}$ 00000 : 0.9 V 00001 : 1.0 V 11011 : 3.6 V 11111 : 3.6 V
5	hcldo_swmod	R/W	0: linear regulator mode 1: switch mode
7:6	reserved	_	

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[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

Table 89. HCLDOENA - HCLDO output enable register (address 3Ah) bit description[1]

Bit	Symbol	Access	Description
0	hcldo_on	R/W	if set, LDO is ON
1	hcldo_p1c	R/W	if set, LDO is ON when GPIO1 = 1
2	hcldo_p2c	R/W	if set, LDO is ON when GPIO2 = 1
3	hcldo_p3c	R/W	if set, LDO is ON when GPIO3 = 1
5:4	hcldo_ena_act	R/W	selects activation phase: 00: ACTPH1 01: ACTPH2 10: ACTPH3 11: ACTPH4
7:6	reserved	_	

^[1] This register is reset at each transition to Standby state. Reset values are determined by the IC variant (see Table 7).

Table 90. HCLDOOVL - HCLDO overload protection register (address 40h) bit description

Bit	Mode	Symbol	Reset	Description
1:0	R/W	HCLDO_DEBOVL	11	Overload detection debounce time 00 : none 01 : 1 ms 10 : 10 ms 11 : 100 ms
7:2		reserved	_	

^[1] This register is reset at each transition to Standby state.

8.11.6 Functional description

8.11.6.1 LDO1 to LDO6

LDO1 to LDO6 can deliver a maximum output current of either 50 mA (LDO1, LDO2, LDO3 and LDO6) or 150 mA (LDO4 and LDO5).

In order to minimize pin count, the LDO inputs are connected internally in pairs as follows: LDO1 to LDO2 (pin **LDO12IN**), LDO3 to LDO4 (pin **LDO34IN**) and LDO5 to LDO6 (pin **LDO56**).

8.11.6.2 HCLDO

This high-current 200 mA linear regulator is equipped with current limiting capability. This makes it suitable for powering an external slot sensitive to short circuit conditions or overload.

The current limit is set at 175% of the maximum output current, or 350 mA. If the output current reaches this level, the HCLDO will enter constant-current mode and will generate a *hcldoovl* interrupt after a programmable debounce time (determined by the *hcldo_debovl* bits in control register *HCLDOOVL*; see <u>Table 90</u>).

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8.11.6.3 Output pull-down

An internal switch pulls down an LDO output when that LDO is disabled. It will discharge the external output capacitor connected to the output pin through a resistor ($R_{pd(ext)}$; see Table 73).

8.11.6.4 Switch mode

An LDO will act as low-ohmic switch if its associated *Idox_swmod* bit is set (see <u>Table 76</u> to <u>Table 88</u>). Output voltage control is disabled, resulting in low power consumption. To enable switch mode, the regulator must be activated as described in <u>Section 8.8.6.2</u>.

Two options are available for using HCLDO as a switch:

- 1. Switch with minimum quiescent current and no current limiting. This mode is selected by setting the *hcldo_swmod* bit in the *HCLDOOUT* control register (see <u>Table 88</u>).
- 2. Switch with current limiting. This mode is selected by programming the HCLDO output voltage to a higher level than its input voltage.

8.12 Main Battery Charger (MBC)

8.12.1 Introduction

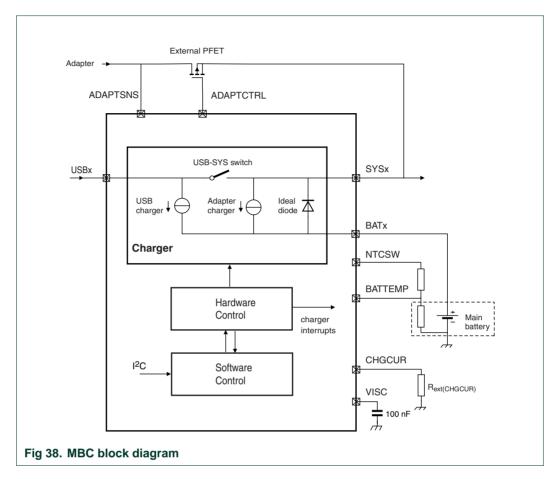
The MBC is a constant-current/constant-voltage (CCCV) charger. It has separate inputs for USB and adapter power sources. USB current limiting is supported.

8.12.2 Features

- Operates independently of the PCF50633 power management unit
- Separate power inputs for adapter and USB, including presence detectors which can wake up the PCF50633 and generate interrupts
- Controlled system supply output, obtained from one of the inputs and/or the battery
- USB input current limiter with programmable current limit
- · Reverse current blocking from battery to USB input
- USB suspend mode support
- Automatic switch to battery when input supply is not capable of supplying required system power (ideal diode functionality)
- · Current limiting in the ideal diode
- · Constant Current/Constant Voltage (CCCV) charger
- Programmable precharge and fast charge current levels for both USB and adapter
- Programmable float voltage
- Only 4 external components required: a resistor to set the fast charge (CC) current, a
 Negative Temperature Coefficient (NTC) bridge for measuring battery temperature, a
 decoupling capacitor for VISC and an external PFET for supplying adapter voltage
- Thermal regulation loop
- Charging resumed automatically when battery is discharged to a predefined level
- Single-cell Li-ion batteries are supported, with a capacitance ranging up to approximately 3000 mAh; maximum charge current of 1 A.

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8.12.3 Block diagram



8.12.4 Hardware interface

Table 91. MBC characteristics $V_{SS} = REFGND = GND = 0 \text{ V}; T_{amb} = -40 \text{ to } +85 \text{ °C}; unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
USB input rel	ated					
V_{USB}	USB supply voltage		4.0	-	5.3	V
V _{th(usbpres)}	USB adapter presence	rising edge	3.25	3.6	3.95	V
	threshold voltage	falling edge	3.15	3.5	3.85	
V _{USBMIN}	USB voltage required for USB charging	$V_{\text{bat(float)prog}} = 4.2 \text{ V}$ ($vmax = 1010$)	4.5	-	-	V
ΔV_{USBOK}	difference between USB and battery voltages for charging $(V_{USB} > V_{BAT} + \Delta V_{USBOK})$		-	50	-	mV
I _{lim(USBx)}	current limit on pin USBx	limit set to 1000 mA	800	900	1000	mA
		limit set to 500 mA	400	450	500	mA
		limit set to 100 mA	80	90	100	mA
R _{ON(USB-SYS)}	USB-SYS FET ON resistance		-	0.20	-	Ω
$\Delta V_{USB-SYS}$	voltage drop across USB-SYS FET	no USB current limiting	-	-	235	mV
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Table 91. MBC characteristics ...continued $V_{SS} = REFGND = GND = 0 \ V; T_{amb} = -40 \ to +85 \ ^{\circ}C;$ unless otherwise specified.

Cymbol	Parameter	Conditions	Min	Tym	Max	Unit
Symbol	Parameter	Conditions	IVIIII	Тур	IVIAX	Unit
Adapter input			4.0		5 0	
V _{ADAPTSNS}	voltage on pin ADAPTSNS		4.0	-	5.3	V
V _{th(adaptpres)}	adapter presence threshold voltage	rising edge	3.25	3.6	3.95	V
.,		falling edge	3.15	3.5	3.85	.,
V _{ADAPTMIN}	minimum SYS voltage required for adapter charging	$V_{\text{bat(float)prog}} = 4.2 \text{ V}$ ($vmax = 1010$)	4.5	-	-	V
$\Delta V_{ADAPTOK}$	difference between system and battery voltages	for charging (V_{SYS} > V_{BAT} + $\Delta V_{ADAPTOK}$)	-	50	-	mV
I _{lim(BAT-SYS)}	BAT-to-SYS current limit	ideal diode conducting	-	-	2.2	Α
R _{ON(BAT-SYS)}	BAT- to-SYS switch ON resistance		-	0.10	0.15	Ω
Charger relate	ed					
V _{BAT}	battery supply voltage	Active mode	2.8	-	5.0	V
V _{batcond}	battery conditioning voltage	vbatcond = 00[1]	-	2.70	-	V
		vbatcond = 01	-	2.85	-	V
		vbatcond = 10	-	3.00	-	V
		vbatcond = 11	-	3.15	-	V
V _{VISC}	voltage on pin VISC[2]		-	2.4	-	V
V _{bat(float)prog}	programmable battery float voltage	programmable in 20 mV steps via <i>vmax</i>	4.0	-	4.3	V
V _{bat(float)}	battery float voltage	single cell Li-lon / Li-Pol	V _{bat(float)prog} – 1%	V _{bat(float)prog}	V _{bat(float)prog} + 1%	V
I _{ch(ref)}	charger reference current[3]	defined as 12500/R _{ext(CHGCUR)}	0	-	1000	mA
		excluding tolerance of external resistor	0.95 × I _{ch(ref)} – 3	I _{ch(ref)}	1.05 × I _{ch(ref)} + 3	mA
R _{ext(CHGCUR)}	external resistor[3]	connected between pin CHGCUR and ground	12.5	-	-	kΩ
I _{ch(BATx)} [4]	charge current on pin BATx	precharge phase; defined as I _{ch(ref)} × prechgcur/255	0	-	$255/255 \times I_{\text{ch(ref)}}$	mA
		excluding tolerance of external resistor	$0.9 \times I_{ch(BATx)} - 3[5]$	I _{ch(BATx)}	$1.1 \times I_{ch(BATx)} + 3$	mA
		adapter fast charge phase; defined as I _{ch(ref)} × fstchgcur1/255	0	-	255/255 × I _{ch(ref)}	mA
		excluding tolerance of external resistor	0.9 × I _{ch(BATx)} – 3[5]	I _{ch(BATx)}	1.1 × I _{ch(BATx)} + 3	mA
		USB fast charge phase; defined as I _{ch(ref)} × fstchgcur1/255	0	-	$255/255 \times I_{\text{ch(ref)}}$	mA
		excluding tolerance of external resistor	0.9 × I _{ch(BATx)} – 3 ^[5]	I _{ch(BATx)}	1.1 × I _{ch(BATx)} + 3	mA
$V_{th(RES)}$	charge resume threshold voltage		-	0.96V _{bat(floa}	-	V
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Table 91. MBC characteristics ... continued

 $V_{SS} = REFGND = GND = 0 V$; $T_{amb} = -40 \text{ to } +85 \text{ }^{\circ}\text{C}$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{\text{th(TBATMIN)}}$	battery low temperature threshold voltage		1.9	2.0	2.1	V
$V_{th(TBATMAX)}$	NTC voltage level for battery high temperature threshold	programmable in 50 mV steps using ntclvt bits	0.6	-	1.35	V
t _{WDT(pre)}	precharge Watchdog Timer	prewdtime = 0	-	30	-	min
	(WDT) time-out time	prewdtime = 1	-	60	-	min
t _{WDT(fst)}	fast-charge watchdog timer time-out time	wdtime = 00	-	1	-	hour
		wdtime = 01	-	2	-	hour
		wdtime = 10	-	4	-	hour
		wdtime = 11	-	6	-	hour
C _{I(BAT)}	input capacitance on BATx pins		1 <u>6</u>	-		uF
C _{I(SYS)}	input capacitance on SYSx pins		22 <mark>6</mark>	-		uF
$T_{lim(USB-BAT)}$	temperature limit for USB-BAT FET		-	108	-	°C
$T_{lim(USB-SYS)}$	temperature limit for USB-SYS FET		-	118	-	°C

^[1] See register MBCC2 (Table 93) for detailsof vbatcond control bits.

8.12.5 Software interface

Table 92. MBCC1 - MBC charger control register 1 (address 43h) bit description[1]

Bit	Symbol	Access	Description
0	chgena	R/W	0: charger is disabled; charger detection still active.1: charger enabled
1	autostop	R/W	0: automatic charge termination disabled; charging is stopped by setting <i>chgena</i> = 0 or when a watchdog timer time-out occurs. 1: automatic charge termination enabled; charging stops when the charge current falls below the <i>cutoffcur</i> threshold (see <u>Table 97</u>) or when a watchdog timer time-out occurs
2	autores	R/W	when set, charging resumes automatically if the battery voltage falls below $V_{th(RES)}$ (or 96% of the float voltage specified by \emph{vmax} ; see Table 93)
3	resume ^[2]	R/W	charging resumes when set and charger is in Battery Full mode (see Figure 39); has no effect when <i>autores</i> = 1

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^[2] Note that V_{VISC} is an internal signal. Pin **VISC** is provided to allow an external decoupling capacitor to be connected. Decoupling is necessary to ensure stable operation.

^[3] I_{ch(ref)} is defined as 12500/R_{CHG}, where R_{CHG} is the value of an external resistor connected between pin **CHGCUR** and ground.

^[4] I_{CHG} = I_{ch(ref)} × *prechgcur* / 255. To select the maximum charge current of 1 A, a 12500 W resistor should be connected and bits *prechgcur* = 11111111 (see Table 94).

^[5] Absolute minimum with guaranteed performance is 50 mA.

^[6] Typical value of assume X5R / X7R type capacitors.

Table 92. MBCC1 - MBC charger control register 1 (address 43h) bit description[1]

Bit	Symbol	Access	Description
4	restart ^[2]	R/W	charging restarts when set and charger is in Halt mode (see Figure 39)
5	prewdtime	R/W	maximum charging time during Precharge phase 0 = 30 minutes, 1 = 60 minutes
7:6	wdtime	R/W	maximum charging time after Precharge phase 00 = 1 hour; 01 = 2 hours; 10 = 4 hours; 11 = 6 hours

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see Table 7).

Table 93. MBCC2 - MBC charger control register 2 (address 44h) bit description[1]

Bit	Symbol	Access	Description
1:0	vbatcond	R/W	$V_{batcond}$ level setting 00 = 2.7 V; 01 = 2.85 V; 10 = 3.0 V; 11 = 3.15 V
5:2	vmax	R/W	programmable battery float voltage (V _{bat(float)prog}) 0000 : 4.00 V 0001 : 4.02 V 0010 : 4.04 V 0011 : 4.06 V 1010 : 4.20 V 1011 : 4.22 V 1111 : 4.30 V
6	reserved		
7	vresdebtime	R/W	debounce time for V _{th(RES)} 0: 32 seconds; 1: 64 seconds

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see <u>Table 7</u>).

Table 94. MBCC3 - MBC charger control register 3 (address 45h) bit description[1]

Bit	Symbol	Access	Description
7:0	prechgcur	R/W	pre-charge current level 0000 0000 : $0/255 \times I_{ch(ref)}$ 0000 0001 : $1/255 \times I_{ch(ref)}$
			1111 1110 :254/255 × I _{ch(ref)} 1111 1111 :255/255 × I _{ch(ref)}

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see Table 7).

Table 95. MBCC4 - MBC charger control register 4 (address 46h) bit description[1]

Bit	Symbol	Access	Description
7:0	fstchgcur1	R/W	fast charge current level in adapter Fast Charge phase; settings same as for <i>prechgcur</i> in Table 94

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see Table 7).

^[2] Bit cleared once action completed.

Table 96. MBCC5 - MBC charger control register 5 (address 47h) bit description[1]

Bit	Symbol	Access	Description
7:0	fstchgcur2	R/W	fast charge current level in USB Fast Charge phase; settings same as for <i>prechgcur</i> in Table 94

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see Table 7).

Table 97. MBCC6 - MBC charger control register 6 (address 48h) bit description[1]

Bit	Symbol	Access	Description
4:0	cutoffcur	R/W	cutoff current level, used for battery full detection in CV mode 00000: 1/32 \times $I_{CHG}^{\hbox{\scriptsize [2]}}$ 00001: 2/32 \times I_{CHG}
			 11110 : 31/32 × _{CHG} 11111 : 32/32 × I _{CHG}
7:5	reserved		

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see Table 7).

Table 98. MBCC7 - MBC charger control register 7 (address 49h) bit description

Bit	Symbol	Access	Reset[1]	Description
1:0	usbdevstat	R/W	[2]	USB device status setting 00 : configured for 100 mA 01 : configured for 500 mA 10 : configured for 1000 mA 11 : suspend
2	battempena	R/W	[3]	if set, battery temperature is measured and impacts the MBC state machine.
5:3	reserved			
7:6	batsysimax	R/W	[3]	maximum BAT-SYS current when ideal diode is conducting 00: 1.6A; 01: 1.8A; 10: 2.0A; 11: 2.2A

^[1] Reset values are determined by the IC variant (see <u>Table 7</u>).

^[2] I_{CHG} is the programmed charge current. The value is defined by either the *prechgcur*, *fstchgcur1* or *fstchgcur2* control bits, depending on the operating mode.

^[2] Reset in Standby state.

^[3] Reset in NoPower state.

Table 99. MBCC8 - MBC charger control register 8 (address 4Ah) bit description[1]

Bit	Symbol	Access	Description
3:0	ntclvt	R/W	defines the NTC voltage level for battery high temperature threshold in 50 mV steps 0000 : 0.60 V 0001 : 0.65 V 1110 : 1.30 V 1111 : 1.35 V
4	usbenasus	R/W	O: USB-SYS switch is not conducting in USB suspend mode; ideal diode is enabled 1: USB-SYS switch is conducting in USB suspend mode; ideal diode is disabled.
7:5	reserved		

^[1] This register is reset in NoPower state. Reset values are determined by the IC variant (see <u>Table 7</u>).

Table 100. MBCS1 - MBC charger status register 1 (address 4Bh) bit description

Bit	Symbol	Access	Description
0	usbpres	R	USB presence indication on pin USBx 0: V _{USB} < V _{th(usbpres)} ; 1: V _{USB} > V _{th(usbpres)}
1	usbok	R	USB voltage indication on pin USBx 0: $V_{USB} < V_{BAT} + \Delta V_{USBOK}$; 1: $V_{USB} > V_{BAT} + \Delta V_{USBOK}$
2	adaptpres	R	adapter presence indication on pin ADAPTSNS 0: V _{ADAPTSNS} < V _{th(adaptpres)} ; 1: V _{ADAPTSNS} > V _{th(adaptpres)}
3	adaptok	R	SYS voltage indication on pin SYSx 0: $V_{SYS} < V_{BAT} + \Delta V_{ADAPTOK}$; 1: $V_{SYS} > V_{BAT} + \Delta V_{ADAPTOK}$
5:4	tbatstat	R	battery temperature status indication 00: temperature within window 01: temperature above window 10: temperature below window 11: temperature is undefined
6	prewdtexp	R	watchdog timer status indication during pre-charge 0: watchdog timer not expired; 1 = watchdog timer expired
7	wdtexp	R	watchdog timer status indication after pre-charge 0: watchdog timer not expired; 1 = watchdog timer expired

Table 101. MBCS2 - MBC charger status register 2 (address 4Ch) bit description

Bit Symbol	Access	Description
3:0 mbcmod	R	main MBC operating modes and charge phases 0000: Play Only mode 0001: USB Precharge phase 0010: USB Precharge Wait phase 0011: USB Fast Charge phase 0100: USB Fast Charge wait phase 0101: USB suspend mode 0110: adapter Precharge phase 0111: adapter Precharge Wait phase 1000: adapter Fast Charge wait phase 1001: adapter Fast Charge wait phase 1001: Battery Full mode 1011: Halt mode 1100-1111: reserved
5:4 chgstat	R	charger connection status 00: no charger detected 01: adapter voltage detected 10: USB voltage detected 11: adapter and USB voltage detected
6 resstat	R	Automatic Resume status indication 0: charging has not resumed automatically 1: charging has resumed automatically
7 reserved		

Table 102. MBCS3 - MBC charger status register 3 (address 4Dh) bit description

Bit	Symbol	Access	Description
0	usblim_play	R	USB current limiting loop in USB-to-SYS path is active if set
1	usblim_chg	R	USB current limiting loop in USB-to-BAT path is active if set
2	tlim_play	R	temperature limiting loop in USB-to-SYS path is active if set
3	tlim_chg	R	temperature limiting loop in USB-to-BAT or SYS-BAT path is active if set
4	ilim	R	0: battery charge current < cutoffcur level 1: battery charge current > cutoffcur level
5	vlim	R	0: battery voltage < <i>vmax</i> level 1: battery voltage equals <i>vmax</i> level
6	vbatstat	R	0: battery voltage < V _{batcond} 1: battery voltage > V _{batcond}
7	vres	R	0: battery voltage < V _{th(RES)} 1: battery voltage > V _{th(RES)}

8.12.6 Functional description

8.12.6.1 Charger circuit arrangement

The charging system is characterized by:

- USB-SYS switch: A current-limited path from the USB input to the system supply output
- USB charger: a charge path from the USB input to the battery

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- Adapter charger: a charge path from the system supply node to the battery, intended to be supplied from an external adapter switched to the SYSx pin by a discrete P-type FET
- Ideal diode: a path for supplying system operation from the battery, and for when the system requires more power than the USB path can deliver.

Refer to the MBC block diagram (Figure 38) for details.

8.12.6.2 USB input

A dedicated USB input is available to support USB charging. Current limiting is guaranteed at the USB input, even though the USB path is split between 2 power components. The current limit level can be set to 100 mA, 500 mA or 1 A by means of the *usbdevstat* bits in register *MBCC7* (see Table 98).

USB presence detection is debounced by 62 ms. A *usbins* interrupt is generated when the USB voltage exceeds $V_{th(usbpres)}$ for longer than 62 ms. A *usbrem* interrupt is generated when the USB voltage drops below $V_{th(usbpres)}$ for longer than 62 ms.

The charge current during USB operation is the maximum available current less the current required by the system. If the system draws more current that the USB source can deliver, the ideal diode will begin conducting and current will flow from the battery to the system via the BAT-to-SYS path (see Figure 41).

When no USB presence is detected, the path from BAT-to-USB is blocked in order to prevent battery discharge in the event of short circuits at the USB connector.

8.12.6.3 Adapter input

When an external power source is present, charging will be via the SYS-to-BAT path only (see <u>Figure 43</u>). The USB-to-SYS path will be blocked to prevent current flow in the USB cable. An external PFET must be connected between the adapter and the **SYSx** pins (see Figure 38). The PFET can be driven by the **ADAPTCTRL** output.

Adapter presence detection is debounced by 62 ms. An *adpins* interrupt is generated when the voltage on **ADAPTSNS** exceeds $V_{th(adaptpres)}$ for longer than 62 ms. An *adprem* interrupt is generated when the voltage on **ADAPTSNS** drops below $V_{th(adaptpres)}$ for longer than 62 ms.

The presence of the external adapter must be signalled to the PCF50633 at the **ADAPTSNS** input, as the **SYSx** pins cannot be used for adapter detection.

8.12.6.4 Current definition pin CHGCUR

An external resistor, R_{CHG} , connected between the **CHGCUR** pin and ground, defines the charge current and current limit levels. The resistance value must be 12500 Ω in order to select the maximum charge current of 1 A and the USB current limit levels to 100 mA and 500 mA. If a different resistance value is used, the maximum charge current and USB current limit levels will be scaled accordingly.

The value of R_{CHG} defines a reference current, $I_{ch(ref)}$, referred to in later sections: $I_{ch(ref)} = 12500 / R_{CHG}$.

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8.12.6.5 Functional description of charger controller

The charger control flow is fully autonomous, requiring no software intervention to fully charge a battery. The following table shows the component states in different operating modes. A charger state diagram is shown in Figure 39. Circuit configurations, operating modes and charging phases are discussed in the following sections.

Table 103. Charger modes and component states

MBC mode	Adapter present[1]	USB present[2]	I _{SYS} > I _{LIM(USB)}	Adapt-SYS ext. FET	USB-SYS FET[3]	USB-BAT charger[4]	SYS-BAT charger $V_{SYS} > V_{BAT}^{[4]}$	Ideal diode, V _{SYS} < V _{BAT}
Play Only	No	No	n.a.	OFF	OFF	OFF	OFF	ON
USB Charge &	No	Yes	No	OFF	CLIM	CHG[5]	OFF	OFF
Play	No	Yes	Yes	OFF	CLIM	CHG	OFF	ON
USB Suspend	No	Yes	n.a.	OFF	ON/OFF61	OFF	OFF	ON/OFF[6]
Adapter Charge & Play	Yes	n.a.	n.a.	ON	OFF	OFF	CHG	OFF
Halt	No	Yes	No	OFF	CLIM	OFF	OFF	OFF
	No	Yes	Yes	OFF	CLIM	OFF	OFF	ON
	Yes	n.a.	n.a.	ON	OFF	OFF	OFF	OFF
Batfull	No	Yes	No	OFF	CLIM	OFF	OFF	OFF
	No	Yes	Yes	OFF	CLIM	OFF	OFF	ON
	Yes	n.a.	n.a.	ON	OFF	OFF	OFF	OFF

^[1] Adapter presence is detected at the **ADAPTSNS** input.

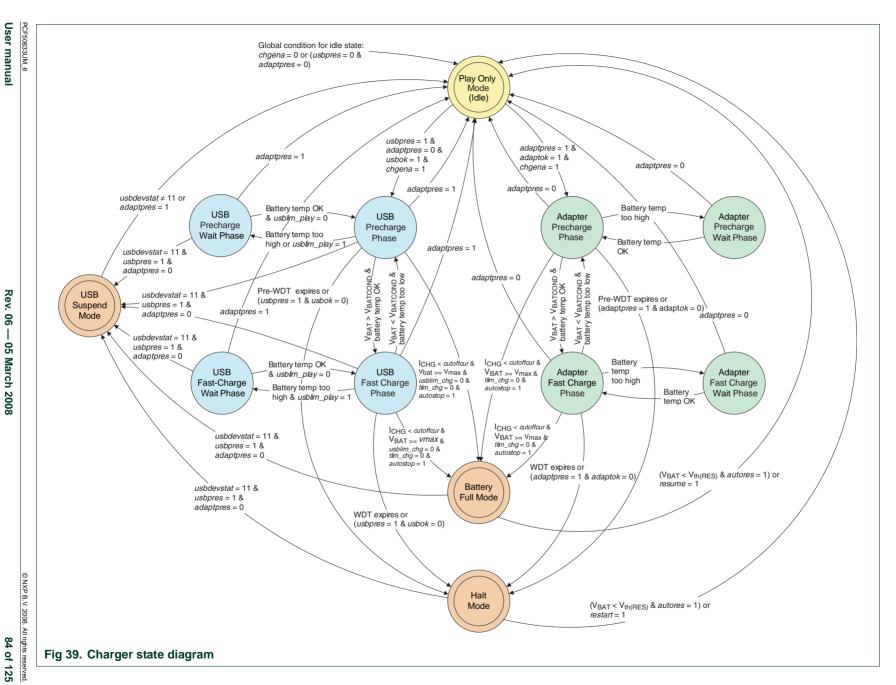
^[2] USB presence is detected by a voltage comparator at the USBx inputs

^[3] CLIM indicates current limiting mode, resulting in a drop in V_{SYS} when in I_{SYS} > I_{LIM(USB)} (as set via *usbdevstat*, see <u>Table 98</u>).

^[4] CHG means charging mode (current controlled by charger).

^[5] Effectively, no charging because all USB current is required by the system.

^[6] ON/OFF status depends on the setting of the usbenasus bit the MBCC8 control register (see Table 99).



8.12.6.6 MBC operating modes

Play Only mode: The MBC operating mode/charge phase can be determined by reading the *mbcmod* bits in the *MBCS2* status register (see Table 101).

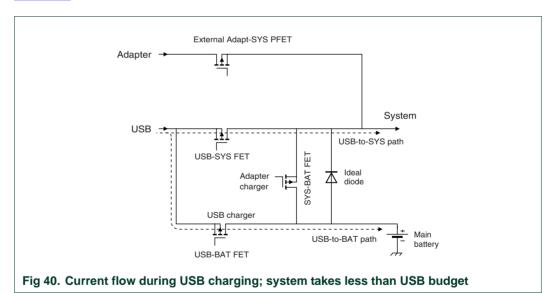
In Play Only (or Idle) mode, most of the circuits of the MBC are disabled when no external power source (USB or adapter) is available.

Programming the *chgena* control bit to 0 while an external power source is available will result in a transition to the Play Only mode. In this case, the USB-BAT and SYS-BAT FETs will be OFF.

USB Charge and Play mode: In this mode, the CPU specifies the USB current budget via the *usbdevstat* bits in register *MBCC7* (see <u>Table 98</u>). How the charger behaves in this mode is determined by the battery state and required system current:

Battery not fully charged: The USB-SYS FET will be conducting as long as the USB can deliver the current needed by the system.

If the USB current budget is greater than that required by the system (plus the battery charger), the excess will be used to charge the battery. This situation is illustrated in Figure 40 below:

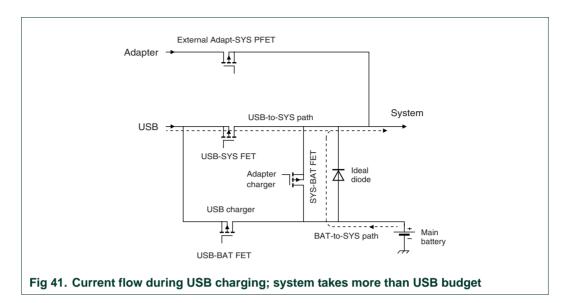


If the requirements of the system (plus the battery charger) exceed the USB current budget, the USB-BAT FET current limiter will be activated. At the same time, the <code>usblim_chg</code> bit in the <code>MBCS3</code> control register (see <code>Table 102</code>) will be set, indicating that the charge current is no longer equal to the programmed value.

If the current in the USB-BAT FET falls to zero, the USB-SYS FET current limiter will be activated and the *usblim_play* bit in the *MBCS3* register will be set. A *usblimon* interrupt will be generated, signalling that current limiting has been activated in the USB-to-SYS path. The USB-SYS FET will act as a current source.

Since the system now requires more current than the USB-SYS FET can deliver, V_{SYS} will begin to fall. When V_{SYS} drops below V_{BAT} , the ideal diode will start conducting. This situation is illustrated in Figure 41.

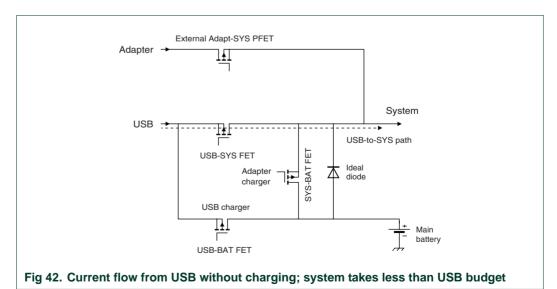
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Note that if this situation persists, the battery will discharge over time. The battery will continue to deliver power to the system, even as it is discharging.

If system current requirements fall, or if the USB current budget is increased, and I_{SYS} becomes less than $I_{LIM(USB)}$, V_{SYS} will steadily rise. A *usblimoff* interrupt will be generated, signalling that current limiting has been deactivated in the USB-to-SYS path. Once $V_{SYS} > V_{BAT}$, the ideal diode will block current flow from the battery.

Battery fully charged: When the battery is fully charged and the charger is in Battery Full mode, the charge path is disabled (the USB-BAT FET is off). As long as the USB can deliver the current needed by the system, the USB-SYS FET will be conducting (see Figure 42).



If the requirements of the system exceed the USB current budget, the USB-SYS FET current limiter will be activated and the *usblim_play* bit set. The USB-SYS FET will then act as a current source.

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Since the system now requires more current than the USB-SYS FET can deliver, V_{SYS} will begin to fall. When $V_{SYS} < V_{BAT}$, the ideal diode will start to conduct. The situation depicted in Figure 41 recurs.

If the *autores* bit in control register *MBCC1* is set, charging will resume. Otherwise the battery will gradually run down in this situation.

If system current requirements fall, or if the USB current budget is increased, and I_{SYS} falls until it is $< I_{LIM(USB)}$, V_{SYS} will steadily rise. Once $V_{SYS} > V_{BAT}$, the ideal diode will block current flow from the battery.

USB suspend mode: The host controller can suspend the USB by writing 11 to the *usbdevstat* control bits in the *MBCC7* register (see <u>Table 98</u>). All MBC circuits will be disabled, with the exception of:

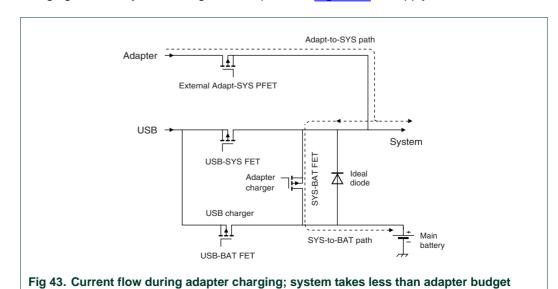
- The Adapter presence detector (in order to wake up the system whenever an Adapter is connected).
- The USB voltage presence detector (in order to detect when the USB supply has been removed).

Theoretically, the CPU core and its I/O supply needs to remain active in order to be able to respond if the USB host issues a resume notification and to ensure it doesn't loose the connection to the USB host. The CPU can be supplied via the USB or the battery.

If the *usbenasus* bit is set (see <u>Table 99</u>), the USB-SYS FET will be fully conducting (no current limiting) in suspend mode. The host controller will be responsible for ensuring that the total current drawn from the USB supply is less than the USB budget. The SYS-BAT FET and the USB-BAT FET will be disabled and the ideal diode will not be conducting.

If the *usbenasus* bit is not set, the USB-SYS FET will be off while the ideal diode will be conducting. The host controller will be powered from the battery. The USB connection will be lost in this case, if the battery is allowed to run down.

Adapter Charge and Play mode: Battery not fully charged: As long as the adapter is capable of delivering the required system current (under all conditions) and is capable of charging the battery, the arrangement depicted in Figure 43 will apply.



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Battery fully charged: There will be no charge current if the battery is fully charged.

Battery Full mode: A battery full condition is detected when the following conditions are satisfied:

- 1. Battery charge current falls below the cutoffcur setting
- 2. V_{BAT} has reached the specified *vmax* value
- 3. USB-BAT FET current limiting is not active (usblim_chg = 0)
- 4. Temperature limiting loops in USB-to-BAT and SYS-to-BAT paths not active (*tlim chg* = 0)

A *batfull* interrupt is generated when all the above conditions are satisfied. A transition to Battery Full mode will occur automatically if *autostop* is set (see Table 92).

Note that the charger will not initiate a transition to Battery Full mode if autostop = 0 (a batfull interrupt will still be generated). In this situation, the current charge mode will be retained.

The state machine goes from Battery Full to Play Only mode whenever the battery voltage drops below the resume level ($V_{th(RES)}$), for a period longer than the debounce time defined by control bit *vresdebtime* in register *MBCC2* (see <u>Table 93</u>), and *autores* is set to '1'.

When charging resumes, and the MBC mode changes from Battery Full to Play Only mode, the *resstat* status bit (which is 0 by default; see <u>Table 101</u>) is set and the watchdog timers are reset. The *resstat* bit will be reset when Battery Full mode is resumed.

When *autores* is set to '0', the MBC remains in Battery Full mode. In this situation, there is a risk of the battery becoming completely discharged if the system is drawing more current than the main charge device can supply (and the ideal diode is active). It is possible to initiate a restart of the charging process by setting the *resume* bit (in register *MBCC1*; see Table 92).

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Halt mode: The MBC enters Halt mode in response to a watchdog timer time-out event or a charge supply fault condition, as described below.

A charge supply fault condition is assumed when the charger supply level is lower then the battery voltage, in which case the charge source is no longer able to charge the battery.

When Halt mode is entered, a *chghalt* interrupt is generated and charging stops.

The state machine goes from the Halt mode to Play Only mode:

- if the main charge supply (USB or adaptor, or both if USB and adapter are connected) is removed
- if the restart bit is set to begin a new charge cycle (see Table 92)
- if the battery voltage drops below the resume level (V_{th(RES)}), for a period longer than
 the debounce time defined by control bit *vresdebtime* in register *MBCC2* (see
 <u>Table 93</u>), and *autores* is set to '1'.

8.12.6.7 Charging phases

There are four charge phases associated with USB Charge and Play mode and Adapter Charge and Play mode. The charge phases apply to Li-ion batteries:

- Precharge phase (conditioning phase)
- Precharge Wait phase
- Fast Charge phase
- Fast Charge Wait phase

Once charging is complete, the MBC will enter either Battery Full or Halt mode.

Charging begins when a valid adapter or USB supply is detected (see <u>Section 8.12.6.3</u> or <u>Section 8.12.6.2</u>). The charger will then enter the USB or Adapter Precharge phase, as appropriate.

8.12.6.8 Precharge phases

When a suitable adapter or USB supply is detected, the battery is charged with a constant precharge current (CC mode). The constant current is selected via the *prechgcur* bits in the *MBCC3* register (see Table 94):

$$I_{ch} = I_{ch(ref)} \times prechgcur/255 \tag{4}$$

 $I_{ch(ref)}$ is defined in section <u>Section 8.12.6.4</u>. For a Li-ion battery, the precharge current is typically 0.1C (C = charge rate = the charge current which will fully charge the battery in one hour).

Precharging with a constant current continues until the battery voltage reaches the conditioned voltage level (V_{batcond}). For a Li-lon battery, V_{batcond} is typically 2.7 V. This level can be set via the *vbatcond* control bits in the *MBCC2* control register (see <u>Table 93</u>).

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When the battery voltage reaches $V_{batcond}$, the MBC enters the Fast Charge phase (provided. if *battempena* is set, the battery temperature is within a specified temperature window; see <u>Table 98</u>). A constant fast-charge current (CC mode) is applied until the battery voltage reaches the specified float level (bits *vmax* in register *MBCC2*; see <u>Table 93</u>).

If the battery voltage reaches V_{batcond} but the battery temperature is not within the specified temperature window (with *battempena* enabled), precharging continues until the battery voltage reaches the specified float level (*vmax*).

If the battery temperature rises above the high temperature threshold in Precharge phase, the MBC will enter Precharge Wait phase and charging will stop. Charging will resume once the battery temperature falls below the high temperature limit.

The charger will also enter the Precharge Wait phase if USB-SYS FET current limiting is activated (*usb_play* = 1). Charging will resume when USB-SYS FET current limiting is deactivated.

When the battery voltage reaches the float level (*vmax*), *vlim* is set (in register *MBCS3*; see <u>Table 102</u>) and charging continues at a constant voltage (CV mode). During this phase, the charger keeps the battery voltage constant at the specified float level. The charge current will gradually decline as the battery charge level increases. When the charge current drops below the cutoff point (as specified via the *cutoffcur* bits in register *MBCC6*; see <u>Table 97</u>), the *ilim* bit is reset to 0 (in register *MBCS3*; see <u>Table 102</u>). When *ilim* = 0, and neither the thermal limiting loop nor the USB current limiting loop is active, a *batfull* interrupt is generated to indicate that the battery is fully charged. If *autostop* is set (see <u>Table 92</u>), charging stops and the MBC enters Battery Full mode. Otherwise charging continues and the control software will be responsible for deciding what action to take.

As a safety precaution, a watchdog timer is started (from zero) when the MBC enters Precharge phase. If the watchdog timer expires (after $t_{WDT(pre)}$ minutes) before the battery reaches $V_{batcond}$, precharging stops and the MBC enters Halt mode. $t_{WDT(pre)}$ is specified via the *prewdtime* bit in the *MBCC1* register (see <u>Table 92</u>). The *prewdtime* control bit is only updated when the charger is in Play Only mode.

Note that the watchdog timer only counts down while the charger is in USB/Adapter Precharge phase. It is halted when the charger is in USB/Adapter Precharge Wait phase.

When *battempena* = 0, it is assumed that the application does not include an NTC for measuring battery temperature. In this situation, all restrictions in the state diagram (<u>Figure 39</u>) relating to battery temperature are ignored.

Charging stops if *chgena* is reset (see <u>Table 92</u>) or if a watchdog timer time-out is generated. When a watchdog timer time-out is generated, bit *prewdtexp* in register *MBCS1* is set (see <u>Table 100</u>) and the charger enters Halt mode. If *autores* = 0, the MBC will remain in Halt mode until the *restart* bit in the *MBCC1* control register is set. If autores = 1, the MBC will return to the Play Only mode when the battery voltage falls below the resume threshold ($V_{BAT} < V_{th(RES)}$; see <u>Table 92</u> and <u>Figure 39</u>).

Note: Well-conditioned Li-ion batteries will register a voltage above 2.7 Volt within 60 minutes of precharging.

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8.12.6.9 Fast charge phases

Fast charging of a battery is only permitted within a certain temperature window (typically between 0 and 50 °C).

When the battery voltage reaches $V_{batcond}$, the MBC enters the Fast Charge phase (provided. if *battempena* is set, the battery temperature is within a specified temperature window; see <u>Table 98</u>) and charging continues with a constant fast-charge current (CC mode).

The fast charge current is selected via the *fstchgcurx* bits in control registers *MBCC4* and *MBCC5* (see Table 95 and Table 96).

$$I_{ch} = I_{ch(ref)} \times fstchgcurx/255$$
 (5)

I_{ch(ref)} is defined in section Section 8.12.6.4.

If charging is via the adapter, the fast charge current is determined by the *fstchgcur1* bit settings. If charging is via the USB connector, bits *fstchgcur2* determine the fast charge current. For a Li-lon battery, the fast-charge current is typically between 0.7 C and 1.0 C.

Fast charging with a constant fast-charge current continues until the battery voltage reaches the programmed float level (*vmax*). For a Li-Ion battery, *vmax* is typically 4.2 V.

When the battery voltage reaches the float level (*vmax*), *vlim* is set (in register *MBCS3*; see <u>Table 102</u>) and charging continues at a constant voltage (CV mode). During this phase, the charger keeps the battery voltage constant at the specified float level. The charge current will gradually decline as the battery charge level increases. When the charge current drops below the cutoff point (as specified via the *cutoffcur* bits in register *MBCC6*; see <u>Table 95</u>), the *ilim* bit is reset to 0 (in register *MBCS3*; see <u>Table 102</u>). When *ilim* = 0, and neither the thermal limiting loop nor the USB current limiting loop is active, a *batfull* interrupt is generated to indicate that the battery is fully charged. If *autostop* is set (see <u>Table 92</u>), charging stops and the MBC enters Battery Full mode. Otherwise charging continues and the control software will be responsible for deciding what action to take.

If the battery temperature rises above the high temperature threshold in Fast Charge phase, the MBC will enter Fast Charge Wait phase and charging will stop. Charging will resume once the battery temperature falls below the high temperature limit.

The charger will also enter the Fast Charge Wait phase if USB-SYS FET current limiting is activated (*usb_play* = 1). Charging will resume when USB-SYS FET current limiting is deactivated.

If the battery temperature falls below the low temperature threshold in either USB or Adapter Fast Charge phase, the MBC will enter Precharge Wait phase. The *tbatstat* status bits in register *MBCS1* (see <u>Table 100</u>) indicate whether the battery temperature is within, above or below the valid temperature window.

As a safety precaution, a watchdog timer is started (from zero) when the MBC enters Fast Charge phase. If the watchdog timer expires (after $t_{WDT(fst)}$ minutes), charging stops and the MBC enters Halt mode. $t_{WDT(fst)}$ is specified via the *wdtime* bits in the *MBCC1* register (see <u>Table 92</u>). The *wdtime* control bits are updated in all charger modes. If *autores* = 0, the MBC will remain in Halt mode until the *restart* bit in the *MBCC1* control register is set. If *autores* = 1, the MBC will return to the Play Only mode when the battery voltage falls below the resume threshold ($V_{BAT} < V_{th(RES)}$; see <u>Table 92</u> and <u>Figure 39</u>).

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Note that the watchdog timer only counts down while the charger is in USB/Adapter Fast Charge phase. It is halted when the charger is in USB/Adapter Fast Charge Wait phase.

When *battempena* = 0, it is assumed that the application does not include an NTC for measuring battery temperature. In this situation, all restrictions in the state diagram (Figure 39) relating to battery temperature are ignored.

Charging stops if *chgena* is reset (see <u>Table 92</u>) or if a watchdog timer time-out is generated. When a watchdog timer time-out is generated, bit *wdtexp* in register *MBCS1* is set (see <u>Table 100</u>).

8.12.6.10 Die Temperature control during charging

The thermal regulation loop is an analog loop that compares the junction temperature of the pass device with a predefined fixed temperature. When the junction temperature approaches this threshold, the loop will automatically reduce the charging current in order to ensure the temperature never exceeds the specified threshold ($T_{lim(USB-BAT)}$) for the USB-BAT FET and $T_{lim(USB-SYS)}$ for the USB-SYS FET; see <u>Table 91</u>).

When the thermal regulation loop reduces the USB-SYS FET current, bits *tlim_play* and *usblim_play* in the *MBCS3* register are set (see <u>Table 102</u>) and *thlimon* and *usblimon* interrupts are generated. *thlimoff* and *usblimoff* interrupts are generated when the thermal regulation loop stops limiting the charge current.

When the thermal regulation loop reduces the charge current through the SYS-BAT FET or the USB-BAT FET, bits *tlim_chg* and *usblim_chg* are set (see <u>Table 102</u>). *tlim_chg* and *usblim_chg* are reset when the thermal regulation loop stops limiting the charge current (no interrupts are generated when the thermal regulation loop starts or stops limiting the charge current).

8.12.6.11 Battery temperature detection circuit

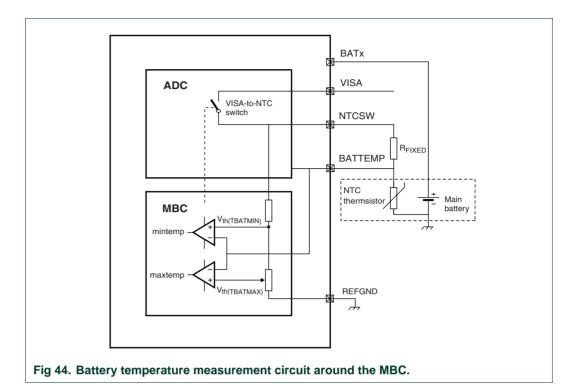
The VISA-to-NTC switch in the on-chip A/D Converter (which can be used to accurately measure battery temperature) is also controlled by the MBC. The equivalent circuit is illustrated in Figure 44.

The following steps should be followed to configure the PCF50633 for battery temperature detection:

- 1. Determine the NTC resistance at low temperature threshold specified for battery
- 2. Calculate R_{FIXFD} such that the voltage on **BATTEMP** equals V_{th(TBATMIN)}
- 3. Determine the NTC resistance at high temperature threshold specified for battery
- 4. Calculate the voltage on **BATTEMP** at the high temperature threshold
- 5. Set V_{th(TBATMAX)} to the calculated value via bits *ntclvt* (programmable in 50 mV; see <u>Table 91</u> and <u>Table 99</u>).

The battery temperature status (whether it is above, below or within the temperature window defined by the low and high temperature thresholds) can be obtained by reading the *tbatstat* status bits in Table 100.

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8.13 Backup Battery Charger (BBC)

8.13.1 Introduction

The BBC module charges a backup battery cell from the **SYSx** node. A constant current algorithm is implemented.

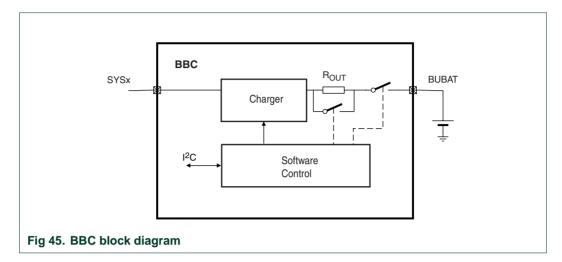
8.13.2 Features

- Voltage limited current source
- Output resistor to reduce the current at higher voltages
- Four programmable charge currents
- Two programmable maximum limiting voltages
- The BBC can only be enabled in the Active state.

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8.13.3 Block diagram



8.13.4 Hardware interface

Table 104. BBC characteristics

 $V_{SS} = REFGND = GND = 0 V$; $T_{amb} = -40 \text{ to } +85 \,^{\circ}\text{C}$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{BUBAT}	backup battery supply voltage		1.6	-	3	V
I _{ch(BUBAT)}	charge current on pin BUBAT	bbcc = 00	35	50	65	μΑ
		bbcc = 01	70	100	130	μΑ
		bbcc = 10	130	200	270	μΑ
		bbcc = 11	250	400	550	μΑ
$V_{lim(BUBAT)}$	limiting voltage on pin BUBAT	bbcv = 0	2.37	2.50	2.63	V
		bbcv = 1	2.85	3.00	3.15	V
		<i>bbcv</i> = 0, T _{amb} = 25 °C	2.42	2.50	2.58	V
		<i>bbcv</i> = 1, T _{amb} = 25 °C	2.91	3.00	3.09	V
V_{DELTA}	voltage range where output current is limited	bbcr = 1	160	220	280	mV
I _{DD(tot)}	total supply current (excluding charge	ON mode charging	-	30	50	μΑ
	current)	ON mode stopped	-	15	25	μΑ
		OFF mode	-	-	1	μΑ

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8.13.5 Software interface

Table 105. BBCCTL - Backup battery charger control register (address 4Eh) bit description

Bit	Symbol	Access	Reset[1]	Description
0	bbce	R/W	0[2]	enable backup battery charger: 0: charger OFF 1: charger ON this bit is automatically cleared in Standby state
1	bbcr	R/W	0	bypass output resistor: 0: output resistor active 1: resistor bypassed
3-2	bbcc	R/W	00	select backup battery charge current ($I_{ch(BUBAT)}$): 00 : 50 μ A 01 : 100 μ A 10 : 200 μ A 11 : 400 μ A
4	bbcv	R/W	0	select limiting voltage for backup battery charger (V _{lim(BUBAT)}): 0: 2.5 V; 1: 3.0 V
7-5	reserved		_	

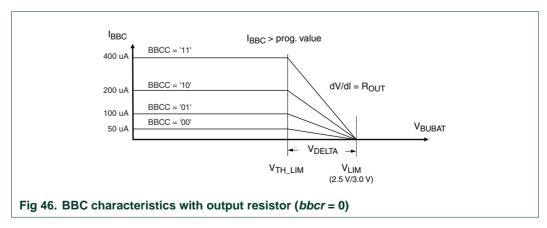
^[1] This register is reset in NoPower state.

8.13.6 Functional description

The backup battery charger is enabled in the Active state by writing 1 to control bit *bbce* (see Table 105). In Standby state, *bbce* is cleared automatically.

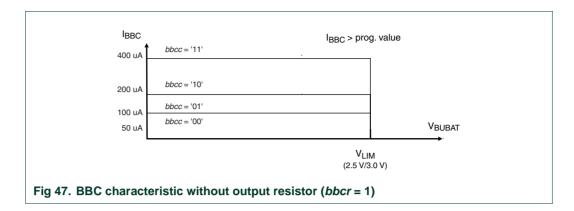
The backup battery is charged from the system voltage (V_{SYS}). Charging stops when the backup battery reaches the programmed maximum voltage ($V_{BUBAT} > V_{lim(BUBAT)}$) or when the system voltage drops below the backup battery voltage ($V_{BUBAT} > V_{SYS}$). Charging will resume automatically when neither of these conditions applies.

If the output resistor is active (bit bbcr = 0), the charge current will gradually ramp down as illustrated in Figure 46.



If the output resistor has been bypassed (bit *bbcr* = 1), the charge current will abruptly drop to zero, as illustrated in Figure 47.

^[2] Reset in Standby state.



8.14 10-bit Analog-to-Digital Converter (ADC)

8.14.1 Introduction

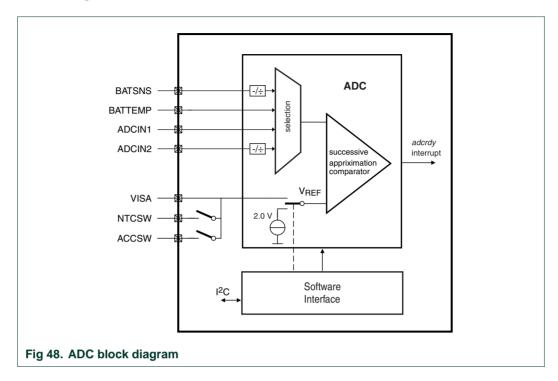
The ADC is a 10-bit successive approximation converter. Voltage division and subtraction functionality is incorporated for high voltage measurements.

8.14.2 Features

- Selectable 8- or 10-bit resolution
- · Measurement averaging is programmable
- · Selectable battery voltage measurement
- Selectable battery temperature measurement
- Selectable NTC measurement
- Two independent analog inputs (ADCIN1 and ADCIN2)
- Selectable and programmable voltage divider functionality (BATSNS and ADCIN2) for high voltage/low resolution measurements
- Selectable voltage subtractor functionality (**BATSNS** and **ADCIN2**) for high voltage/high resolution measurements.

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8.14.3 Block diagram



8.14.4 Hardware interface

Table 106. ADC characteristics

 $V_{SS} = REFGND = GND = 0 \ V; \ T_{amb} = -40 \ to \ +85 \ ^{\circ}C; \ unless \ otherwise \ specified.$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{I(ADCIN1)}	input voltage on pin ADCIN1		0	-	2.0	V
V _{I(BATTEMP)}	input voltage on pin BATTEMP		0	-	2.0	V
V _{I(ADCIN2)}	input voltage on pin ADCIN2	full scale mode, divide by 2	0	-	4.0	V
, ,		full scale mode, divide by 3	0	-	5.5	V
		subtraction mode	2.25	-	4.25	V
V _{I(BATSNS)}	input voltage on pin BATSNS	full scale mode, divide by 2	0	-	4.0	V
		full scale mode, divide by 3	0	-	5.5	V
		subtraction mode	2.25	-	4.25	V
RES	resolution	adcres = 0	-	10	-	bits
		adcres = 1	-	8	-	bits
DNL	differential non-linearity	ADCIN1 and BATTEMP inputs	-0.7	-	+0.7	LSB
		high voltage ADCIN2 and BATSNS inputs; full scale mode, divide by 2 or 3	-0.8	-	+0.8	LSB
		high voltage ADCIN2 and BATSNS inputs; subtraction mode	-1.0	-	+1.0	LSB

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Table 106. ADC characteristics ... continued

 $V_{SS} = REFGND = GND = 0 V$; $T_{amb} = -40 \text{ to } +85 \,^{\circ}\text{C}$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
INL	integral non-linearity	ADCIN1 and BATTEMP inputs	-4.0	-	+4.0	LSB
		high voltage ADCIN2 and BATSNS inputs; full scale mode, divide by 2	-4.0	-	+4.0	LSB
		high voltage ADCIN2 and BATSNS inputs; full scale mode, divide by 3	-4.0	-	+4.0	LSB
		high voltage ADCIN2 and BATSNS inputs; subtraction mode	-12.0	-	+12.0	LSB
E _{gain(I)}	gain error for ADCIN1 and BATTEMP inputs		-1.0	-	+1.0	%
E _{u(tot)}	total unadjusted error for ADCIN1 and BATTEMP inputs		-10	-	+10	LSB
t _{pwrup}	power-up time		-	7	-	μs
t _{conv}	conversion time	adcres = 0 (10-bit)	-	28	-	μs
		adcres = 1 (8-bit)	-	23	-	μs
t _{stRM}	ratiometric settling time	adcratioset = 0	-	10	-	μs
		adcratioset = 1	-	100	-	μs
R _{NTCSW}	resistance of the VISA-to-NTC switch	ntcswen = 1, switch is closed	120	175	225	Ω
R _{ACCSW}	resistance of the VISA-to-ACC switch	accswen = 1, switch is closed	120	175	225	Ω
Z _I	input impedance of the high voltage ADCIN2 input during conversion		250	360	-	kΩ
IL	leakage current on ADC inputs; no conversion in progress		-	-	1	μΑ

8.14.5 Software interface

Table 107. ADCC1 - A/D converter control register 1 (address 54h) bit description

Bit	Symbol	Access	Reset[1]	Description
0	adcstart	R/W	0	ADC conversion start command (starts when set)
1	adcres	R/W	0	ADC resolution selection 0: 10-bit resolution; 1: 8-bit resolution
3:2	adc_av	R/W	00	measurement averaging 00: no averaging, single sample 01: averaging over 4 samples 10: averaging over 8 samples 11: averaging over 16 samples
7:4	adcinmux	R/W	0000	ADC input selection 0000: BATSNS pin via resistive divider 0001: BATSNS pin via subtractor 0010: ADCIN2 via resistive divider 0011: ADCIN2 via subtractor 0100: reserved 0101: reserved 0110: BATTEMP 0111: ADCIN1 1000-1111: reserved

^[1] This register is reset in NoPower state.

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Table 108. ADCC2 - A/D converter control register 2 (address 53h) bit description

Bit	Symbol	Access	Reset[1]	Description
1:0	adcratioen	R/W	00	ratiometric measurement selection 00 : no ratiometric mode measurement 01 : ratiometric mode for BATTEMP only 10 : ratiometric mode for ADCIN1 only 11 : ratiometric mode for BATTEMP and ADCIN1 [2]
2	adcratioset	R/W	0	ratiometric settling time 0 = 10 us; 1 = 100 us
7:3	reserved			

^[1] This register is reset in NoPower state.

Table 109. ADCC3 - A/D converter control register 3 (address 52h) bit description

Bit	Symbol	Access	Reset[1]	Description
0	accswen	R/W	0	enables biasing for ratiometric measurement on ADCIN1 pin
1	reserved			
2	ntcswen	R/W	0	enables biasing for ratiometric measurement on BATTEMP pin
3	reserved			
4	adcdivsel	R/W	0	resistive divider type selection 0: divide by 3; 1: divide by 2
7:5	reserved		_	

^[1] This register is reset in NoPower state.

Table 110. ADCS1 - A/D converter status register 1 (address 55h) bit description[1]

Bit	Symbol	Access	Description
7:0	adcdat1h	R	8 most significant bits of the (first) ADC result

^[1] This register is reset in NoPower state.

Table 111. ADCS2 - A/D converter status register 2 (address 56h) bit description[1]

Bit	Symbol	Access	Description
7:0	adcdat2h	R	8 most significant bits of the second ADC conversion of an ADC measurement sequence

^[1] This register is reset in NoPower state.

^[2] If adcratioen is set to 11, the result of the **BATTEMP** conversion is stored in ADCS1/ADCS3 (bit 1:0) status registers and the result of the **ADCIN1** conversion is stored in the ADCS1/ADCS3 (bit 3:2) status resisters.

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Table 112. ADCS3 - A/D converter status register 3 (address 57h) bit description

Bit	Symbol	Access	Reset[1]	Description
1:0	adcdat1l	R	-	2 least significant bits of the (first) ADC result
3:2	adcdat2l	R	_	2 least significant bits of the second ADC conversion of an ADC measurement sequence
6:4	adcrefmux	R	111	ADC Reference selection V _{REF} 000: NTCSW 001: ACCSW 010: 2.0 V 011: VISA 100-110: reserved 111: 2.0 V
7	adcrdy	R	0	ADC status: 0: ADC is disabled or conversion is in progress 1: ADC conversion is completed.

^[1] This register is reset in NoPower state.

8.14.6 Functional description

8.14.6.1 Overview

The ADC module consists of a 10-bit Analog-to-Digital converter with internal sample and hold and an input multiplexer offering 4 separate input channels: pins **ADCIN1**, **ADCIN2**, **BATTEMP** and **BATSNS**. Two of these inputs (**ADCIN2** and **BATSNS**) can be preprocessed using either a voltage divider or a subtraction circuit, facilitating an extended input range. The input source is selected by means of the *adcinmux* bits in the *ADCC1* register (see Table 107).

A conversion is initiated by setting bit *adcstart*. The resolution (8- or 10-bit) is determined by the setting of bit *adcres*. When the conversion is complete, the *adcrdy* status bit is set and an *adcrdy* interrupt generated. The measurement results can then be retrieved from the ADC status registers (Table 110 to Table 112).

A single sample can be taken, or the measured data can be averaged over 4, 8, or 16 samples as determined by the setting of bit *adc* av.

The ADC supports ratiometric measurements.

8.14.6.2 High-voltage ADC inputs and analog preprocessing

The **BATSNS** and the **ADCIN2** inputs are high voltage terminals that can be used to measure voltages higher than the standard 2.0 V ADC range. These higher voltages can be measured either by subtracting a reference voltage or by dividing the voltage by a specified factor.

Divider mode: A resistive divider is used to divide the input voltage by a factor of 2 or 3 (depending on the setting of bit *adcdivsel* in register *ADCC3*; see <u>Table 109</u>). This makes it possible to measure input voltages up to 5.5 V.

Bit *adcinmux* is set to 0000 or 0010 to measure a voltage on, respectively, **BATSNS** or **ADCIN2** via the resistive divider (see Table 107).

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The resistive divider is activated only during the ADC tracking and conversion phases. It is kept floating at all other times, resulting in negligible input currents. The voltage on the **BATSNS** input in divide-by-two mode can be calculated using the following formula:

$$V_{BATSNS} = \frac{ADCDAT_{(BATSNS))}}{1023} \times 4.0V \tag{6}$$

where ADCDAT(BATSNS) is the 8- or 10-bit result stored in the status registers.

Subtraction mode: The input voltage is processed by a subtraction circuit that allows for an ADC input range of 2.25 V to 4.25 V. The subtraction process provides enhanced resolution in the fully charged battery voltage range. This mode is selected by setting the *adcinmux* control bits to 0001, when using the **BATSNS** input, or to 0011 for the **ADCIN2** input (see Table 107). The voltage on **BATSNS** is determined by the following formula:

$$V_{BATSNS} = \frac{ADCDAT_{(BATSNS)}}{1023} \times 2 + 2.25V \tag{7}$$

8.14.6.3 Low-voltage ADC inputs and ratiometric measurement

The **ADCIN1** and **BATTEMP** inputs can be used to measure voltages within the standard ADC module input voltage range of 0 V to 2.0 V. The *adcinmux* control bits in register *ADCC1* are set to 0.111 to select **ADCIN1** and to 0.110 to select **BATTEMP**.

The battery temperature is typically measured using an external NTC bridge placed close to the battery (see <u>Section 8.12.6.11</u>). The ADC and the MBC (Main Battery Charger) modules share the NTC circuit, which contains a known fixed resistance in series with the NTC thermistor. The NTC circuit is configured as a half bridge connected between the **NTCSW** pin and the PCB ground. The internal node of the half bridge is connected to the **BATTEMP** input of the ADC module.

The **BATTEMP** and **ADCIN1** inputs support ratiometric measurement (the ratiometric mode is determined by the settings of the *adcratioen* control bits; see <u>Table 108</u>). In this mode, the ADC results reflect the ratio of the external fixed resistance to the NTC resistor value:

$$R_{NTC} = \frac{ADCDAT_{(BATTEMP)}}{1023 - ADCDAT_{(BATTEMP)}} \times R_{FIXED}$$
(8)

If adcratioen = 11, the ADC will perform sequential conversions on both the **BATTEMP** and **ADCIN1** inputs. The result of the **BATTEMP** conversion is stored in the ADCS1/ADCS3 (bit 1:0) status registers and the result of the **ADCIN1** conversion is stored in the ADCS1/ADCS3 (bit 3:2) status resisters.

Before starting a ratiometric measurement, a settling period determined by the *adcratioset* bit should be specified (see <u>Table 108</u>).

The **NTCSW** and **ACCSW** pins provide biasing for the half bridge when measuring voltages on **BATTEMP** and **ADCIN1** respectively. Biasing should be activated (bits *ntcswen* or *accswen* set to 1; see <u>Table 109</u>) before initiating the ADC conversion sequence. Biasing is automatically disabled (*ntcswen* or *accswen* set to 0) when the conversion is complete to conserve power.

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The **ADCIN1** and **BATTEMP** inputs can be used as normal ADC inputs if a ratiometric mode is not selected (*adcratioen* = 0).

Ratiometric measurements can be used for determining the value of id resistors found in some battery packs (see Figure 49).

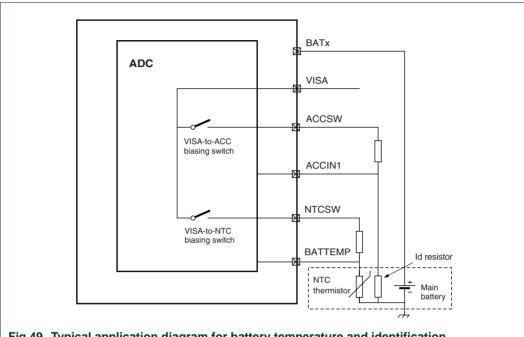


Fig 49. Typical application diagram for battery temperature and identification measurement

8.14.6.4 ADC conversion control

The ADC module can be configured as an 8- or 10-bit converter via the *adcres* control bit in the *ADCC1* register (see <u>Table 107</u>). 8-bit is faster than 10-bit conversion, and may be preferred when the digital resolution is not critical. 8-bit conversion is completed a full 2 clock cycles faster than the equivalent 10-bit conversion. In addition, the 8-bit result can be read in a single I²C-bus read cycle, considerably reducing data communication times.

A power-up and conversion sequence at 8-bit resolution typically takes 30 μ s. The conversion can be performed and the results read back in the space of two sequential I²C-bus access cycles (it will take at least 40 μ s at a 400 kbit/s I²C-bus speed).

8.15 Real-time clock (RTC)

8.15.1 Introduction

The RTC module provides timing information for the application based on a 1 Hz clock frequency. It contains a calendar function that automatically takes account of differing month lengths and leap years.

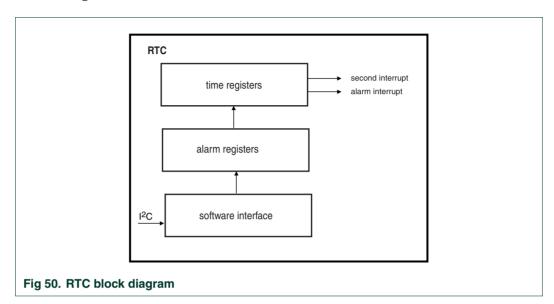
8.15.2 Features

- Periodic second interrupt
- Enabled in all states except NoPower

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- Alarm wake-up function
- Automatic leap year correction.

8.15.3 Block diagrams



8.15.4 Hardware interface

There is no hardware interface associated with the RTC.

8.15.5 Software interface

8.15.5.1 RTC time registers

Table 113. RTCSC - RTC second value register (address 59h) bit description

Bit	Symbol	Access	Reset[1]	Description
6-0	sec	R/W [2]	0000000	current seconds value (00 to 59) coded in BCD format
				example: sec = 0001 1001 represents a value 19 s.
7	reserved		[2]	

^[1] This register is reset in NoPower state.

Table 114. RTCMN - RTC minute value register (address 5Ah) bit description

Bit	Symbol	Access	Reset[1]	Description
6-0	min	R/W	0000000	current minutes value (00 to 59) coded in BCD format
7	reserved		[2]	

^[1] This register is reset in NoPower state.

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^[2] Counting proceeds after this register has been updated. The software should take this into account and ensure that a full RTC update (up to 7 registers) is completed before the seconds counter reaches 59. To avail of the maximum available update time, the software should initiate an update immediately after a one second interrupt has been generated.

^[2] Reserved bits should be written 0; return values are not defined.

^[2] Reserved bits should be written 0; return values are not defined.

Table 115. RTCHR - RTC hour value register (address 5Bh) bit description

Bit	Symbol	Access	Reset[1]	Description
5-0	hour	R/W	000000	current hours value (00 to 23) coded in BCD format
7-6	reserved		[2]	

^[1] This register is reset in NoPower state.

8.15.5.2 RTC date registers

Table 116. RTCWD - RTC day-of-week value register (address 5Ch) bit description

Bit	Symbol	Access	Reset[1]	Description
2-0	wkday	R/W	000	current day-of-week value (0 to 6); see Table 117.
7-3	reserved		[2]	

^[1] This register is reset in NoPower state.

Table 117. WKDAY assignment

Day	Bit	Bit 1	Bit 0
Sunday	0	0	0
Monday	0	0	1
Tuesday	0	1	0
Wednesday	0	1	1
Thursday	1	0	0
Friday	1	0	1
Saturday	1	1	0

Table 118. RTCDT - RTC day value in BCD format register (address 5Dh) bit description

Bit	Symbol	Access	Reset[1]	Description
5-0	day	R/W	000001	current day value (01 to 31) coded in BCD format
7-6	reserved		[2]	

^[1] This register is reset in NoPower state.

Table 119. RTCMT - RTC month value in BCD format register (address 5Eh) bit description

Bit	Symbol	Access	Reset[1]	Description
4-0	month	R/W	000001	current month value (01 to 12) coded in BCD format; see <u>Table 121</u> .
7-5	reserved		[2]	

^[1] This register is reset in NoPower state.

Table 120. RTCYR - RTC year value in BCD format register (address 5Fh) bit description

Bit	Symbol	Access	Reset[1]	Description
7-0	year	R/W	00000000	current year value (00 to 99) coded in BCD format

^[2] Reserved bits should be written 0; return values are not defined.

^[2] Reserved bits should be written 0; the return values are not defined.

^[2] Reserved bits should be written 0; return values are not defined.

^[2] Reserved bits should be written 0; return values are not defined.

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[1] This register is reset in NoPower state.

Table 121. MONTH assignment

Day	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
January	0	0	0	0	1
February	0	0	0	1	0
March	0	0	0	1	1
April	0	0	1	0	0
May	0	0	1	0	1
June	0	0	1	1	0
July	0	0	1	1	1
August	0	1	0	0	0
September	0	1	0	0	1
October	1	0	0	0	0
November	1	0	0	0	1
December	1	0	0	1	0

8.15.6 RTC alarm registers

Table 122. RTCSCA - RTC second alarm value register (address 60h) bit description

Bit	Symbol	Access	Reset[1]	Description
6-0	seca	R/W	1111111	second alarm value (00 to 59) coded in BCD format
7	reserved		[2]	

^[1] This register is reset in NoPower state.

Table 123. RTCMNA - RTC minute alarm value register (address 61h) bit description

Bit	Symbol	Access	Reset[1]	Description
6-0	mina	R/W	1111111	minute alarm value (00 to 59) coded in BCD format
7	reserved		[2]	

^[1] This register is reset in NoPower state.

Table 124. RTCHRA - RTC hour alarm value register (address 62h) bit description

Bit	Symbol	Access	Reset[1]	Description
5-0	houra	R/W	111111	hour alarm value (00 to 23) coded in BCD format
7-6	reserved		[2]	

^[1] This register is reset in NoPower state.

Table 125. RTCWDA - RTC weekday alarm value e register (address 63h) bit description

Bit	Symbol	Access	Reset[1]	Description
2-0	wkdaya	R/W	111	day-of-week alarm value (0 to 6) see Table 117.
7-3	reserved		[2]	

^[2] Reserved bits should be written 0; return values are not defined.

^[2] Reserved bits should be written 0; return values are not defined.

^[2] Reserved bits should be written 0; return values are not defined.

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- [1] This register is reset in NoPower state.
- [2] Reserved bits should be written 0; return values are not defined.

Table 126. RTCDTA - RTC weekday alarm BCD value register (address 64h) bit description

Bit	Symbol	Access	Reset[1]	Description
5-0	daya	R/W	111111	day alarm value (00 to 31) coded in BCD format
7-6	reserved		[2]	

- [1] This register is reset in NoPower state.
- [2] Reserved bits should be written 0; return values are not defined.

Table 127. RTCMTA - RTC month alarm BCD value register (address 65h) bit description

Bit	Symbol	Access	Reset[1]	Description
4-0	montha	R/W	11111	month alarm value (01 to 12) coded in BCD format; see <u>Table 121</u> .
7-5	reserved		[2]	

- [1] This register is reset in NoPower state.
- [2] Reserved bits should be written 0; return values are not defined.

Table 128. RTCYRA - RTC year alarm BCD value register (address 66h) bit description

Bit	Symbol	Access	Reset[1]	Description
7-0	yeara	R/W	11111111	year alarm value (00 to 99) coded in BCD format

^[1] This register is reset in NoPower state.

8.15.7 Functional description

The RTC module is supplied from the internal supply (V_{VISA}) and is active in all activity states except NoPower (see Table 15).

The RTC time/date registers are reset to zero when the PCF50633 is in the NoPower state. The time/date registers can be programmed to any start time once in Active state. It is recommended that the RTC interrupts (second/rtcalarm) be masked before writing a new value to the time/date registers to avoid interrupts being generated during the write cycles (up to 7 register write cycles may be required to update the time/date).

The PCF50633 compensates for leap years by adding a 29th day to February if the year counter contains a value exactly divisible by 4.

The RTC unit contains an alarm function. The alarm registers can be individually enabled by writing a value different from the reset value. When one or more of the alarm registers is loaded with a valid time and/or date, the alarm register contents will be compared with the current time and date. When all enabled comparisons match, an *rtcalarm* interrupt is generated. The alarm registers are preset to 1, which disables the alarm. It is recommended that the *rtcalarm* interrupt be masked before writing a new value to the alarm registers to avoid interrupts being generated during the write cycles (up to 7 register write cycles may be required to update the alarm).

A second interrupt is generated, as its name implies, every second.

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If the PCF50633 is in Standby state when an RTC alarm occurs, a state transition to Active will be initiated as soon as the start-up conditions are met (see <u>Section 8.1.6.2</u> "Transitions between activity states").

The RTC time/date registers may be updated only once per second. There are no restrictions imposed when writing to the alarm registers or when reading from any of the registers.

Values written to the RTC registers become effective at the next 1 Hz clock pulse. It can therefore take up to 1 second for new values to become active.

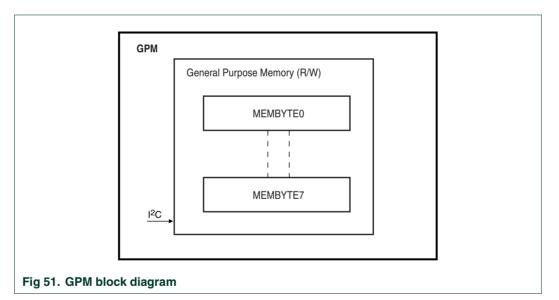
To obtain an accurate RTC, a 32 kHz crystal oscillator or an external 32 kHz signal needs to be connected to the PCF50633. When an accurate 32 kHz signal is not available, the clock for the RTC is derived from the integrated free-running oscillator.

8.16 General Purpose Memory (GPM)

8.16.1 Introduction

The PCF50633 contains an 8-byte general purpose memory block.

8.16.2 Block diagram



8.16.3 Software interface

Table 129. MEMBYTE0 - General purpose memory byte 0 (address 67h) bit description

Bit	Symbol	Access	Reset	Description
7-0	membyte0	R/W	00000000	byte 0 of 8-byte general purpose memory

Table 130. MEMBYTE1 - General purpose memory byte 1 (address 68h) bit description

Bit	Symbol	Access	Reset	Description
7-0	membyte1	R/W	00000000	byte 1 of 8-byte general purpose memory

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Table 131. MEMBYTE2 - General purpose memory byte 2 (address 69h) bit description

Bit	Symbol	Access	Reset	Description
7-0	membyte2	R/W	00000000	byte 2 of 8-byte general purpose memory

Table 132. MEMBYTE3 - General purpose memory byte 3 (address 6Ah) bit description

Bit	Symbol	Access	Reset	Description
7-0	membyte3	R/W	00000000	byte 3 of 8-byte general purpose memory

Table 133. MEMBYTE4 - General purpose memory byte 4 (address 6Bh) bit description

Bit	Symbol	Access	Reset	Description
7-0	membyte4	R/W	00000000	byte 4 of 8-byte general purpose memory

Table 134. MEMBYTE5 - General purpose memory byte 5 (address 6Ch) bit description

Bit	Symbol	Access	Reset	Description
7-0	membyte5	R/W	00000000	byte 5 of 8-byte general purpose memory

Table 135. MEMBYTE6 - General purpose memory byte 6 (address 6Dh) bit description

Bit	Symbol	Access	Reset	Description
7-0	membyte6	R/W	00000000	byte 6 of 8-byte general purpose memory

Table 136. MEMBYTE7 - General purpose memory byte 7 (address 6Eh) bit description

Bit	Symbol	Access	Reset	Description
7-0	membyte7	R/W	00000000	byte 7 of 8-byte general purpose memory

8.16.4 Functional description

The PCF50633 includes an 8-byte general purpose memory block which can be used to support sleep states, for RTC encryption or for any other purpose required by the application. R/W operations to the general purpose memory registers are via the I²C-bus interface. Data is retained as long as the device does not enter the NoPower state, even when the backup battery is the only valid power source.

8.17 Serial interface (I²C)

8.17.1 Introduction

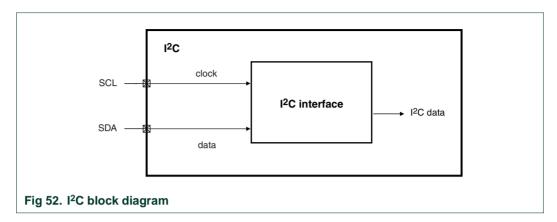
The serial interface of the PCF50633 uses the I²C-bus. A detailed description of the I²C-bus specification, including applications, is provided in *The I²C-bus and how to use it* brochure, order no. 9398 393 40011, or in the IPC Peripherals Data Handbook IC12.

8.17.2 Features

- Data transfer speed up to 400 kHz
- Slave device.

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8.17.3 Block diagrams



8.17.4 Hardware interface

Table 137. I²C-bus characteristics

 $V_{SS} = REFGND = GND = 0 \text{ V}; T_{amb} = -40 \text{ to } +85 \text{ }^{\circ}\text{C}; \text{ unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{IL}	LOW-level input voltage on SDA, SCL pins		0	-	0.5	V
V _{IH}	HIGH-level input voltage on SDA, SCL pins		0.8	-	5.5	V
V _{OL}	LOW-level output voltage on SDA pin	Pull up resistance > 1 k Ω	-0.2	-	0.4	V
f _{SCL}	I ² C-bus clock frequency		-	-	400	kHz

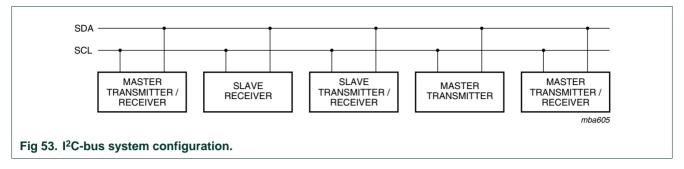
8.17.5 Functional description

The I²C-bus is used for bidirectional, two-line communication between ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor. Data transfer may be initiated only when the bus is not busy. In bus configurations where ICs are on different supply voltages, the pull-up resistors should be connected to the highest supply voltage. The I²C-bus supports incremental addressing. This enables the host controller to read or write to multiple registers in a single I²C-bus action. The PCF50633 supports I²C-bus communications up to 400 kbit/s.

8.17.5.1 I²C-bus configuration

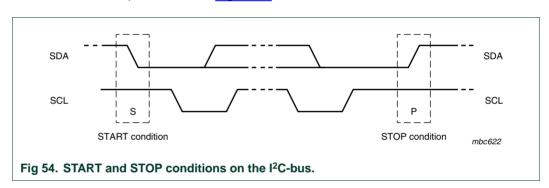
The I²C-bus system configuration is shown in <u>Figure 53</u>. The device generating the message is the 'transmitter' while the receiving device is the 'receiver'. The device controlling the operation is the 'master' while the device or devices being controlled by the master are the 'slaves'. The PCF50633 is a slave only device.

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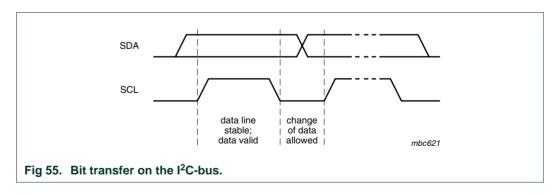
8.17.6 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not active. A HIGH-to-LOW transition on the data line, while the clock is HIGH, is defined as the START condition (S). When this occurs the bus becomes 'busy'. A LOW-to-HIGH transition on the data line while the clock is HIGH is defined as the STOP condition (P). This terminates data transfer and frees up the bus; see Figure 54.



8.17.7 Bit transfer

A single data bit is transferred during each clock pulse. The data on the SDA line must remain stable while the clock pulse is HIGH as state transitions that occur on the data line while the clock is HIGH are interpreted as control signals; see Figure 55.



8.17.8 Acknowledge

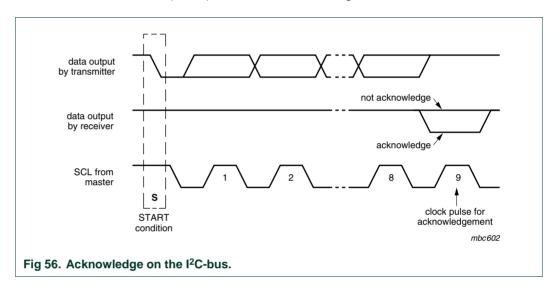
There is no limit to the amount of data that can be transmitted between the START and STOP conditions. Each byte (8 bits) is followed by an acknowledge bit. The acknowledge bit is a HIGH level signal on the SDA line for which the receiver generates an extra acknowledge-related clock pulse.

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The transmitter releases the SDA line (HIGH) during the acknowledge clock pulse. The slave receiver must generate an acknowledge signal by pulling the SDA line LOW. It must remain stable LOW while the acknowledge clock pulse is HIGH (setup and hold times must be taken into consideration).

A master receiver must also generate an acknowledge signal after receiving each byte clocked out of the slave transmitter.

A master-receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte to be clocked out of the slave. The slave transmitter must then release the data line (HIGH) to allow the master to generate a STOP condition.



8.17.9 Internal timing of a write sequence

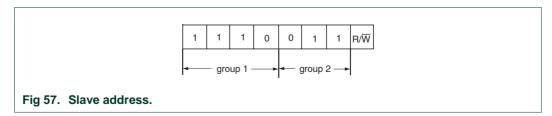
Data written to the PCF50633 will become valid on the falling edge of the associated SCL acknowledge signal.

8.17.10 I²C-bus protocol

Addressing: The first byte of any data transmission on the I²C-bus contains the address of the target device. The address of the PCF50633 is 1110011R/W. The least significant bit is the read/write indicator.

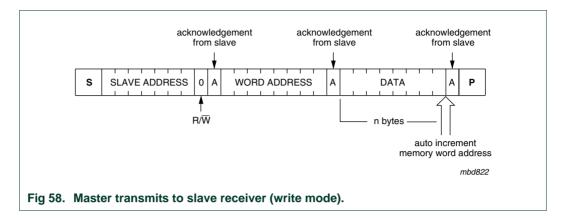
The PCF50633 acts as a slave receiver or slave transmitter. Therefore the SCL clock signal is a unidirectional input signal. The data line, SDA, is bidirectional.

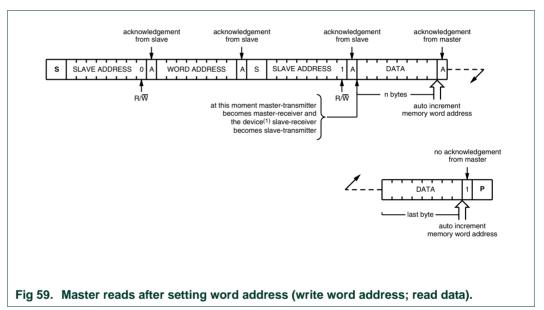
The PCF50633 slave address is illustrated in Figure 57.

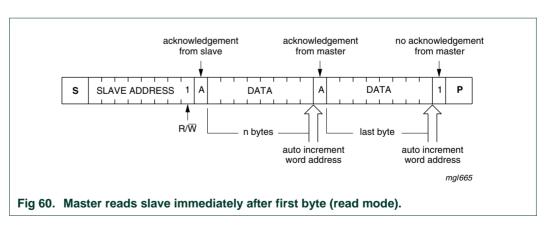


Read/write cycles: The I²C-bus configurations for the PCF50633 read and write cycles are illustrated in <u>Figure 58</u> to <u>Figure 60</u>. The word address is an 8-bit value indicating which register is being accessed.

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8.17.11 De-activation of the I²C-bus module

The I²C-bus module is only enabled in the Active state when the reset for the host controller is released (**RSTHC** is HIGH). It only consumes power during data communications.

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8.18 Register map

Table 138. PCF50633 register overview

HEX Addr.	Register Name	Mode	Reset [1]	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Ref
00	VERSION	R	NA	version								Table 6
01	VARIANT	R	NA	variant								Table 7
02	INT1	R&C	NOP	second	rtcalarm	reserved		usbrem	usbins	adprem	adpins	Table 17
03	INT2	R&C	NOP	exton3f	exton3r	exton2f	exton2r	exton1f	exton1r	onkeyf	onkeyr	Table 18
04	INT3	R&C	NOP	onkey1s	adcrdy	usblimoff	usblimon	thlimoff	thlimon	chghalt	batfull	Table 19
05	INT4	R&C	NOP	ledovp	ledpwrfail	dwn2pwrfail	dwn1pwrfail	autopwrfail	hightmp	lowbat	lowsys	Table 20
06	INT5	R&C	NOP	hcldoovl	hcldopwrfail	ldo6pwrfail	ldo5pwrfail	ldo4pwrfail	ldo3pwrfail	ldo2pwrfail	ldo1pwrfail	Table 21
07	INT1MASK	R/W	NOP	secondm	rtcalarmm	reserved		usbremm	usbinsm	adpremm	adpinsm	Table 22
08	INT2MASK	R/W	NOP	exton3fm	exton3rm	exton2fm	exton2rm	exton1fm	exton1rm	onkeyfm	onkeyrm	Table 23
09	INT3MASK	R/W	NOP	onkey1sm	adcrdym	usblimoffm	usblimonm	thlimoffm	thlimonm	chghaltm	batfullm	Table 24
0A	INT4MASK	R/W	NOP	ledovpm	ledpwrfailm	dwn2pwrfailm	dwn1pwrfailm	autopwrfailm	hightmpm	lowbatm	lowsysm	Table 25
0B	INT5MASK	R/W	NOP	hcldoovlm	hcldopwrfailm	ldo6pwrfailm	ldo5pwrfailm	ldo4pwrfailm	ldo3pwrfailm	ldo2pwrfailm	ldo1pwrfailm	Table 26
0C	OOCSHDWN	R/W	NOP	reserved				coldboot	totrst	reserved	go_stby	Table 8
0D	OOCWAKE	R/W	NOP	adp_wake	usb_wake	reserved	rtc_wake	exton3_wake	exton2_wake	exton1_wake	onkey_wake	Table 9
0E	OOCTIM1	R/W	NOP	shdwn_deb	ı	exton3_deb		exton2_deb		exton1_deb		Table 10
0F	OOCTIM2	R/W	STBY	almon	hcrstdel		actphdel		onkey_deb			Table 11
10	OOCMODE	R/W	NOP	onkey_mod	le	exton3_mode		exton2_mode		exton1_mode		Table 12
11	OOCCTL	R/W	NOP	reserved	stbclk32on	reserved	usbbatchk	heartbeat	actclk32on	actphrst		Table 13
12	OOCSTAT	R	NOP	tmpok	batok	sysok	bubpres	exton3	exton2	exton1	onkey	Table 14
13	GPIOCTL	R/W	NOP	reserved					gpio3dir	gpio2dir	gpio1dir	Table 29
14	GPIO1CFG	R/W	NOP	reserved				gpio1pol	gpio1sel			Table 30
15	GPIO2CFG	R/W	NOP	reserved				gpio2pol	gpio2sel			Table 31
16	GPIO3CFG	R/W	NOP	reserved				gpio3pol	gpio3sel			Table 32
17	GPOCFG	R/W	NOP	reserved				gpopol	gposel			Table 33
18	BVMCTL	R/W	NOP	reserved			bvmdisdb	bvmlvl			bvmlow	Table 37
19	SVMCTL	R/W	NOP	reserved			svmdisdb	svmlvl			svmlow	Table 35
1A	AUTOOUT	R/W	STBY	auto_out								Table 50
1B	AUTOENA	R/W	STBY	reserved		auto_ena_act		auto_p3c	auto_p2c	auto_p1c	auto_on	Table 51
1C	AUTOCTL	R/W	NOP	reserved						auto_mod	autopwmonly	Table 52

DOESOS331M 6	HEX Addr.	Register Name	Mode	Reset	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Ref
ח	1D	AUTOMXC	R/W	STBY	reserved	auto_maxcmod	auto_maxc						Table
	1E	DOWN1OUT	R/W	STBY	down1_out								Table
	1F	DOWN1ENA	R/W	STBY	reserved		down1_ena_ac	ct	down1_p3c	down1_p2c	down1_p1c	down1_on	Table
	20	DOWN1CTL	R/W	NOP	reserved			down1_dvmste	p			down1pwmon ly	Tabl
	21	DOWN1MXC	R/W	STBY	reserved	down1_maxcm od	down1_maxc						Tabl
	22	DOWN2OUT	R/W	STBY	down2_out								Tabl
	23	DOWN2ENA	R/W	STBY	reserved		down2_ena_ac	ot	down2_p3c	down2_p2c	down2_p1c	down2_on	Tab
	24	DOWN2CTL	R/W	NOP	reserved			down2_dvmste	þ			down2pwmon ly	Tabl
	25	DOWN2MXC	R/W	NOP	reserved	down2_maxcm od	down2_maxc						Tab
	26	MEMLDOOUT	R/W	STBY	reserved		memldo_swm od	memldo_out					Tab
	27	MEMLDOENA	R/W	STBY	reserved		memldo_ena_a	act	memldo_p3c	memldo_p2c	memldo_p1c	memldo_on	Tab
	28	LEDOUT	R/W	STBY	reserved		led_out						Tab
	29	LEDENA	R/W	STBY	reserved		led_ena_act		led_p3c	led_p2c	led_p1c	led_on	Tab
	2A	LEDCTL	R/W	NOP	reserved					led_ocp	led_ovprst	led_ovpon	Tab
	2B	LEDDIM	R/W	STBY	led_dimstep								Tab
	2C	RESERVED	-	NOP	reserved								
	2D	LDO10UT	R/W	STBY	reserved		ldo1_swmod	ldo1_out					Tab
	2E	LDO1ENA	R/W	STBY	reserved		ldo1_ena_act		ldo1_p3c	ldo1_p2c	ldo1_p1c	ldo1_on	Tab
	2F	LDO2OUT	R/W	STBY	reserved		ldo2_swmod	ldo2_out					Tab
	30	LDO2ENA	R/W	STBY	reserved		ldo2_ena_act		ldo2_p3c	ldo2_p2c	ldo2_p1c	ldo2_on	Tab
	31	LDO3OUT	R/W	STBY	reserved		ldo3_swmod	ldo3_out					Tab
	32	LDO3ENA	R/W	STBY	reserved		ldo3_ena_act		ldo3_p3c	ldo3_p2c	ldo3_p1c	ldo3_on	Tab
)	33	LDO4OUT	R/W	STBY	reserved		ldo4_swmod	ldo4_out					Tab
1	34	LDO4ENA	R/W	STBY	reserved		ldo4_ena_act		ldo4_p3c	ldo4_p2c	ldo4_p1c	ldo4_on	Tab
	35	LDO5OUT	R/W	STBY	reserved		ldo5_swmod	ldo5_out					Tab
	36	LDO5ENA	R/W	STBY	reserved		ldo5_ena_act		ldo5_p3c	ldo5_p2c	ldo5_p1c	ldo5_on	Tab
© NXD B V 2008 ∆II righte recer	37	LDO6OUT	R/W	STBY	reserved		ldo6_swmod	ldo6_out					Tab

PCF50633UM_6	HEX Addr.	Register Name	Mode	Reset [1]	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Ref
6	38	LDO6ENA	R/W	STBY	reserved		ldo6_ena_act		ldo6_p3c	ldo6_p2c	ldo6_p1c	ldo6_on	Table 8
	39	HCLDOOUT	R/W	STBY	reserved		hcldo_swmod	hcldo_out					Table 8
	3A	HCLDOENA	R/W	STBY	reserved		hcldo_ena_act		hcldo_p3c	hcldo_p2c	hcldo_p1c	hcldo_on	Table 8
	3B	STBYCTL1	R/W	NOP	reserved	ldo4_ena_stb	reserved	ldo3_ena_stb	reserved	ldo2_ena_stb	reserved	ldo1_ena_stb	Table 4
	3C	STBYCTL2	R/W	NOP	reserved	memldo_ena_s tb	reserved	hcldo_ena_stb	reserved	ldo6_ena_stb	reserved	ldo5_ena_stb	Table 4
	3D	DEBPF1	R/W	NOP	led_debpf		down2_debpf		down1_debpf		auto_debpf		Table 4
	3E	DEBPF2	R/W	NOP	ldo4_debpf		ldo3_debpf		ldo2_debpf		ldo1_debpf		Table 4
	3F	DEBPF3	R/W	NOP	reserved		hcldo_debpf		ldo6_debpf		ldo5_debpf		Table 4
	40	HCLDOOVL	R/W	NOP	reserved						hcldo_debovl		Table 9
	41	DCDCSTAT	R	NOP	reserved				led_pwrok	down2_pwrok	down1_pwro k	auto_pwrok	Table 4
	42	LDOSTAT	R	NOP	hcldo_ovl	hcldo_pwrok	ldo6_pwrok	ldo5_pwrok	ldo4_pwrok	ldo3_pwrok	ldo2_pwrok	ldo1_pwrok	Table 4
	43	MBCC1	R/W	NOP	wdtime		prewdtime	restart	resume	autores	autostop	chgena	Table
	44	MBCC2	R/W	NOP	vresdebtim e	reserved	vmax				vbatcond		Table 9
	45	MBCC3	R/W	NOP	prechgcur								Table !
	46	MBCC4	R/W	NOP	fstchgcur1								Table
	47	MBCC5	R/W	NOP	fstchgcur2								Table !
	48	MBCC6	R/W	NOP	reserved			cutoffcur					<u>Table</u>
	49	MBCC7	R/W	NOP	batsysimax		reserved			battempena	usbdevstat		<u>Table</u>
	4A	MBCC8	R/W	NOP	reserved			usbenasus	ntclvt				<u>Table</u>
	4B	MBCS1	R	NOP	wdtexp	prewdtexp	tbatstat		adaptok	adaptpres	usbok	usbpres	Table
	4C	MBCS2	R	NOP	reserved	resstat	chgstat		mbcmod				Table
	4D	MBCS3	R	NOP	vres	vbatcond	vlim	ilim	tlim_chg	tlim_play	usblim_chg	usblim_play	Table
	4E	BBCCTL	R/W	NOP	reserved			bbcv	bbcc		bbcr	bbce	Table
© Z	4F	ALMGAIN	R/W	NOP	reserved			alm_gain					Table 1
© NXP B.V. 2008.	50	ALMDATA	R	NOP	alm_data	alm_data	alm_data	alm_data	alm_data	alm_data	alm_data	alm_data	Table
. 2008.	51	RESERVED	-	NOP	reserved								
. All rights res	52	ADCC3	R/W	NOP	reserved			adcdivsel	reserved	ntcswen	reserved	accswen	Table
hts re	53	ADCC2	R/W	NOP	reserved					adcratioset	adcratioen	adcratioen	Table
e e													

3	Table 138.	PCF50633	register	overview	continued
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HEX Addr.	Register Name	Mode	Reset [1]	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Ref
54	ADCC1	R/W	NOP	adcinmux				adc_av		adcres	adcstart	Table 107
55	ADCS1	R	NOP	adcdat1h								<u>Table 110</u>
56	ADCS2	R	NOP	adcdat2h								<u>Table 111</u>
57	ADCS3	R	NOP	adcrdy	adcrefmux			adcdat2l		adcdat1l		Table 112
58	RESERVED	-	NOP	reserved								
59	RTCSC	R/W	NOP	reserved				sec				<u>Table 113</u>
5A	RTCMN	R/W	NOP	reserved				min				Table 114
5B	RTCHR	R/W	NOP	reserved					hour			<u>Table 115</u>
5C	RTCWD	R/W	NOP	reserved						wkday		<u>Table 116</u>
5D	RTCDT	R/W	NOP	reserved					day			Table 118
5E	RTCMT	R/W	NOP	reserved					month			<u>Table 119</u>
5F	RTCYR	R/W	NOP					year				<u>Table 120</u>
60	RTCSCA	R/W	NOP	reserved				seca				Table 122
61	RTCMNA	R/W	NOP	reserved				mina				<u>Table 123</u>
62	RTCHRA	R/W	NOP	reserved				ŀ	noura			Table 124
63	RTCWDA	R/W	NOP	reserved						wkdaya		<u>Table 125</u>
64	RTCDTA	R/W	NOP	reserved				(daya			<u>Table 126</u>
65	RTCMTA	R/W	NOP	reserved					montha			Table 127
66	RTCYRA	R/W	NOP					yeara				Table 128
67	MEMBYTE0	R/W	NOP	membyte0								Table 129
68	MEMBYTE1	R/W	NOP	membyte1								Table 130
69	MEMBYTE2	R/W	NOP	membyte2								<u>Table 131</u>
6A	MEMBYTE3	R/W	NOP	membyte3								<u>Table 132</u>
6B	MEMBYTE4	R/W	NOP	membyte4								<u>Table 133</u>
6C	MEMBYTE5	R/W	NOP	membyte5								Table 134
6D	MEMBYTE6	R/W	NOP	membyte6								Table 135
6D 6E	MEMBYTE7	R/W	NOP	membyte7								Table 136
	RESERVED	-	NOP	reserved								
84	DCDCPFM	R/W	NOP	reserved					down2pfm	down1pfm	autopfm	Table 64

^[1] NA: register content is fixed; NOP: register is reset in NoPower state; STBY: register is reset at each transition to Standby state

9. Quality specification

In accordance with "SNW-FQ-611". The numbers of the quality specification can be found in the "Quality Reference Handbook". This handbook can be ordered using the code 9397 750 00192.

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10. Limiting values

Table 139. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134)

Symbol	Parameter	Conditions		Min	Max	Unit
V_{BAT}	battery supply voltage			-0.5	+5.5	V
V_{BUBAT}	backup battery supply voltage			-0.5	+5.5	V
V_{SYS}	system supply voltage			-0.5	+5.5	V
V_{USB}	USB supply voltage			-0.5	+5.5	V
V _I	input voltage	on any pin with respect to REFGND		-0.5	+5.5	V
I _I	input current	DC; at any control input		-10	+10	mA
Io	output current	DC; at any control output		-10	+10	mA
P _{tot}	total power dissipation			_	2000	mW
T _{amb}	ambient temperature			-40	+85	°C
T _{stg}	storage temperature			-55	+150	°C
V _{esd}	electrostatic discharge voltage	HBM[1]	[2]	-	±1000	V
			[3]	-	±2000	V
		MM[4]	[2]		±100	V
			[3]		±200	V
		CDM ^[5]			±500	V

^[1] Human Body Model: equivalent to discharging a 100 pF capacitor via a 1.5 $k\Omega$ resistor.

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^[2] Pins AUTOIN1, AUTOIN2, AUTOLXA1, AUTOLXA2, AUTOLXB1, AUTOLXB2, AUTOOUT1, AUTOOUT2, DOWN1IN, DOWN2IN, DOWN1LX, DOWN2LX, LEDIN, LEDLX and LEDOUT.

^[3] Pins other than those listed in Table note 2 above.

^[4] Machine Model: equivalent to discharging a 200 pF capacitor via a 0 Ω resistor.

^[5] Charge Device Model.

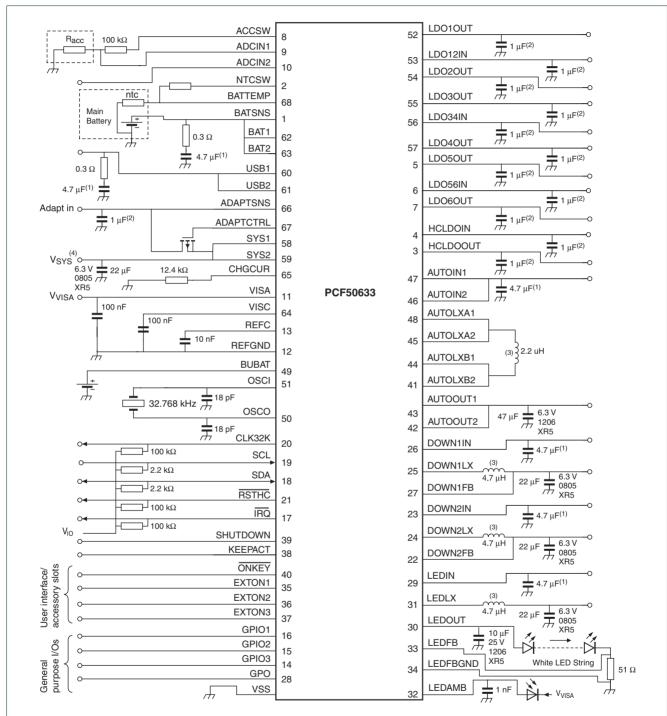
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11. Thermal characteristics

Table 140. Thermal characteristics

Symbol	Parameter	Package	Тур	Unit
Rth j-a,inf	Thermal resistance from junction to ambient in free air, mounted on infinite heatsink	HVQFN68	10	K/W
Rth j-a,pcb	Thermal resistance from junction to ambient, typical PCB situation		40	K/W

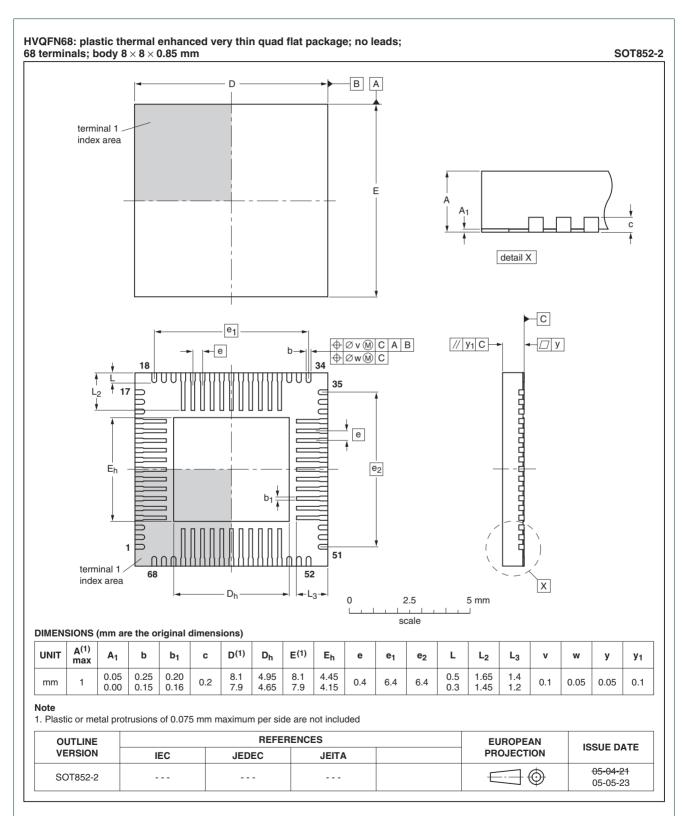
12. Application information



- (1) 6.3 V 0603 XR5
- (2) 6.3 V 0402 XR5
- (3) Power inductors with sufficiently high current saturation ratings, such as the TDK VLF3012 series, should be used.
- (4) V_{SYS} is typically used as an input voltage for the AUTO/DOWN converters and LDOs. For greater LDO efficiency, the outputs of the AUTO and DOWN converters can be used as inputs to the LDOs.

Fig 61. Typical application

13. Package outline



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14. Soldering

Soldering guidelines for package HVQFN68 can be found in Application Note *AN10365* "Surface mount reflow soldering description".

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15. Legal information

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